Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

⚠ REMINDERS

- Product information in this catalog is as of October 2015. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

  Please note that TAIYO YUDEN CO., LTD. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact TAIYO YUDEN CO., LTD. for further details of product specifications as the individual specification is available.

- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.

- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact TAIYO YUDEN CO., LTD. for more detail in advance.
  Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

  In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").
  It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.

- Please note that TAIYO YUDEN CO., LTD. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. TAIYO YUDEN CO., LTD. grants no license for such rights.

- Caution for export
  Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

SMD POWER INDUCTORS(NR SERIES/NR SERIES H TYPE/S TYPE/V TYPE)

REFLOW

■PARTS NUMBER

＊ Operating Temp.:−25〜+120℃(NRS40/50/60/80:−25〜+125℃) (Including self-generated heat)

N R △	4 0 1 8	T △	1 0 0	M	△
①	②	③	④	⑤	⑥

△=Blank space

①Series name

Code	Series name
NR△	Coating resin specification
NRH	
NRS	
NRV	

②Dimensions(L×W×H)

Code	Dimensions(L×W×H)[mm]
2010	2.0×2.0×1.0
2012	2.0×2.0×1.2
2410	2.4×2.4×1.0
2412	2.4×2.4×1.2
3010	3.0×3.0×1.0
3012	3.0×3.0×1.2
3015	3.0×3.0×1.5
4010	4.0×4.0×1.0
4012	4.0×4.0×1.2
4018	4.0×4.0×1.8
5010	4.9×4.9×1.0
5012	4.9×4.9×1.2
5014	4.9×4.9×1.4
5020	4.9×4.9×2.0
5024	4.9×4.9×2.4
5030	4.9×4.9×3.0
5040	4.9×4.9×4.0
6010	6.0×6.0×1.0
6012	6.0×6.0×1.2
6014	6.0×6.0×1.4
6020	6.0×6.0×2.0
6028	6.0×6.0×2.8
6045	6.0×6.0×4.5
8030	8.0×8.0×3.0
8040	8.0×8.0×4.0

③Packaging

Code	Packaging
T△	Taping

④Nominal inductance

Code (example)	Nominal inductance[μH]
2R2	2.2
100	10
101	100

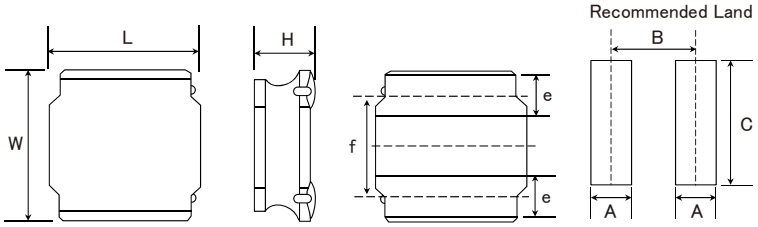
※R=Decimal point

⑤Inductance tolerance

Code	Inductance tolerance
M	±20%
N	±30%

⑥Internal code

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Recommended Land Patterns

Type	A	B	C
NRV2010	0.65	1.35	2.0
NRS2012, NRV2012			
NRH2410	0.7	1.45	2.0
NRH2412			
NR 3010, NRH3010	0.8	2.2	2.7
NR 3012, NRH3012, NRV3012			
NR 3015, NRS3015			
NR 4010, NRS4010	1.2	2.8	3.7
NR 4012, NRS4012			
NR 4018, NRS4018			
NRS8030	1.8	5.6	7.5
NR 8040, NRS8040			

Unit:mm

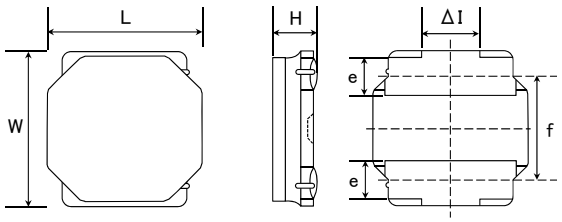
Type	L	W	H	e	f	Standard quantity [pcs] Taping
NRV2010	2.0±0.1 (0.079±0.004)	2.0±0.1 (0.079±0.004)	1.0 max (0.039 max)	0.5±0.2 (0.020±0.008)	1.25±0.2 (0.050±0.008)	2500
NRS2012 NRV2012	2.0±0.1 (0.079±0.004)	2.0±0.1 (0.079±0.004)	1.2 max (0.047 max)	0.5±0.2 (0.020±0.008)	1.25±0.2 (0.050±0.008)	2500
NRH2410	2.4±0.1 (0.095±0.004)	2.4±0.1 (0.095±0.004)	1.0 max (0.039 max)	0.6±0.2 (0.024±0.008)	1.45±0.2 (0.057±0.008)	2500
NRH2412	2.4±0.1 (0.095±0.004)	2.4±0.1 (0.095±0.004)	1.2 max (0.047 max)	0.6±0.2 (0.024±0.008)	1.45±0.2 (0.057±0.008)	2500
NR 3010 NRH3010	3.0±0.1 (0.118±0.004)	3.0±0.1 (0.118±0.004)	1.0 max (0.039 max)	0.9±0.2 (0.035±0.008)	1.9±0.2 (0.075±0.008)	2000

▶This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

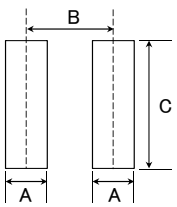
NR 3012 NRH3012 NRV3012	3.0±0.1 (0.118±0.004)	3.0±0.1 (0.118±0.004)	1.2 max (0.047 max)	0.9±0.2 (0.035±0.008)	1.9±0.2 (0.075±0.008)	2000
NR 3015 NRS3015	3.0±0.1 (0.118±0.004)	3.0±0.1 (0.118±0.004)	1.5 max (0.059 max)	0.9±0.2 (0.035±0.008)	1.9±0.2 (0.075±0.008)	2000
NR 4010 NRS4010	4.0±0.2 (0.157±0.008)	4.0±0.2 (0.157±0.008)	1.0 max (0.039 max)	1.1±0.2 (0.043±0.008)	2.5±0.2 (0.098±0.008)	5000
NR 4012 NRS4012	4.0±0.2 (0.157±0.008)	4.0±0.2 (0.157±0.008)	1.2 max (0.047 max)	1.1±0.2 (0.043±0.008)	2.5±0.2 (0.098±0.008)	4500
NR 4018 NRS4018	4.0±0.2 (0.157±0.008)	4.0±0.2 (0.157±0.008)	1.8 max (0.071 max)	1.1±0.2 (0.043±0.008)	2.5±0.2 (0.098±0.008)	3500
NRS8030	8.0±0.2 (0.315±0.008)	8.0±0.2 (0.315±0.008)	3.0 max (0.118 max)	1.60±0.3 (0.063±0.012)	5.6±0.3 (0.22±0.012)	1000
NR 8040 NRS8040	8.0±0.2 (0.315±0.008)	8.0±0.2 (0.315±0.008)	*1) 4.2 max (0.165 max) *2) 4.0 max (0.157 max)	1.60±0.3 (0.063±0.012)	5.6±0.3 (0.22±0.012)	1000

*1) 0R9～6R8 type, *2) 100～101 type

Unit : mm (inch)



Recommended Land Patterns



Type	A	B	C
NRS5010	1.5	3.6	4.0
NRS5012			
NRS5014			
NRS5020			
NRS5024			
NRS5030			
NR 5040, NRS5040			
NRS6010	1.6	4.7	5.7
NR 6012, NRS6012			
NRS6014			
NR 6020, NRS6020			
NR 6028, NRS6028			
NR 6045, NRS6045			

Unit : mm

Type	L	W	H	e	f	ΔI	Standard quantity [pcs] Taping
NRS5010	4.9±0.2 (0.193±0.008)	4.9±0.2 (0.193±0.008)	1.0 max (0.039 max)	1.2±0.2 (0.047±0.008)	3.3±0.2 (0.130±0.008)	1.3typ (0.051typ)	1000
NRS5012	4.9±0.2 (0.193±0.008)	4.9±0.2 (0.193±0.008)	1.2 max (0.047 max)	1.2±0.2 (0.047±0.008)	3.3±0.2 (0.130±0.008)	1.3typ (0.051typ)	1000
NRS5014	4.9±0.2 (0.193±0.008)	4.9±0.2 (0.193±0.008)	1.4 max (0.055 max)	1.2±0.2 (0.047±0.008)	3.3±0.2 (0.130±0.008)	1.3typ (0.051typ)	1000
NRS5020	4.9±0.2 (0.193±0.008)	4.9±0.2 (0.193±0.008)	2.0 max (0.079 max)	1.2±0.2 (0.047±0.008)	3.3±0.2 (0.130±0.008)	1.3typ (0.051typ)	800
NRS5024	4.9±0.2 (0.193±0.008)	4.9±0.2 (0.193±0.008)	*3) 2.5 max (0.098 max) *4) 2.4 max (0.094 max)	1.2±0.2 (0.047±0.008)	3.3±0.2 (0.130±0.008)	1.3typ (0.051typ)	2500
NRS5030	4.9±0.2 (0.193±0.008)	4.9±0.2 (0.193±0.008)	*5) 3.1 max (0.122 max) *6) 3.0 max (0.118 max)	1.2±0.2 (0.047±0.008)	3.3±0.2 (0.130±0.008)	1.3typ (0.051typ)	500
NR 5040 NRS5040	4.9±0.2 (0.193±0.008)	4.9±0.2 (0.193±0.008)	*7) 4.1 max (0.161 max) *8) 4.0 max (0.157 max)	1.2±0.2 (0.047±0.008)	3.3±0.2 (0.130±0.008)	1.3typ (0.051typ)	1500
NRS6010	6.0±0.2 (0.236±0.008)	6.0±0.2 (0.236±0.008)	1.0 max (0.039 max)	1.35±0.2 (0.053±0.008)	4.0±0.2 (0.157±0.008)	2.3typ (0.091typ)	1000
NR 6012 NRS6012	6.0±0.2 (0.236±0.008)	6.0±0.2 (0.236±0.008)	1.2 max (0.047 max)	1.35±0.2 (0.053±0.008)	4.0±0.2 (0.157±0.008)	2.3typ (0.091typ)	1000
NRS6014	6.0±0.2 (0.236±0.008)	6.0±0.2 (0.236±0.008)	1.4 max (0.055 max)	1.35±0.2 (0.053±0.008)	4.0±0.2 (0.157±0.008)	2.3typ (0.091typ)	1000
NR 6020 NRS6020	6.0±0.2 (0.236±0.008)	6.0±0.2 (0.236±0.008)	2.0 max (0.079 max)	1.35±0.2 (0.053±0.008)	4.0±0.2 (0.157±0.008)	2.3typ (0.091typ)	2500
NR 6028 NRS6028	6.0±0.2 (0.236±0.008)	6.0±0.2 (0.236±0.008)	2.8 max (0.110 max)	1.35±0.2 (0.053±0.008)	4.0±0.2 (0.157±0.008)	2.3typ (0.091typ)	2000
NR 6045 NRS6045	6.0±0.2 (0.236±0.008)	6.0±0.2 (0.236±0.008)	4.5 max (0.177 max)	1.35±0.2 (0.053±0.008)	4.0±0.2 (0.157±0.008)	2.3typ (0.091typ)	1500

*3) 1R0～1R5 type, *4) 2R2～330 type

*5) R47～100 type, *6) 150～470 type

*7) 1R5～100 type, *8) 150～470 type

Unit : mm (inch)

▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PARTS NUMBER

●NRS2012 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]				Measuring frequency [kHz]
						Saturation current: Idc1		Temperature rise current: Idc2		
						Max.	Typ.	Max.	Typ.	
NRS2012T 1R0N GJ	RoHS	1.0	±30%	—	0.070	1,900	2,050	1,700	1,850	100
NRS2012T 1R5N GJ	RoHS	1.5	±30%	—	0.090	1,650	1,800	1,500	1,650	100
NRS2012T 2R2M GJ	RoHS	2.2	±20%	—	0.107	1,350	1,500	1,370	1,500	100
NRS2012T 3R3M GJ	RoHS	3.3	±20%	—	0.190	1,000	1,150	1,020	1,100	100
NRS2012T 4R7M GJ	RoHS	4.7	±20%	—	0.241	900	1,050	910	1,000	100

●NRV2010 type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]				Measuring frequency [kHz]
						Saturation current: Idc1		Temperature rise current: Idc2		
						Max.	Typ.	Max.	Typ.	
NRV2010T R47N GF	RoHS	0.47	±30%	—	0.052	2,100	2,250	2,000	2,300	100
NRV2010T R68N GF	RoHS	0.68	±30%	—	0.060	1,850	2,000	1,850	2,100	100
NRV2010T 1R0N GF	RoHS	1.0	±30%	—	0.080	1,550	1,700	1,600	1,850	100
NRV2010T 1R5M GF	RoHS	1.5	±20%	—	0.100	1,350	1,450	1,450	1,650	100
NRV2010T 2R2M GF	RoHS	2.2	±20%	—	0.175	1,100	1,200	1,100	1,200	100
NRV2010T 3R3M GF	RoHS	3.3	±20%	—	0.250	880	950	1,000	1,100	100
NRV2010T 4R7M GF	RoHS	4.7	±20%	—	0.320	760	810	820	930	100

●NRV2012 type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]				Measuring frequency [kHz]
						Saturation current: Idc1		Temperature rise current: Idc2		
						Max.	Typ.	Max.	Typ.	
NRV2012T 1R0N GF	RoHS	1.0	±30%	—	0.073	2,200	2,350	1,650	1,830	100
NRV2012T 1R5N GF	RoHS	1.5	±30%	—	0.100	1,800	1,950	1,400	1,550	100
NRV2012T 2R2M GF	RoHS	2.2	±20%	—	0.129	1,600	1,700	1,200	1,350	100
NRV2012T 3R3M GF	RoHS	3.3	±20%	—	0.227	1,250	1,350	900	1,040	100
NRV2012T 4R7M GF	RoHS	4.7	±20%	—	0.325	1,100	1,150	750	850	100

●NRH2410 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1	Temperature rise current: Idc2	
						Max.	Max.	
NRH2410T R68NN 4	RoHS	0.68	±30%	120	0.060	2,200	1,570	100
NRH2410T 1R0NN 4	RoHS	1.0	±30%	106	0.070	1,800	1,410	100
NRH2410T 1R5MN	RoHS	1.5	±20%	94	0.110	1,550	1,160	100
NRH2410T 2R2MN	RoHS	2.2	±20%	77	0.150	1,290	970	100
NRH2410T 3R3MN	RoHS	3.3	±20%	56	0.220	1,000	770	100
NRH2410T 4R7MN	RoHS	4.7	±20%	50	0.290	880	670	100
NRH2410T 6R8MN	RoHS	6.8	±20%	43	0.410	750	570	100
NRH2410T 100MN	RoHS	10	±20%	32	0.690	550	450	100
NRH2410T 150MN	RoHS	15	±20%	27	1.02	470	370	100
NRH2410T 220MN	RoHS	22	±20%	22	1.47	390	300	100

●NRH2412 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1	Temperature rise current: Idc2	
						Max.	Max.	
NRH2412T R47NNGJ	RoHS	0.47	±30%	180	0.050	2,900	2,100	100
NRH2412T 1R0NNGH	RoHS	1.0	±30%	101	0.077	2,350	1,300	100
NRH2412T 1R5NNGH	RoHS	1.5	±30%	89	0.100	2,100	1,150	100
NRH2412T 2R2MNGH	RoHS	2.2	±20%	72	0.140	1,700	1,000	100
NRH2412T 3R3MNGH	RoHS	3.3	±20%	56	0.225	1,400	750	100
NRH2412T 4R7MNGH	RoHS	4.7	±20%	45	0.300	1,150	650	100
NRH2412T 6R8MNGH	RoHS	6.8	±20%	34	0.420	950	550	100
NRH2412T 100MNGH	RoHS	10	±20%	29	0.600	810	450	100

●NRH3010 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1	Temperature rise current: Idc2	
						Max.	Max.	
NRH3010T 1R2NN	RoHS	1.2	±30%	120	0.065	1,700	1,480	100
NRH3010T 1R5NN	RoHS	1.5	±30%	99	0.075	1,440	1,370	100
NRH3010T 2R2MN	RoHS	2.2	±20%	86	0.083	1,300	1,300	100
NRH3010T 3R3MN	RoHS	3.3	±20%	64	0.130	1,000	1,030	100
NRH3010T 4R7MN	RoHS	4.7	±20%	50	0.170	850	900	100
NRH3010T 6R8MN	RoHS	6.8	±20%	44	0.250	700	745	100
NRH3010T 100MN	RoHS	10	±20%	34	0.350	600	620	100
NRH3010T 150MN	RoHS	15	±20%	25	0.550	450	480	100
NRH3010T 220MN	RoHS	22	±20%	22	0.770	380	410	100
NRH3010T 470MN	RoHS	47	±20%	17	2.050	250	285	100

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20℃)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40℃. (at 20℃)
※) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

▶This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PARTS NUMBER

●NRH3012 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRH3012T R47NN	RoHS	0.47	±30%	160	0.033	2,600	1,900	100
NRH3012T 1R0NN	RoHS	1.0	±30%	111	0.048	2,200	1,710	100
NRH3012T 1R5NN	RoHS	1.5	±30%	95	0.055	1,700	1,600	100
NRH3012T 2R2MN	RoHS	2.2	±20%	78	0.075	1,500	1,370	100
NRH3012T 3R3MN	RoHS	3.3	±20%	61	0.100	1,200	1,210	100
NRH3012T 4R7MN	RoHS	4.7	±20%	50	0.130	1,000	1,060	100
NRH3012T 6R8MN	RoHS	6.8	±20%	43	0.190	850	890	100
NRH3012T 100MN	RoHS	10	±20%	32	0.270	730	720	100
NRH3012T 150MN	RoHS	15	±20%	26	0.450	530	570	100
NRH3012T 220MN	RoHS	22	±20%	22	0.630	500	500	100

●NRV3012 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRV3012T 1R0N	RoHS	1.0	±30%	110	0.065	2,500	1,600	100
NRV3012T 1R5N	RoHS	1.5	±30%	92	0.075	2,100	1,400	100
NRV3012T 2R2M	RoHS	2.2	±20%	70	0.120	1,800	1,100	100
NRV3012T 3R3M	RoHS	3.3	±20%	55	0.150	1,600	1,000	100
NRV3012T 4R7M	RoHS	4.7	±20%	48	0.190	1,250	850	100
NRV3012T 6R8M	RoHS	6.8	±20%	40	0.300	950	650	100
NRV3012T 100M	RoHS	10	±20%	32	0.470	800	550	100

●NRS3015 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]				Measuring frequency [kHz]
						Saturation current: Idc1		Temperature rise current: Idc2		
						Max.	Typ.	Max.	Typ.	
NRS3015T 1R0NNGH	RoHS	1.0	±30%	100	0.030	2,100	2,400	2,100	2,350	100
NRS3015T 1R5NNGH	RoHS	1.5	±30%	87	0.038	1,800	2,100	1,820	2,100	100
NRS3015T 2R2MNGH	RoHS	2.2	±20%	64	0.058	1,480	1,700	1,500	1,800	100
NRS3015T 3R3MNGH	RoHS	3.3	±20%	49	0.078	1,210	1,400	1,230	1,500	100
NRS3015T 4R7MNGH	RoHS	4.7	±20%	40	0.120	1,020	1,100	1,040	1,300	100
NRS3015T 6R8MNGH	RoHS	6.8	±20%	36	0.160	870	920	880	1,100	100
NRS3015T 100MNGH	RoHS	10	±20%	28	0.220	700	750	710	840	100
NRS3015T 220MNGH	RoHS	22	±20%	20	0.520	470	540	470	530	100

●NRS4010 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS4010T 1R0NDGG	RoHS	1.0	±30%	116	0.056	2,000	1,900	100
NRS4010T 2R2MDGG	RoHS	2.2	±20%	73	0.085	1,200	1,500	100
NRS4010T 3R3MDGG	RoHS	3.3	±20%	58	0.100	1,100	1,400	100
NRS4010T 4R7MDGG	RoHS	4.7	±20%	47	0.140	950	1,200	100
NRS4010T 6R8MDGG	RoHS	6.8	±20%	38	0.200	800	1,000	100
NRS4010T 100MDGG	RoHS	10	±20%	31	0.300	620	750	100
NRS4010T 150MDGG	RoHS	15	±20%	24	0.430	540	600	100
NRS4010T 220MDGG	RoHS	22	±20%	19	0.570	450	500	100

●NRS4012 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS4012T 1R0NDGG	RoHS	1.0	±30%	100	0.042	2,800	2,200	100
NRS4012T 2R2MDGJ	RoHS	2.2	±20%	70	0.060	1,650	1,900	100
NRS4012T 3R3MDGJ	RoHS	3.3	±20%	60	0.070	1,400	1,700	100
NRS4012T 4R7MDGJ	RoHS	4.7	±20%	45	0.095	1,200	1,500	100
NRS4012T 6R8MDGJ	RoHS	6.8	±20%	35	0.125	900	1,300	100
NRS4012T 100MDGJ	RoHS	10	±20%	30	0.170	800	1,100	100
NRS4012T 150MDGJ	RoHS	15	±20%	24	0.260	650	750	100
NRS4012T 220MDGJ	RoHS	22	±20%	18	0.400	500	620	100

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20℃)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40℃. (at 20℃)
※) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PARTS NUMBER

●NRS4018 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS4018T 1R0NDGJ	RoHS	1.0	±30%	90	0.027	4,000	3,200	100
NRS4018T 2R2MDGJ	RoHS	2.2	±20%	60	0.042	3,000	2,200	100
NRS4018T 3R3MDGJ	RoHS	3.3	±20%	45	0.055	2,300	2,000	100
NRS4018T 4R7MDGJ	RoHS	4.7	±20%	35	0.070	2,000	1,700	100
NRS4018T 6R8MDGJ	RoHS	6.8	±20%	30	0.098	1,600	1,450	100
NRS4018T 100MDGJ	RoHS	10	±20%	25	0.150	1,300	1,200	100
NRS4018T 150MDGJ	RoHS	15	±20%	18	0.210	1,100	850	100
NRS4018T 220MDGJ	RoHS	22	±20%	15	0.290	900	720	100
NRS4018T 330MDGJ	RoHS	33	±20%	12	0.460	700	550	100
NRS4018T 470MDGJ	RoHS	47	±20%	10	0.650	600	440	100
NRS4018T 680MDGJ	RoHS	68	±20%	8.3	1.00	520	320	100
NRS4018T 101MDGJ	RoHS	100	±20%	6.5	1.45	420	280	100
NRS4018T 151MDGJ	RoHS	150	±20%	5.5	2.30	340	220	100
NRS4018T 221MDGJ	RoHS	220	±20%	4.0	3.80	275	170	100

●NRS5010 type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS5010T 1R0NMGF	RoHS	1.0	±30%	95	0.070	2,350	1,750	100
NRS5010T 2R2NMGF	RoHS	2.2	±30%	65	0.105	1,500	1,400	100
NRS5010T 3R3MMGF	RoHS	3.3	±20%	42	0.125	1,400	1,250	100
NRS5010T 4R7MMGF	RoHS	4.7	±20%	37	0.145	1,200	1,150	100
NRS5010T 6R8MMGF	RoHS	6.8	±20%	33	0.185	1,000	1,000	100
NRS5010T 100MMGF	RoHS	10	±20%	23	0.250	850	900	100
NRS5010T 150MMGF	RoHS	15	±20%	19	0.400	680	650	100
NRS5010T 220MMGF	RoHS	22	±20%	15	0.600	550	450	100

●NRS5012 type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS5012T 1R0NMGF	RoHS	1.0	±30%	100	0.053	4,500	2,300	100
NRS5012T 1R5NMGF	RoHS	1.5	±30%	86	0.070	3,800	2,200	100
NRS5012T 2R2MMGF	RoHS	2.2	±20%	70	0.085	3,100	2,000	100
NRS5012T 3R3MMGF	RoHS	3.3	±20%	48	0.160	2,400	1,450	100
NRS5012T 4R7MMGF	RoHS	4.7	±20%	40	0.180	2,200	1,400	100
NRS5012T 6R8MMGF	RoHS	6.8	±20%	36	0.260	1,700	1,100	100
NRS5012T 100MMGF	RoHS	10	±20%	26	0.420	1,400	850	100
NRS5012T 150MMGF	RoHS	15	±20%	22	0.670	1,200	640	100

●NRS5014 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS5014T R47NMGG	RoHS	0.47	±30%	185	0.025	5,800	3,300	100
NRS5014T 1R2NMGG	RoHS	1.2	±30%	86	0.045	3,800	2,400	100
NRS5014T 2R2NMGG	RoHS	2.2	±30%	56	0.065	2,800	2,000	100
NRS5014T 3R3NMGG	RoHS	3.3	±30%	48	0.080	2,350	1,700	100
NRS5014T 4R7NMGG	RoHS	4.7	±30%	41	0.100	2,050	1,400	100
NRS5014T 6R8MMGG	RoHS	6.8	±20%	33	0.150	1,600	1,200	100
NRS5014T 100MMGG	RoHS	10	±20%	27	0.200	1,400	1,050	100
NRS5014T 150MMGG	RoHS	15	±20%	20	0.320	1,100	650	100
NRS5014T 220MMGG	RoHS	22	±20%	16	0.450	900	550	100

●NRS5020 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS5020T R47NMGJ	RoHS	0.47	±30%	230	0.012	6,100	5,000	100
NRS5020T 1R0NMGJ	RoHS	1.0	±30%	81	0.021	4,000	3,600	100
NRS5020T 1R5NMGJ	RoHS	1.5	±30%	68	0.026	3,350	3,200	100
NRS5020T 2R2NMGJ	RoHS	2.2	±30%	57	0.035	2,900	2,900	100
NRS5020T 3R3NMGJ	RoHS	3.3	±30%	46	0.048	2,400	2,400	100
NRS5020T 4R7MMGJ	RoHS	4.7	±20%	37	0.060	2,000	2,000	100
NRS5020T 6R8MMGJ	RoHS	6.8	±20%	30	0.090	1,600	1,650	100
NRS5020T 100MMGJ	RoHS	10	±20%	24	0.120	1,300	1,450	100
NRS5020T 150MMGJ	RoHS	15	±20%	20	0.165	1,100	1,200	100
NRS5020T 220MMGJ	RoHS	22	±20%	17	0.260	900	1,000	100

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20℃)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40℃. (at 20℃)
※) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

▶This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PARTS NUMBER

●NRS5024 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS5024T 1R0NMGJ	RoHS	1.0	±30%	85	0.016	5,800	4,400	100
NRS5024T 1R5NMGJ	RoHS	1.5	±30%	67	0.022	5,200	3,600	100
NRS5024T 2R2NMGJ	RoHS	2.2	±30%	51	0.029	4,100	3,100	100
NRS5024T 3R3NMGJ	RoHS	3.3	±30%	41	0.043	3,100	2,400	100
NRS5024T 4R7MMGJ	RoHS	4.7	±20%	37	0.055	2,700	2,000	100
NRS5024T 6R8MMGJ	RoHS	6.8	±20%	28	0.080	2,200	1,600	100
NRS5024T 100MMGJ	RoHS	10	±20%	21	0.125	1,700	1,200	100
NRS5024T 150MMGJ	RoHS	15	±20%	18	0.170	1,400	1,000	100
NRS5024T 220MMGJ	RoHS	22	±20%	15	0.230	1,200	820	100
NRS5024T 330MMGJ	RoHS	33	±20%	11	0.370	1,000	630	100

●NRS5030 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]				Measuring frequency [kHz]
						Saturation current: Idc1		Temperature rise current: Idc2		
						Max.	Typ.	Max.	Typ.	
NRS5030T R47NMGJ	RoHS	0.47	±30%	185	0.010	9,000	9,400	5,000	5,900	100
NRS5030T 1R0NMGJ	RoHS	1.0	±30%	110	0.015	6,600	7,400	4,000	4,900	100
NRS5030T 2R2NMGJ	RoHS	2.2	±30%	46	0.023	4,200	5,000	3,500	4,100	100
NRS5030T 3R3MMGJ	RoHS	3.3	±20%	36	0.030	3,600	3,900	3,000	3,600	100
NRS5030T 4R7MMGJ	RoHS	4.7	±20%	31	0.035	3,100	3,500	2,600	3,000	100
NRS5030T 6R8MMGJ	RoHS	6.8	±20%	22	0.052	2,500	2,800	2,300	2,500	100
NRS5030T 100MMGJ	RoHS	10	±20%	20	0.070	2,100	2,300	1,700	2,000	100
NRS5030T 150MMGJ	RoHS	15	±20%	14	0.125	1,600	1,800	1,400	1,550	100
NRS5030T 220MMGJ	RoHS	22	±20%	13	0.180	1,400	1,500	1,050	1,200	100
NRS5030T 330MMGJ	RoHS	33	±20%	10	0.225	1,150	1,250	800	950	100
NRS5030T 470MMGJ	RoHS	47	±20%	9	0.325	950	1,050	700	800	100

●NRS5040 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS5040T 1R5NMGJ	RoHS	1.5	±30%	60	0.017	6,400	4,500	100
NRS5040T 2R2NMGJ	RoHS	2.2	±30%	42	0.022	5,000	3,700	100
NRS5040T 3R3NMGJ	RoHS	3.3	±30%	32	0.027	4,000	3,300	100
NRS5040T 4R7NMGK	RoHS	4.7	±30%	28	0.029	3,300	3,100	100
NRS5040T 6R8MMGJ	RoHS	6.8	±20%	21	0.049	2,800	2,400	100
NRS5040T 100MMGJ	RoHS	10	±20%	18	0.056	2,300	2,100	100
NRS5040T 150MMGJ	RoHS	15	±20%	13	0.080	2,000	1,800	100
NRS5040T 220MMGK	RoHS	22	±20%	9	0.126	1,500	1,400	100
NRS5040T 330MMGJ	RoHS	33	±20%	7	0.180	1,300	1,200	100
NRS5040T 470MMGJ	RoHS	47	±20%	6	0.310	1,100	900	100

●NRS6010 type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS6010T 1R5MMGF	RoHS	1.5	±20%	77	0.090	2,400	1,900	100
NRS6010T 2R2MMGF	RoHS	2.2	±20%	56	0.110	1,900	1,700	100
NRS6010T 3R3MMGF	RoHS	3.3	±20%	42	0.135	1,600	1,500	100
NRS6010T 4R7MMGF	RoHS	4.7	±20%	36	0.165	1,300	1,400	100
NRS6010T 6R8MMGF	RoHS	6.8	±20%	30	0.220	1,200	1,200	100
NRS6010T 100MMGF	RoHS	10	±20%	25	0.270	1,000	1,100	100
NRS6010T 220MMGF	RoHS	22	±20%	12	0.580	650	700	100

●NRS6012 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS6012T 1R0NMGJ	RoHS	1.0	±30%	95	0.050	3,000	2,400	100
NRS6012T 1R5NMGG	RoHS	1.5	±30%	69	0.067	2,600	2,100	100
NRS6012T 2R5NMGG	RoHS	2.5	±30%	45	0.090	2,100	1,800	100
NRS6012T 3R3NMGG	RoHS	3.3	±30%	42	0.105	1,800	1,700	100
NRS6012T 4R7MMGG	RoHS	4.7	±20%	36	0.125	1,600	1,550	100
NRS6012T 5R3MMGJ	RoHS	5.3	±20%	34	0.125	1,500	1,550	100
NRS6012T 6R8MMGJ	RoHS	6.8	±20%	30	0.165	1,300	1,350	100
NRS6012T 100MMGJ	RoHS	10	±20%	22	0.200	1,000	1,200	100
NRS6012T 150MMGJ	RoHS	15	±20%	18	0.295	800	800	100
NRS6012T 220MMGJ	RoHS	22	±20%	12	0.465	760	650	100
NRS6012T 330MMGJ	RoHS	33	±20%	8	0.580	590	550	100
NRS6012T 470MMGJ	RoHS	47	±20%	6	0.965	520	460	100
NRS6012T 680MMGJ	RoHS	68	±20%	3	1.16	440	410	100
NRS6012T 101MMGJ	RoHS	100	±20%	1	1.67	350	320	100

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)
※) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PARTS NUMBER

●NRS6014 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS6014T 1R2NMGG	RoHS	1.2	±30%	77	0.042	4,000	2,750	100
NRS6014T 2R2NMGG	RoHS	2.2	±30%	61	0.055	3,000	2,300	100
NRS6014T 3R3NMGG	RoHS	3.3	±30%	41	0.075	2,500	2,000	100
NRS6014T 4R7MMGG	RoHS	4.7	±20%	36	0.090	2,000	1,900	100
NRS6014T 6R8MMGG	RoHS	6.8	±20%	30	0.115	1,700	1,650	100
NRS6014T 100MMGG	RoHS	10	±20%	24	0.140	1,400	1,400	100
NRS6014T 150MMGG	RoHS	15	±20%	20	0.210	1,150	1,200	100
NRS6014T 220MMGG	RoHS	22	±20%	16	0.300	950	1,000	100

●NRS6020 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS6020T 0R8NMGG	RoHS	0.8	±30%	110	0.020	6,400	4,100	100
NRS6020T 1R5NMGJ	RoHS	1.5	±30%	93	0.026	4,300	3,600	100
NRS6020T 2R2NMGJ	RoHS	2.2	±30%	73	0.034	3,200	2,900	100
NRS6020T 3R3NMGJ	RoHS	3.3	±30%	55	0.040	2,800	2,750	100
NRS6020T 4R7NMGJ	RoHS	4.7	±30%	43	0.058	2,400	2,150	100
NRS6020T 6R8NMGJ	RoHS	6.8	±30%	30	0.085	2,000	1,800	100
NRS6020T 100MMGG	RoHS	10	±20%	18	0.125	1,900	1,500	100
NRS6020T 220MMGG	RoHS	22	±20%	11	0.290	1,250	950	100

●NRS6028 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]				Measuring frequency [kHz]
						Saturation current: Idc1		Temperature rise current: Idc2		
						Max.	Typ.	Max.	Typ.	
NRS6028T 0R9NMGJ	RoHS	0.9	±30%	90	0.013	6,700	7,900	4,600	5,200	100
NRS6028T 1R5NMGJ	RoHS	1.5	±30%	78	0.016	5,100	6,100	4,200	4,700	100
NRS6028T 2R2NMGJ	RoHS	2.2	±30%	68	0.020	4,200	5,100	3,700	4,200	100
NRS6028T 3R0NMGJ	RoHS	3.0	±30%	55	0.023	3,600	4,300	3,400	3,900	100
NRS6028T 4R7MMGK	RoHS	4.7	±20%	39	0.031	2,700	3,300	3,000	3,400	100
NRS6028T 6R8MMGJ	RoHS	6.8	±20%	25	0.043	2,600	3,000	2,500	2,900	100
NRS6028T 100MMGK	RoHS	10	±20%	20	0.065	1,900	2,200	1,900	2,200	100
NRS6028T 150MMGJ	RoHS	15	±20%	17	0.095	1,600	1,900	1,800	1,900	100
NRS6028T 220MMGJ	RoHS	22	±20%	12	0.135	1,300	1,600	1,400	1,600	100
NRS6028T 330MMGJ	RoHS	33	±20%	10	0.220	1,100	1,300	1,100	1,250	100
NRS6028T 470MMGJ	RoHS	47	±20%	8	0.300	1,000	1,150	920	1,050	100
NRS6028T 680MMGJ	RoHS	68	±20%	5	0.420	800	950	770	880	100
NRS6028T 101MMGJ	RoHS	100	±20%	3	0.600	650	750	660	750	100

●NRS6045 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]				Measuring frequency [kHz]
						Saturation current: Idc1		Temperature rise current: Idc2		
						Max.	Typ.	Max.	Typ.	
NRS6045T 1R0NMGK	RoHS	1.0	±30%	110	0.014	9,800	11,000	4,500	5,200	100
NRS6045T 1R3NMGK	RoHS	1.3	±30%	95	0.016	8,200	9,300	4,200	4,800	100
NRS6045T 1R8NMGK	RoHS	1.8	±30%	80	0.019	7,200	8,100	3,900	4,400	100
NRS6045T 2R3NMGK	RoHS	2.3	±30%	60	0.022	6,400	7,300	3,600	4,100	100
NRS6045T 3R0NMGK	RoHS	3.0	±30%	45	0.024	5,600	6,500	3,300	4,000	100
NRS6045T 4R5MMGK	RoHS	4.5	±20%	25	0.030	4,400	5,400	3,100	3,600	100
NRS6045T 6R3MMGK	RoHS	6.3	±20%	15	0.036	3,600	4,300	3,000	3,300	100
NRS6045T 100MMGK	RoHS	10	±20%	12	0.046	3,100	3,600	2,400	2,800	100
NRS6045T 150MMGK	RoHS	15	±20%	10	0.070	2,500	3,000	1,900	2,300	100
NRS6045T 220MMGK	RoHS	22	±20%	7	0.107	2,000	2,400	1,600	1,900	100
NRS6045T 330MMGK	RoHS	33	±20%	6	0.141	1,650	2,000	1,400	1,600	100
NRS6045T 470MMGK	RoHS	47	±20%	5	0.211	1,400	1,600	1,150	1,350	100
NRS6045T 680MMGK	RoHS	68	±20%	4	0.304	1,100	1,300	950	1,100	100
NRS6045T 101MMGK	RoHS	100	±20%	3	0.466	900	1,200	750	900	100

●NRS8030 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS8030T 1R0NJGJ	RoHS	1.0	±30%	120	0.009	7,800	6,200	100
NRS8030T 1R5NJGJ	RoHS	1.5	±30%	80	0.012	6,200	5,300	100
NRS8030T 2R2NJGJ	RoHS	2.2	±30%	60	0.015	4,900	4,800	100
NRS8030T 3R3MJGJ	RoHS	3.3	±20%	50	0.019	4,200	4,300	100
NRS8030T 4R7MJGJ	RoHS	4.7	±20%	40	0.022	3,600	4,000	100
NRS8030T 6R8MJGJ	RoHS	6.8	±20%	32	0.029	3,000	3,400	100
NRS8030T 100MJGJ	RoHS	10	±20%	27	0.033	2,400	3,000	100
NRS8030T 150MJGJ	RoHS	15	±20%	20	0.060	2,000	2,200	100
NRS8030T 220MJGJ	RoHS	22	±20%	16	0.070	1,750	1,900	100
NRS8030T 330MJGJ	RoHS	33	±20%	13	0.120	1,300	1,500	100
NRS8030T 470MJGJ	RoHS	47	±20%	11	0.170	1,100	1,300	100

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20℃)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40℃. (at 20℃)
※) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

▶This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PARTS NUMBER

●NRS8040 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NRS8040T 0R9NJGJ	RoHS	0.9	±30%	85	0.006	13,000	7,800	100
NRS8040T 1R4NJGJ	RoHS	1.4	±30%	63	0.007	10,000	7,000	100
NRS8040T 2R0NJGJ	RoHS	2.0	±30%	50	0.009	8,100	6,300	100
NRS8040T 3R6NJGJ	RoHS	3.6	±30%	34	0.015	6,400	4,900	100
NRS8040T 4R7NJGJ	RoHS	4.7	±30%	30	0.018	5,400	4,100	100
NRS8040T 6R8NJGJ	RoHS	6.8	±30%	24	0.025	4,400	3,700	100
NRS8040T 100MJGJ	RoHS	10	±20%	22	0.034	3,800	3,100	100
NRS8040T 150MJGJ	RoHS	15	±20%	16	0.050	2,900	2,400	100
NRS8040T 220MJGJ	RoHS	22	±20%	13	0.066	2,400	2,200	100
NRS8040T 330MJGK	RoHS	33	±20%	12	0.100	2,000	1,700	100
NRS8040T 470MJGK	RoHS	47	±20%	8	0.140	1,500	1,500	100
NRS8040T 101MJGK	RoHS	100	±20%	6	0.280	1,100	1,000	100

●NR 3010 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NR 3010T 1R0N	RoHS	1.0	±30%	126	0.065	1,300	1,400	100
NR 3010T 1R5N	RoHS	1.5	±30%	98	0.080	1,200	1,300	100
NR 3010T 2R2M	RoHS	2.2	±20%	82	0.095	1,100	1,100	100
NR 3010T 3R3M	RoHS	3.3	±20%	63	0.140	870	940	100
NR 3010T 4R7M	RoHS	4.7	±20%	56	0.190	750	780	100
NR 3010T 6R8M	RoHS	6.8	±20%	46	0.300	610	630	100
NR 3010T 100M	RoHS	10	±20%	35	0.450	500	510	100
NR 3010T 150M	RoHS	15	±20%	30	0.740	400	400	100
NR 3010T 220M	RoHS	22	±20%	25	1.03	350	350	100
NR 3010T 330M	RoHS	33	±20%	20	1.55	260	275	100
NR 3010T 470M	RoHS	47	±20%	17	2.05	220	235	100

●NR 3012 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NR 3012T 1R0N	RoHS	1.0	±30%	110	0.050	1,500	1,490	100
NR 3012T 1R5N	RoHS	1.5	±30%	92	0.060	1,360	1,400	100
NR 3012T 2R2M	RoHS	2.2	±20%	70	0.080	1,100	1,200	100
NR 3012T 3R3M	RoHS	3.3	±20%	55	0.100	910	1,050	100
NR 3012T 4R7M	RoHS	4.7	±20%	48	0.130	770	980	100
NR 3012T 6R8M	RoHS	6.8	±20%	40	0.190	670	740	100
NR 3012T 100M	RoHS	10	±20%	32	0.290	540	630	100
NR 3012T 150M	RoHS	15	±20%	27	0.450	440	485	100
NR 3012T 220M	RoHS	22	±20%	22	0.630	375	420	100
NR 3012T 330M	RoHS	33	±20%	19	1.03	310	330	100
NR 3012T 470M	RoHS	47	±20%	17	1.45	250	280	100

●NR 3015 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NR 3015T 1R0N	RoHS	1.0	±30%	100	0.030	2,100	2,100	100
NR 3015T 1R5N	RoHS	1.5	±30%	87	0.040	1,800	1,820	100
NR 3015T 2R2M	RoHS	2.2	±20%	64	0.060	1,480	1,500	100
NR 3015T 3R3M	RoHS	3.3	±20%	49	0.080	1,210	1,230	100
NR 3015T 4R7M	RoHS	4.7	±20%	40	0.120	1,020	1,040	100
NR 3015T 6R8M	RoHS	6.8	±20%	36	0.160	870	880	100
NR 3015T 100M	RoHS	10	±20%	28	0.230	700	710	100
NR 3015T 150M	RoHS	15	±20%	23	0.360	560	560	100
NR 3015T 220M	RoHS	22	±20%	20	0.520	470	470	100
NR 3015T 330M	RoHS	33	±20%	18	0.840	390	370	100
NR 3015T 470M	RoHS	47	±20%	17	1.34	320	300	100

●NR 4010 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NR 4010T 1R0N	RoHS	1.0	±30%	116	0.100	1,800	1,050	100
NR 4010T 2R2N	RoHS	2.2	±30%	73	0.150	1,150	890	100
NR 4010T 3R3M	RoHS	3.3	±20%	58	0.180	1,100	820	100
NR 4010T 4R7M	RoHS	4.7	±20%	47	0.210	900	750	100
NR 4010T 6R8M	RoHS	6.8	±20%	38	0.300	740	620	100
NR 4010T 100M	RoHS	10	±20%	31	0.380	560	600	100
NR 4010T 150M	RoHS	15	±20%	24	0.510	470	510	100
NR 4010T 220M	RoHS	22	±20%	19	0.870	360	400	100
NR 4010T 330M	RoHS	33	±20%	15	1.54	280	300	100
NR 4010T 470M	RoHS	47	±20%	13	1.81	240	280	100

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20℃)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40℃. (at 20℃)
※) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PARTS NUMBER

●NR 4012 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NR 4012T 1R0N	RoHS	1.0	±30%	131	0.060	2,500	1,500	100
NR 4012T 2R2M	RoHS	2.2	±20%	66	0.090	1,650	1,200	100
NR 4012T 3R3M	RoHS	3.3	±20%	50	0.130	1,200	980	100
NR 4012T 4R7M	RoHS	4.7	±20%	45	0.140	1,050	960	100
NR 4012T 6R8M	RoHS	6.8	±20%	35	0.180	900	840	100
NR 4012T 100M	RoHS	10	±20%	28	0.240	740	770	100
NR 4012T 150M	RoHS	15	±20%	23	0.400	560	600	100
NR 4012T 220M	RoHS	22	±20%	18	0.480	510	540	100
NR 4012T 330M	RoHS	33	±20%	15	0.810	400	420	100
NR 4012T 470M	RoHS	47	±20%	12	1.00	350	370	100

●NR 4018 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NR 4018T 1R0N	RoHS	1.0	±30%	80	0.030	4,000	1,830	100
NR 4018T 2R2M	RoHS	2.2	±20%	52	0.060	2,700	1,440	100
NR 4018T 3R3M	RoHS	3.3	±20%	44	0.070	2,000	1,230	100
NR 4018T 4R7M	RoHS	4.7	±20%	34	0.090	1,700	1,200	100
NR 4018T 6R8M	RoHS	6.8	±20%	29	0.110	1,450	1,060	100
NR 4018T 100M	RoHS	10	±20%	24	0.180	1,200	840	100
NR 4018T 150M	RoHS	15	±20%	19	0.250	940	650	100
NR 4018T 220M	RoHS	22	±20%	16	0.360	800	590	100
NR 4018T 330M	RoHS	33	±20%	12	0.530	650	490	100
NR 4018T 470M	RoHS	47	±20%	10	0.650	570	420	100
NR 4018T 680M	RoHS	68	±20%	8.3	1.00	470	320	100
NR 4018T 101M	RoHS	100	±20%	6.5	1.50	400	270	100
NR 4018T 151M	RoHS	150	±20%	5.5	2.50	310	220	100
NR 4018T 221M	RoHS	220	±20%	4.0	4.00	270	170	100

●NR 5040 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NR 5040T 1R5N	RoHS	1.5	±30%	60	0.020	6,000	3,600	100
NR 5040T 2R2N	RoHS	2.2	±30%	42	0.022	4,600	3,500	100
NR 5040T 3R3N	RoHS	3.3	±30%	32	0.027	3,800	3,300	100
NR 5040T 4R7N	RoHS	4.7	±30%	28	0.029	3,300	3,100	100
NR 5040T 6R8M	RoHS	6.8	±20%	21	0.049	2,600	2,300	100
NR 5040T 100M	RoHS	10	±20%	18	0.056	2,300	2,100	100
NR 5040T 150M	RoHS	15	±20%	13	0.080	2,000	1,800	100
NR 5040T 220M	RoHS	22	±20%	9	0.126	1,600	1,400	100
NR 5040T 330M	RoHS	33	±20%	7	0.180	1,300	1,200	100
NR 5040T 470M	RoHS	47	±20%	6	0.310	1,100	900	100

●NR 6012 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NR 6012T 2R5NE	RoHS	2.5	±30%	45	0.090	2,100	1,730	100
NR 6012T 4R0NE	RoHS	4.0	±30%	39	0.105	1,800	1,570	100
NR 6012T 5R3ME	RoHS	5.3	±20%	34	0.125	1,500	1,400	100
NR 6012T 6R8ME	RoHS	6.8	±20%	30	0.165	1,300	1,180	100
NR 6012T 100ME	RoHS	10	±20%	22	0.235	1,000	1,000	100
NR 6012T 150ME	RoHS	15	±20%	18	0.330	800	790	100
NR 6012T 220ME	RoHS	22	±20%	12	0.530	760	630	100
NR 6012T 330ME	RoHS	33	±20%	8	0.700	590	530	100
NR 6012T 470ME	RoHS	47	±20%	6	1.05	520	460	100
NR 6012T 680ME	RoHS	68	±20%	3	1.35	440	410	100
NR 6012T 101ME	RoHS	100	±20%	1	2.18	350	320	100

●NR 6020 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NR 6020T 0R8N	RoHS	0.8	±30%	110	0.020	5,500	3,800	100
NR 6020T 1R5N	RoHS	1.5	±30%	93	0.026	4,000	3,200	100
NR 6020T 2R2N	RoHS	2.2	±30%	73	0.034	3,200	2,700	100
NR 6020T 3R3N	RoHS	3.3	±30%	55	0.040	2,800	2,600	100
NR 6020T 4R7N	RoHS	4.7	±30%	43	0.058	2,400	2,000	100
NR 6020T 6R8N	RoHS	6.8	±30%	30	0.085	2,000	1,800	100
NR 6020T 100M	RoHS	10	±20%	18	0.125	1,700	1,400	100
NR 6020T 220M	RoHS	22	±20%	11	0.290	1,050	950	100

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)
※) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

▶This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PARTS NUMBER

●NR 6028 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NR 6028T 0R9N	RoHS	0.9	±30%	90	0.013	6,600	4,600	100
NR 6028T 1R5N	RoHS	1.5	±30%	78	0.016	5,000	4,200	100
NR 6028T 2R2N	RoHS	2.2	±30%	68	0.020	4,200	3,700	100
NR 6028T 3R0N	RoHS	3.0	±30%	55	0.023	3,600	3,400	100
NR 6028T 4R7M	RoHS	4.7	±20%	39	0.031	2,700	3,000	100
NR 6028T 6R0M	RoHS	6.0	±20%	30	0.040	2,500	2,500	100
NR 6028T 100M	RoHS	10	±20%	20	0.065	1,900	1,900	100
NR 6028T 150M	RoHS	15	±20%	17	0.095	1,600	1,800	100
NR 6028T 220M	RoHS	22	±20%	12	0.135	1,300	1,400	100
NR 6028T 330M	RoHS	33	±20%	10	0.220	1,100	1,100	100
NR 6028T 470M	RoHS	47	±20%	8	0.300	950	920	100
NR 6028T 680M	RoHS	68	±20%	5	0.420	760	770	100
NR 6028T 101M	RoHS	100	±20%	3	0.600	620	660	100

●NR 6045 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NR 6045T 1R0N	RoHS	1.0	±30%	110	0.014	8,500	4,200	100
NR 6045T 1R3N	RoHS	1.3	±30%	95	0.016	8,000	4,000	100
NR 6045T 1R8N	RoHS	1.8	±30%	80	0.018	7,000	3,700	100
NR 6045T 2R3N	RoHS	2.3	±30%	60	0.021	6,000	3,500	100
NR 6045T 3R0N	RoHS	3.0	±30%	45	0.024	5,000	3,200	100
NR 6045T 4R5M	RoHS	4.5	±20%	25	0.031	4,000	3,000	100
NR 6045T 6R3M	RoHS	6.3	±20%	15	0.038	3,800	2,800	100
NR 6045T 100M	RoHS	10	±20%	12	0.047	3,000	2,500	100
NR 6045T 150M	RoHS	15	±20%	10	0.077	2,300	1,900	100
NR 6045T 220M	RoHS	22	±20%	7	0.115	1,900	1,500	100
NR 6045T 330M	RoHS	33	±20%	6	0.145	1,500	1,400	100
NR 6045T 470M	RoHS	47	±20%	5	0.220	1,300	1,100	100
NR 6045T 680M	RoHS	68	±20%	4	0.330	1,000	900	100
NR 6045T 101M	RoHS	100	±20%	3	0.500	800	700	100

●NR 8040 Shielded type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current: Idc1 Max.	Temperature rise current: Idc2 Max.	
NR 8040T 0R9N	RoHS	0.9	±30%	85	0.006	11,000	7,800	100
NR 8040T 1R4N	RoHS	1.4	±30%	63	0.007	9,000	7,000	100
NR 8040T 2R0N	RoHS	2.0	±30%	50	0.009	7,400	6,300	100
NR 8040T 3R6N	RoHS	3.6	±30%	34	0.015	5,300	4,900	100
NR 8040T 4R7N	RoHS	4.7	±30%	30	0.018	4,700	4,100	100
NR 8040T 6R8N	RoHS	6.8	±30%	24	0.025	4,000	3,700	100
NR 8040T 100M	RoHS	10	±20%	22	0.034	3,400	3,100	100
NR 8040T 150M	RoHS	15	±20%	16	0.050	2,700	2,400	100
NR 8040T 220M	RoHS	22	±20%	13	0.066	2,200	2,200	100
NR 8040T 330M	RoHS	33	±20%	12	0.100	1,900	1,700	100
NR 8040T 470M	RoHS	47	±20%	8	0.150	1,500	1,400	100
NR 8040T 680M	RoHS	68	±20%	7	0.230	1,200	1,100	100
NR 8040T 101M	RoHS	100	±20%	6	0.290	1,000	1,000	100

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)
※) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PACKAGING

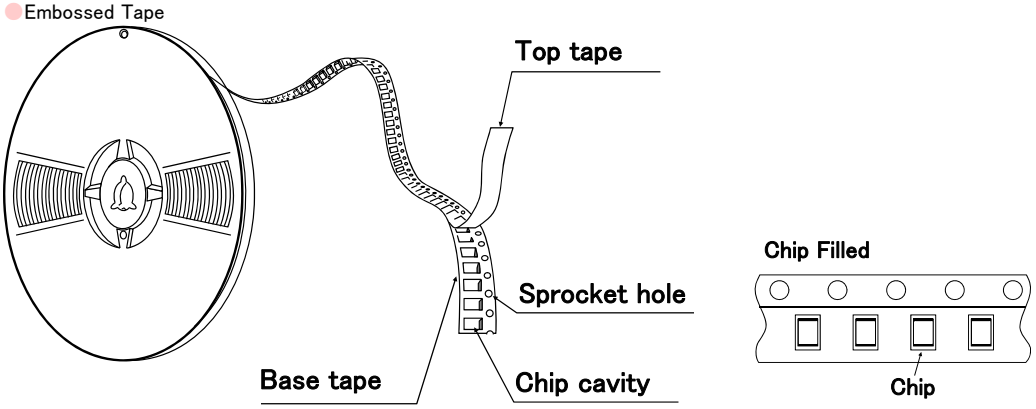
①Minimum Quantity

Type	Standard Quantity [pcs]
	Tape & Reel
NRV2010	2500
NRS2012 NRV2012	2500
NRH2410	2500
NRH2412	2500
NR 3010 NRH3010	2000
NR 3012 NRH3012 NRV3012	2000
NR 3015 NRS3015	2000
NR 4010 NRS4010	5000
NR 4012 NRS4012	4500
NR 4018 NRS4018	3500

Type	Standard Quantity [pcs]
	Tape & Reel
NRS5010	1000
NRS5012	1000
NRS5014	1000
NRS5020	800
NRS5024	2500
NRS5030	500
NR 5040 NRS5040	1500
NRS6010	1000
NR 6012 NRS6012	1000
NRS6014	1000
NR 6020 NRS6020	2500
NR 6028 NRS6028	2000
NR 6045 NRS6045	1500
NRS8030	1000
NR 8040 NRS8040	1000

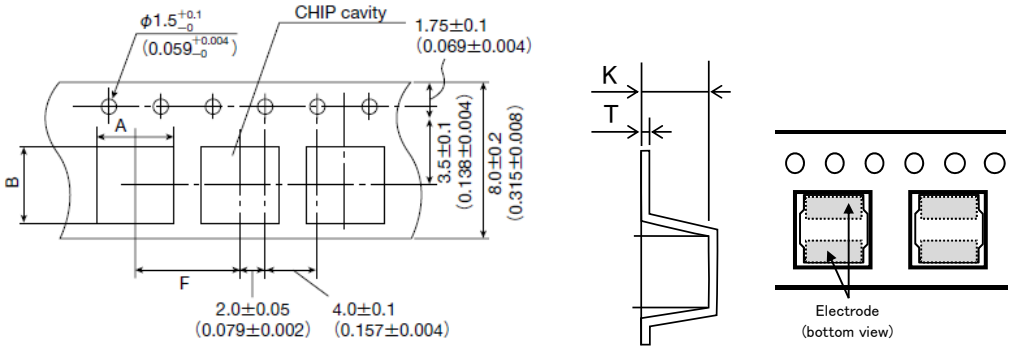
②Tape Material

Embossed Tape



③Taping dimensions

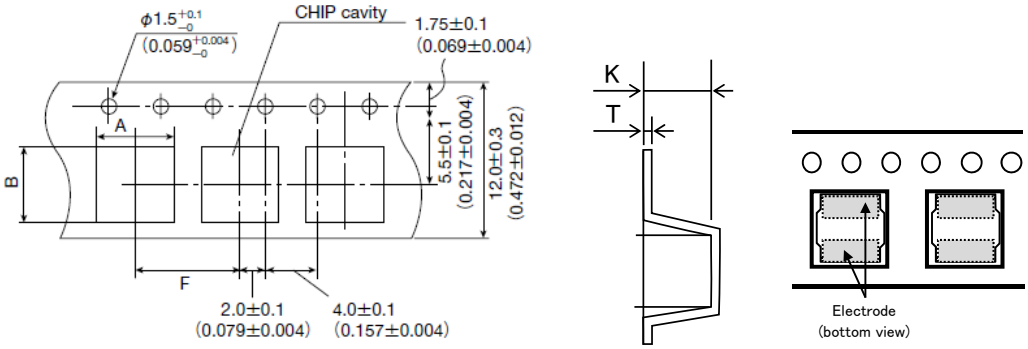
Embossed tape 8mm wide (0.315 inches wide)



Type	Chip cavity		Insertion pitch	Tape thickness	
	A	B	F	T	K
NRV2010	2.2±0.1 (0.102±0.004)	2.2±0.1 (0.102±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.009±0.002)	1.3±0.1 (0.051±0.004)
NRS2012 NRV2012					
NRH2410	2.6±0.1 (0.087±0.004)	2.6±0.1 (0.102±0.004)		0.25±0.05 (0.009±0.002)	1.3±0.1 (0.051±0.004)
NRH2412					
NR 3010 NRH3010	3.2±0.1 (0.126±0.004)	3.2±0.1 (0.126±0.004)		0.3±0.05 (0.012±0.002)	1.4±0.1 (0.055±0.004)
NR 3012 NRH3012 NRV3012					1.6±0.1 (0.063±0.004)
NR 3015 NRS3015					1.9±0.1 (0.075±0.004)

Unit:mm(inch)

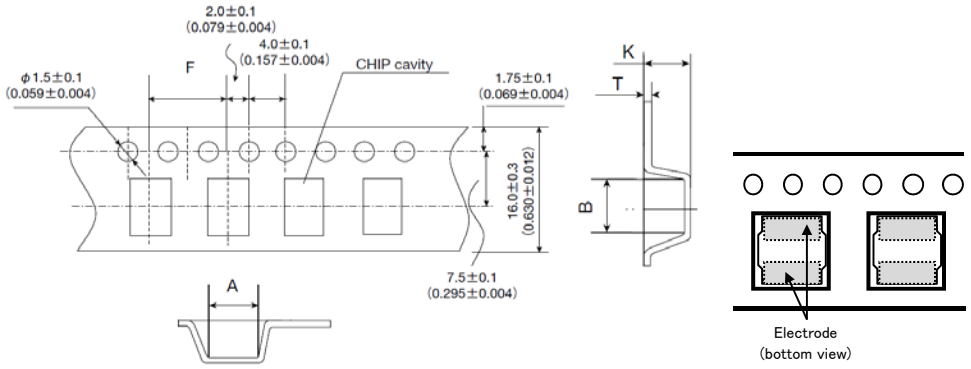
Embossed tape 12mm wide (0.47 inches wide)



Type	Chip cavity		Insertion pitch	Tape thickness	
	A	B	F	T	K
NR 4010 NRS4010	4.3±0.1 (0.169±0.004)	4.3±0.1 (0.169±0.004)	8.0±0.1 (0.315±0.004)	0.3±0.1 (0.012±0.004)	1.4±0.1 (0.055±0.004)
NR 4012 NRS4012					1.6±0.1 (0.063±0.004)
NR 4018 NRS4018					2.1±0.1 (0.083±0.004)
NRS5010	5.25±0.1 (0.207±0.004)	5.25±0.1 (0.207±0.004)			1.4±0.1 (0.055±0.004)
NRS5012					1.4±0.1 (0.055±0.004)
NRS5014					1.6±0.1 (0.063±0.004)
NRS5020					2.3±0.1 (0.091±0.004)
NRS5024					2.7±0.1 (0.106±0.004)
NRS5030	5.15±0.1 (0.203±0.004)	5.15±0.1 (0.203±0.004)		0.4±0.1 (0.016±0.004)	3.2±0.1 (0.126±0.004)
NR 5040 NRS5040	5.15±0.1 (0.203±0.004)	5.15±0.1 (0.203±0.004)			4.2±0.1 (0.165±0.004)
NRS6010	6.3±0.1 (0.248±0.004)	6.3±0.1 (0.248±0.004)			1.4±0.1 (0.055±0.004)
NR 6012 NRS6012					1.6±0.1 (0.063±0.004)
NRS6014					1.6±0.1 (0.063±0.004)
NR 6020 NRS6020					2.3±0.1 (0.090±0.004)
NR 6028 NRS6028					3.1±0.1 (0.122±0.004)
NR 6045 NRS6045					4.7±0.1 (0.185±0.004)

Unit:mm(inch)

Embossed tape 16mm wide (0.63 inches wide)

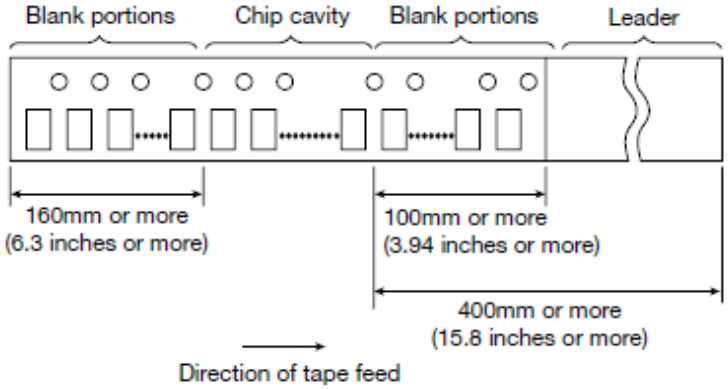


Type	Chip cavity		Insertion pitch	Tape thickness	
	A	B	F	T	K
NRS8030	8.3±0.1 (0.327±0.004)	8.3±0.1 (0.327±0.004)	12.0±0.1 (0.472±0.004)	0.5±0.1 (0.020±0.004)	3.4±0.1 (0.134±0.004)
NR 8040 NRS8040					4.5±0.1 (0.177±0.004)

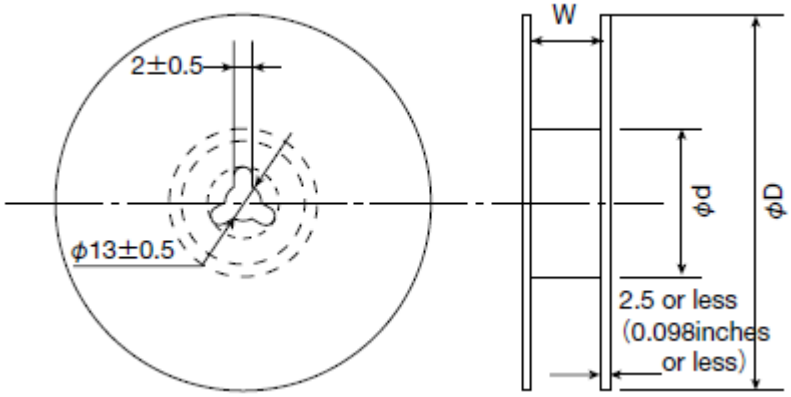
Unit:mm(inch)

④Leader and Blank portion

NR, NRH, NRS, NRV



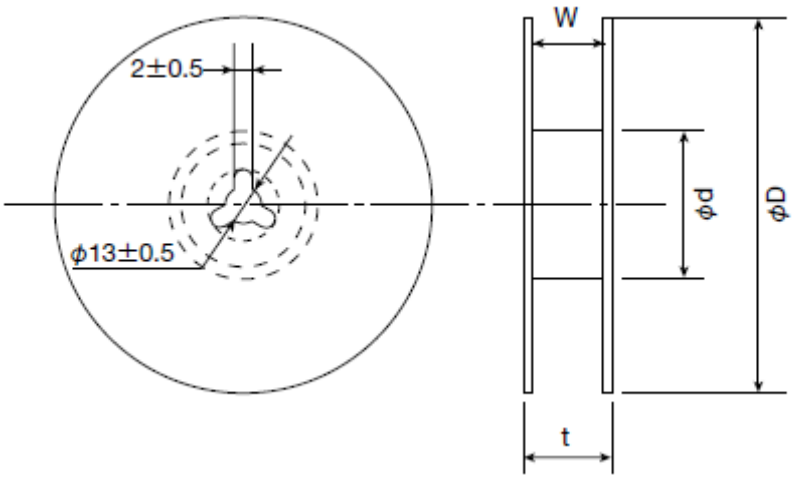
⑤Reel size



Type	Reel size (Reference values)		
	φD	φd	W
NRV2010	180±0.5 (7.087±0.019)	60±1.0 (2.36±0.04)	10.0±1.5 (0.394±0.059)
NRS2012 NRV2012			
NRH2410			
NRH2412			
NR 3010 NRH3010			
NR 3012 NRH3012 NRV3012			
NR 3015 NRS3015			

NRS5010	180±3.0 (7.087±0.118)	60±2.0 (2.36±0.08)	14.0±1.5 (0.551±0.059)
NRS5012			
NRS5014			
NRS5020			
NRS5030			
NRS6010			
NR 6012 NRS6012			
NRS6014			

Unit : mm (inch)

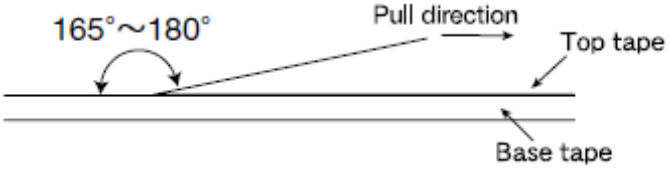


Type	Reel size (Reference values)			
	ϕD	ϕd	t (max.)	W
NR 4010 NRS4010	330±3.0 (12.99±0.118)	80±2.0 (3.15±0.078)	18.5 (0.72)	13.5±1.0 (0.531±0.04)
NR 4012 NRS4012				
NR 4018 NRS4018				
NRS5024				
NR 5040 NRS5040				
NR 6020 NRS6020				
NR 6028 NRS6028				
NR 6045 NRS6045				
NRS8030			22.5 (0.89)	17.5±1.0 (0.689±0.04)
NR 8040 NRS8040				

Unit : mm (inch)

⑥Top Tape Strength

The top tape requires a peel-off force of 0.1 to 1.3N in the direction of the arrow as illustrated below.



■RELIABILITY DATA

1. Operating Temperature Range		
Specified Value	NR30/40/50/60/80, NRS20, NRV20/30, NRH24/30 Type	−25～＋120℃
	NRS40/50/60/80 Type	−25～＋125℃
	NR10050 Type	−25～＋105℃
	NS101, NS125 Type	−40～＋125℃
Test Methods and Remarks	Including self-generated heat	

2. Storage Temperature Range		
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	−40～＋85℃
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type: −5 to 40℃ for the product with taping.	

3. Rated current		
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Within the specified tolerance
	NR10050 Type	
	NS101, NS125 Type	

4. Inductance		
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Within the specified tolerance
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : Specified frequency NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type : Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : 100kHz, 1V NR10050 Type : Measuring equipment : LCR Meter (HP 4263A or equivalent) Measuring frequency : 100kHz, 1V	

5. DC Resistance		
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Within the specified tolerance
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent)	

6. Self resonance frequency		
Specified Value	NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	Within the specified tolerance
	NR10050 Type	
	NS101, NS125 Type	−
Test Methods and Remarks	NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050 Type : Measuring equipment : Impedance analyzer/material analyzer(HP4291A or equivalent HP4191A, 4192A or equivalent)	

7. Temperature characteristic

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±20%
	NR10050 Type	
	NS101, NS125 Type	Inductance change : Within ±15%
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type : Measurement of inductance shall be taken at temperature range within −25℃～+85℃. With reference to inductance value at +20℃., change rate shall be calculated. NS101, NS125 Type : Measurement of inductance shall be taken at temperature range within −40℃～+125℃. With reference to inductance value at +20℃., change rate shall be calculated. Change of maximum inductance deviation in step 1 to 5	

Step	Temperature(℃)
1	20
2	Minimum operating temperature
3	20 (Standard temperature)
4	Maximum operating temperature
5	20

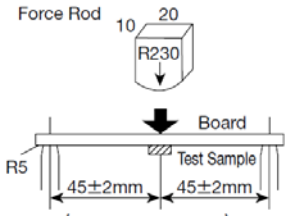
8. Resistance to flexure of substrate

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	No damage
	NR10050 Type	—
	NS101, NS125 Type	No damage

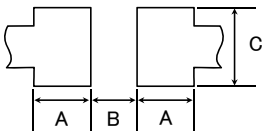
Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2 mm.

Test board size : 100×40×1.0
Test board material : Glass epoxy-resin
Solder cream thickness : 0.10mm (NR30, NRS20, NRH24/30, NRV20/30)
: 0.15mm(NR40/50/60/80, NRS40/50/60, NS101/125Type)



Land dimension



Type	A	B	C
NRS20, NRV20	0.65	0.7	2.0
NRH24	0.7	0.75	2.0
NR30, NRV30, NRH30	0.8	1.4	2.7
NR40, NRS40	1.2	1.6	3.7
NR50, NRS50	1.5	2.1	4.0
NR60, NRS60	1.6	3.1	5.7
NR80, NRS80	1.8	3.8	7.5

Type	A	B	C
NS101	2.5	5.6	3.2
NS125	2.5	8.6	3.2

9. Insulation resistance : between wires

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	—
	NR10050 Type	
	NS101, NS125 Type	

10. Insulation resistance : between wire and core

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	—
	NR10050 Type	
	NS101, NS125 Type	

11. Withstanding voltage : between wire and core

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	—
	NR10050 Type	
	NS101, NS125 Type	

12. Adhesion of terminal electrode

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Shall not come off PC board
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NS101/125 Type : The test samples shall be soldered to the test board by the reflow. Applied force : 10N to X and Y directions. Duration : 5s. Solder cream thickness : 0.10mm (NR30, NRS20, NRH24/30, NRV20/30) : 0.15mm (NR40/50/60/80, NRS40/50/60, NS101/125Type)  NR10050 Type Applied force : 5N to X and Y directions. Duration : 5s.	

13. Resistance to vibration

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	

Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow.
Then it shall be submitted to below test conditions.

Frequency Range	10～55Hz	
Total Amplitude	1.5mm (May not exceed acceleration 196m/s^2)	
Sweeping Method	10Hz to 55Hz to 10Hz for 1min.	
Time	X	For 2 hours on each X, Y, and Z axis.
	Y	
	Z	

Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

14. Solderability

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	At least 90% of surface of terminal electrode is covered by new solder.
	NR10050 Type	
	NS101, NS125 Type	

Test Methods and Remarks

The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table.
Flux : Methanol solution containing rosin 25%.
NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type

Solder Temperature	245±5℃
Time	5±1.0 sec.

※Immersion depth : All sides of mounting terminal shall be immersed.

15. Resistance to soldering heat

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type : The test sample shall be exposed to reflow oven at 230±5℃ for 40 seconds, with peak temperature at 260±5℃ for 5 seconds, 2 times. NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80Type, NS101/125 Type Test board material : Glass epoxy-resin Test board thickness : 1.0mm NR10050 Type Test board material : Glass epoxy-resin Test board thickness : 1.6mm Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

16. Thermal shock

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	

Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified time by step 1 to step 4 as shown in below table in sequence. The temperature cycle shall be repeated 100 cycles.

Conditions of 1 cycle		
Step	Temperature (℃)	Duration (min)
1	−40±3	30±3
2	Room temperature	Within 3
3	+85±2	30±3
4	Room temperature	Within 3

Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

17. Damp heat

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	—
	NS101, NS125 Type	Inductance change : Within ±10% No significant abnormality in appearance.

Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow.
The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.

Temperature	60±2℃
Humidity	90～95%RH
Time	500+24/−0 hour

Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

18. Loading under damp heat

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	

Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow.
The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated current continuously as shown in below table.

Temperature	60±2℃
Humidity	90～95%RH
Applied current	Rated current
Time	500+24/−0 hour

Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

19. Low temperature life test

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type : The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table. Temperature: −40±2℃ Time: 500+24/−0 hour Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

20. High temperature life test

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	—
	NR10050 Type	—
	NS101, NS125 Type	—
Test Methods and Remarks	NR10050 Type : Temperature: 105±3℃ Time: 500+24/−0 hour Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

21. Loading at high temperature life test

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	—
	NS101, NS125 Type	Inductance change : Within ±10% No significant abnormality in appearance.
Test Methods and Remarks	NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type : The test samples shall be soldered to the test board by the reflow soldering. Temperature: 85±2℃ Applied current: Rated current Time: 500+24/−0 hour Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

22. Standard condition

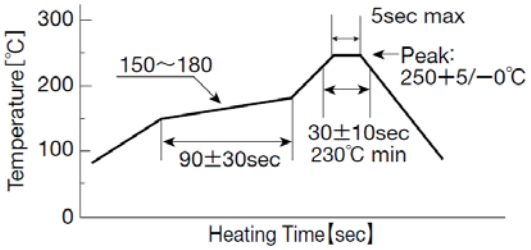
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Standard test condition : Unless otherwise specified, temperature is 20±15℃ and 65±20%of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of 20±2℃ of temperature, 65±5% relative humidity. Inductance is in accordance with our measured value.
	NR10050 Type	
	NS101, NS125 Type	

■PRECAUTIONS

1. Circuit Design	
Precautions	◆Operating environment 1. The products described in this specification are intended for use in general electronic equipment,(office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

2. PCB Design	
Precautions	◆Land pattern design 1. Please refer to a recommended land pattern.
Technical considerations	◆Land pattern design Surface Mounting ・ Mounting and soldering conditions should be checked beforehand. ・ Applicable soldering process to this products is reflow soldering only.

3. Considerations for automatic placement	
Precautions	◆Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand.
Technical considerations	◆Adjustment of mounting machine 1. When installing products, care should be taken not to apply distortion stress as it may deform the products.

4. Soldering	
Precautions	◆Reflow soldering 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. 2. The product shall be used reflow soldering only. 3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering. ◆Lead free soldering 1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently. ◆Recommended conditions for using a soldering iron (NR10050 Type) ・ Put the soldering iron on the land-pattern. ・ Soldering iron's temperature – Below 350℃ ・ Duration – 3 seconds or less ・ The soldering iron should not directly touch the inductor.
Technical considerations	◆Reflow soldering 1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products. ・NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type Recommended reflow condition (Pb free solder) 

5. Cleaning	
Precautions	◆Cleaning conditions 1. Washing by supersonic waves shall be avoided.
Technical considerations	◆Cleaning conditions 1. If washed by supersonic waves, the products might be broken.

6. Handling	
Precautions	◆Handling 1. Keep the product away from all magnets and magnetic objects. ◆Breakaway PC boards (splitting along perforations) 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations 1. Please do not give the product any excessive mechanical shocks. 2. Please do not add any shock and power to a product in transportation. ◆Pick-up pressure 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. ◆Packing 1. Please avoid accumulation of a packing box as much as possible.
Technical considerations	◆Handling 1. There is a case that a characteristic varies with magnetic influence. ◆Breakaway PC boards (splitting along perforations) 1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ◆Mechanical considerations 1. There is a case to be damaged by a mechanical shock. 2. There is a case to be broken by the handling in transportation. ◆Pick-up pressure 1. Damage and a characteristic can vary with an excessive shock or stress. ◆Packing 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.

7. Storage conditions	
Precautions	◆Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. ・ Recommended conditions Ambient temperature : −5～40℃ Humidity : Below 70% RH ・ The ambient temperature must be kept below 30℃. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used within 6 months from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage.
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.

SMD POWER INDUCTORS

REFLOW

■PARTS NUMBER

*Operating Temp.: −25〜+105℃ (Including self-generated heat)

N	R	△	1	0	0	5	0	T	△	1	0	0	M	△
①			②					③		④			⑤	⑥

△=Blank space

①Series name

Code	Series name
NR△	Coating resin specification

②Dimensions (L×H)

Code	Dimensions (L×H) [mm]
10050	10.0×5.0

③Packaging

Code	Packaging
T△	Taping

④Nominal inductance

Code (example)	Nominal inductance [μH]
1R3	1.3
100	10
101	100

※R=Decimal point

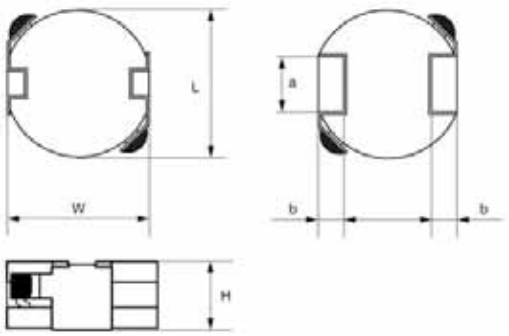
⑤Inductance tolerance

Code	Inductance tolerance
M	±20%
N	±30%

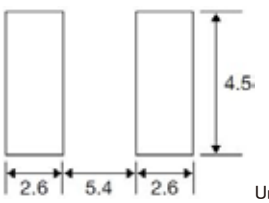
⑥Internal code

Code	Internal code
△	standard

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Recommended Land Patterns
Surface Mounting
・Mounting and soldering conditions should be checked beforehand.
・Applicable soldering process to these products is reflow soldering only.



Unit: mm

Type	L	W	H	a	b	Standard quantity [pcs] Taping
NR 10050	10.0±0.3 (0.394±0.012)	9.8±0.5 (0.386±0.020)	5.0 max (0.197 max)	4.0 (0.16)	1.75 (0.07)	500

Unit: mm (inch)

■PARTS NUMBER

●NR 10050 type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [kHz]
						Saturation current Idc1	Temperature rise current Idc2	
NR 10050T 1R3N	RoHS	1.3	±30%	53	0.0068	11,000	9,000	100
NR 10050T 2R1N	RoHS	2.1	±30%	37	0.0080	10,000	8,300	100
NR 10050T 2R9N	RoHS	2.9	±30%	29	0.0093	8,200	7,300	100
NR 10050T 3R8N	RoHS	3.8	±30%	26	0.013	7,300	6,800	100
NR 10050T 4R9N	RoHS	4.9	±30%	23	0.015	6,600	6,000	100
NR 10050T 6R5N	RoHS	6.5	±30%	19	0.018	6,000	5,200	100
NR 10050T 100M	RoHS	10	±20%	15	0.025	4,700	4,100	100
NR 10050T 150M	RoHS	15	±20%	11	0.035	3,600	3,200	100
NR 10050T 220M	RoHS	22	±20%	10	0.045	2,600	2,500	100
NR 10050T 330M	RoHS	33	±20%	8.2	0.066	2,500	2,100	100
NR 10050T 470M	RoHS	47	±20%	7.0	0.092	2,000	1,800	100
NR 10050T 680M	RoHS	68	±20%	5.6	0.144	1,700	1,500	100
NR 10050T 101M	RoHS	100	±20%	4.6	0.209	1,300	1,200	100
NR 10050T 221M	RoHS	220	±20%	3.0	0.450	1,000	800	100

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20℃)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40℃. (at 20℃)
※) The maximum rated current is the DC current value that satisfies both of current value Saturation current value and temperature rise current value. (at 20℃)

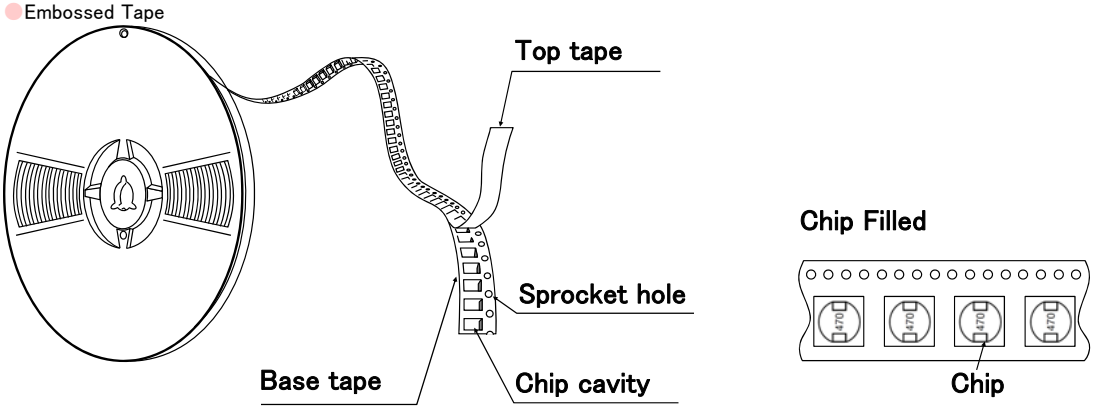
■PACKAGING

①Minimum Quantity

Type	Standard Quantity [pcs]
	Tape & Reel
NR 10050	500

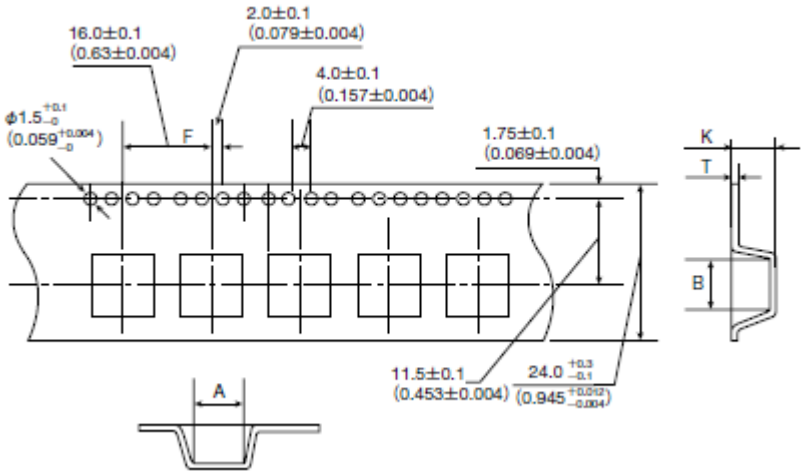
②Tape Material

●Embossed Tape



③Taping dimensions

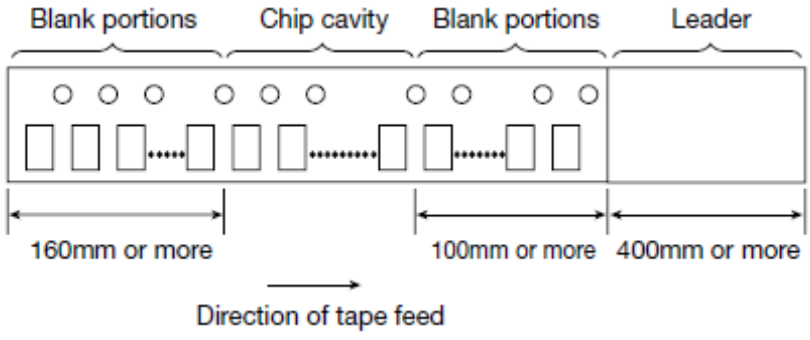
●Embossed tape 24mm wide (0.945 inches wide)



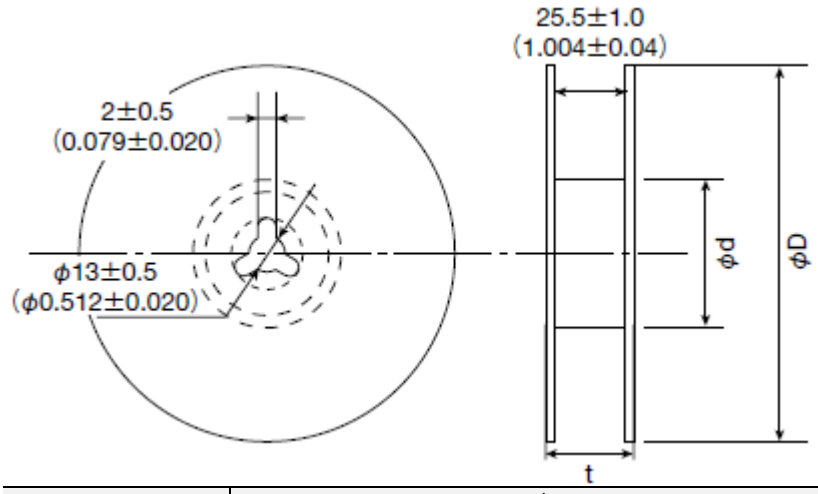
Type	Chip cavity		Insertion pich	Tape thickness	
	A	B	F	T	K
NR 10050	10.4±0.1 (0.409±0.004)	9.9±0.1 (0.390±0.004)	16.0±0.1 (0.630±0.004)	0.5±0.05 (0.020±0.002)	5.7±0.1 (0.224±0.004)

Unit:mm(inch)

④Leader and Blank portion



⑤Reel size

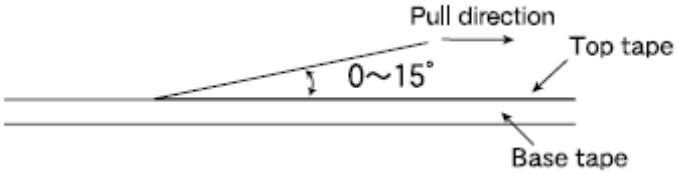


Type	Reel size (Reference valus		
	ϕD	ϕd	t(max.)
NR 10050	330±3 (12.99±0.118)	80±2 (3.15±0.078)	30.5 (1.201)

Unit : mm(inch)

⑥Top Tape Strength

The top tape requires a peel-off force of 0.1 to 1.3N in the direction of the arrow as illustrated below.



■RELIABILITY DATA

1. Operating Temperature Range		
Specified Value	NR30/40/50/60/80, NRS20, NRV20/30, NRH24/30 Type	−25～＋120℃
	NRS40/50/60/80 Type	−25～＋125℃
	NR10050 Type	−25～＋105℃
	NS101, NS125 Type	−40～＋125℃
Test Methods and Remarks	Including self-generated heat	

2. Storage Temperature Range		
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	−40～＋85℃
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type: −5 to 40℃ for the product with taping.	

3. Rated current		
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Within the specified tolerance
	NR10050 Type	
	NS101, NS125 Type	

4. Inductance		
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Within the specified tolerance
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : Specified frequency NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type : Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : 100kHz, 1V NR10050 Type : Measuring equipment : LCR Meter (HP 4263A or equivalent) Measuring frequency : 100kHz, 1V	

5. DC Resistance		
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Within the specified tolerance
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent)	

6. Self resonance frequency		
Specified Value	NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	Within the specified tolerance
	NR10050 Type	
	NS101, NS125 Type	−
Test Methods and Remarks	NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050 Type : Measuring equipment : Impedance analyzer/material analyzer(HP4291A or equivalent HP4191A, 4192A or equivalent)	

7. Temperature characteristic

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±20%
	NR10050 Type	
	NS101, NS125 Type	Inductance change : Within ±15%
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type : Measurement of inductance shall be taken at temperature range within −25℃～+85℃. With reference to inductance value at +20℃., change rate shall be calculated. NS101, NS125 Type : Measurement of inductance shall be taken at temperature range within −40℃～+125℃. With reference to inductance value at +20℃., change rate shall be calculated. Change of maximum inductance deviation in step 1 to 5	

Step	Temperature(℃)
1	20
2	Minimum operating temperature
3	20 (Standard temperature)
4	Maximum operating temperature
5	20

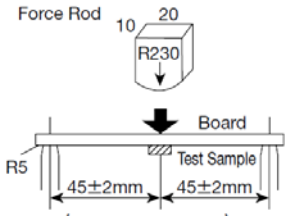
8. Resistance to flexure of substrate

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	No damage
	NR10050 Type	—
	NS101, NS125 Type	No damage

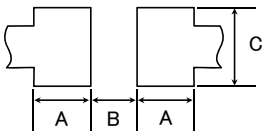
Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2 mm.

Test board size : 100×40×1.0
Test board material : Glass epoxy-resin
Solder cream thickness : 0.10mm (NR30, NRS20, NRH24/30, NRV20/30)
: 0.15mm(NR40/50/60/80, NRS40/50/60, NS101/125Type)



Land dimension



Type	A	B	C
NRS20, NRV20	0.65	0.7	2.0
NRH24	0.7	0.75	2.0
NR30, NRV30, NRH30	0.8	1.4	2.7
NR40, NRS40	1.2	1.6	3.7
NR50, NRS50	1.5	2.1	4.0
NR60, NRS60	1.6	3.1	5.7
NR80, NRS80	1.8	3.8	7.5

Type	A	B	C
NS101	2.5	5.6	3.2
NS125	2.5	8.6	3.2

9. Insulation resistance : between wires

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	—
	NR10050 Type	
	NS101, NS125 Type	

10. Insulation resistance : between wire and core

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	—
	NR10050 Type	
	NS101, NS125 Type	

11. Withstanding voltage : between wire and core

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	—
	NR10050 Type	
	NS101, NS125 Type	

12. Adhesion of terminal electrode

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Shall not come off PC board
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NS101/125 Type : The test samples shall be soldered to the test board by the reflow. Applied force : 10N to X and Y directions. Duration : 5s. Solder cream thickness : 0.10mm (NR30, NRS20, NRH24/30, NRV20/30) : 0.15mm (NR40/50/60/80, NRS40/50/60, NS101/125Type)  NR10050 Type Applied force : 5N to X and Y directions. Duration : 5s.	

13. Resistance to vibration

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	

Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow.
Then it shall be submitted to below test conditions.

Frequency Range	10～55Hz	
Total Amplitude	1.5mm (May not exceed acceleration 196m/s^2)	
Sweeping Method	10Hz to 55Hz to 10Hz for 1min.	
Time	X	For 2 hours on each X, Y, and Z axis.
	Y	
	Z	

Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

14. Solderability

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	At least 90% of surface of terminal electrode is covered by new solder.
	NR10050 Type	
	NS101, NS125 Type	

Test Methods and Remarks

The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table.
Flux : Methanol solution containing rosin 25%.
NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type

Solder Temperature	245±5℃
Time	5±1.0 sec.

※Immersion depth : All sides of mounting terminal shall be immersed.

15. Resistance to soldering heat

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type : The test sample shall be exposed to reflow oven at 230±5℃ for 40 seconds, with peak temperature at 260±5℃ for 5 seconds, 2 times. NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80Type, NS101/125 Type Test board material : Glass epoxy-resin Test board thickness : 1.0mm NR10050 Type Test board material : Glass epoxy-resin Test board thickness : 1.6mm Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

16. Thermal shock

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	

Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified time by step 1 to step 4 as shown in below table in sequence. The temperature cycle shall be repeated 100 cycles.

Conditions of 1 cycle		
Step	Temperature (℃)	Duration (min)
1	−40±3	30±3
2	Room temperature	Within 3
3	+85±2	30±3
4	Room temperature	Within 3

Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

17. Damp heat

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	—
	NS101, NS125 Type	Inductance change : Within ±10% No significant abnormality in appearance.

Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow.
The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.

Temperature	60±2℃
Humidity	90～95%RH
Time	500+24/−0 hour

Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

18. Loading under damp heat

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	

Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow.
The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated current continuously as shown in below table.

Temperature	60±2℃
Humidity	90～95%RH
Applied current	Rated current
Time	500+24/−0 hour

Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

19. Low temperature life test

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type : The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table. Temperature: −40±2℃ Time: 500+24/−0 hour Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

20. High temperature life test

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	—
	NR10050 Type	—
	NS101, NS125 Type	—
Test Methods and Remarks	NR10050 Type : Temperature: 105±3℃ Time: 500+24/−0 hour Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

21. Loading at high temperature life test

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	—
	NS101, NS125 Type	Inductance change : Within ±10% No significant abnormality in appearance.
Test Methods and Remarks	NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type : The test samples shall be soldered to the test board by the reflow soldering. Temperature: 85±2℃ Applied current: Rated current Time: 500+24/−0 hour Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

22. Standard condition

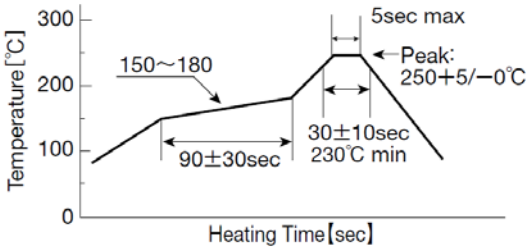
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Standard test condition : Unless otherwise specified, temperature is 20±15℃ and 65±20%of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of 20±2℃ of temperature, 65±5% relative humidity. Inductance is in accordance with our measured value.
	NR10050 Type	
	NS101, NS125 Type	

■PRECAUTIONS

1. Circuit Design	
Precautions	◆Operating environment 1. The products described in this specification are intended for use in general electronic equipment,(office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

2. PCB Design	
Precautions	◆Land pattern design 1. Please refer to a recommended land pattern.
Technical considerations	◆Land pattern design Surface Mounting ・ Mounting and soldering conditions should be checked beforehand. ・ Applicable soldering process to this products is reflow soldering only.

3. Considerations for automatic placement	
Precautions	◆Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand.
Technical considerations	◆Adjustment of mounting machine 1. When installing products, care should be taken not to apply distortion stress as it may deform the products.

4. Soldering	
Precautions	◆Reflow soldering 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. 2. The product shall be used reflow soldering only. 3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering. ◆Lead free soldering 1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently. ◆Recommended conditions for using a soldering iron (NR10050 Type) ・ Put the soldering iron on the land-pattern. ・ Soldering iron's temperature – Below 350℃ ・ Duration – 3 seconds or less ・ The soldering iron should not directly touch the inductor.
Technical considerations	◆Reflow soldering 1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products. ・NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type Recommended reflow condition (Pb free solder) 

5. Cleaning	
Precautions	◆Cleaning conditions 1. Washing by supersonic waves shall be avoided.
Technical considerations	◆Cleaning conditions 1. If washed by supersonic waves, the products might be broken.

6. Handling	
Precautions	◆Handling 1. Keep the product away from all magnets and magnetic objects. ◆Breakaway PC boards (splitting along perforations) 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations 1. Please do not give the product any excessive mechanical shocks. 2. Please do not add any shock and power to a product in transportation. ◆Pick-up pressure 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. ◆Packing 1. Please avoid accumulation of a packing box as much as possible.
Technical considerations	◆Handling 1. There is a case that a characteristic varies with magnetic influence. ◆Breakaway PC boards (splitting along perforations) 1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ◆Mechanical considerations 1. There is a case to be damaged by a mechanical shock. 2. There is a case to be broken by the handling in transportation. ◆Pick-up pressure 1. Damage and a characteristic can vary with an excessive shock or stress. ◆Packing 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.

7. Storage conditions	
Precautions	◆Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. ・ Recommended conditions Ambient temperature : −5～40℃ Humidity : Below 70% RH ・ The ambient temperature must be kept below 30℃. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used within 6 months from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage.
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.

SMD POWER INDUCTORS(NS SERIES)

REFLOW

■PARTS NUMBER

＊Operating Temp.:−40〜+125℃(Including self-generated heat)

N S △	1 0 1 4 5	T △	1 0 0	M	N A
①	②	③	④	⑤	⑥

△=Blank space

①Series name

Code	Series name
NS△	SMD inductor

②Dimensions(L×W×H)

Code	Dimensions(L×W×H)[mm]
10145	10.1×10.1×4.5
10155	10.1×10.1×5.5
10165	10.1×10.1×6.5
12555	12.5×12.5×5.5
12565	12.5×12.5×6.5
12575	12.5×12.5×7.5

③Packaging

Code	Packaging
T△	Taping

④Nominal inductance

Code (example)	Nominal inductance[μH]
1R0	1.0
100	10
101	100

※R=Decimal point

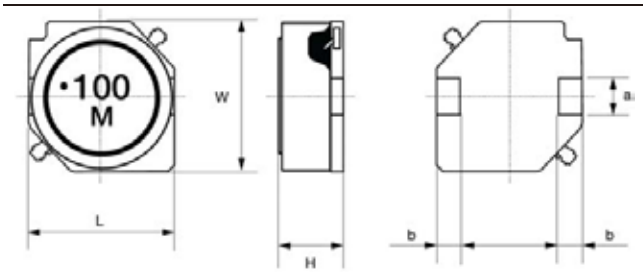
⑤Inductance tolerance

Code	Inductance tolerance
M	±20%
N	±30%

⑥Internal code

Code	
N△	Internal code
NA	

■STANDARD EXTERNAL DIMENSIONS / MINIMUM QUANTITY



※ The NS 101□□ type does not have the indication of the Manufacturing date code.

Type	L	W	H	a	b	Minimum quantity [pcs]
NS 10145	10.1±0.3 (0.398±0.012)	10.1±0.3 (0.398±0.012)	4.5±0.35 (0.177±0.014)	2.8±0.1 (0.110±0.004)	2.0±0.15 (0.079±0.006)	2000
NS 10155	10.1±0.3 (0.398±0.012)	10.1±0.3 (0.398±0.012)	5.5±0.35 (0.217±0.014)	2.8±0.1 (0.110±0.004)	2.0±0.15 (0.079±0.006)	2000
NS 10165	10.1±0.3 (0.398±0.012)	10.1±0.3 (0.398±0.012)	6.5±0.35 (0.256±0.014)	2.8±0.1 (0.110±0.004)	2.0±0.15 (0.079±0.006)	2000
NS 12555	12.5±0.3 (0.492±0.012)	12.5±0.3 (0.492±0.012)	5.5±0.35 (0.217±0.014)	3.0±0.1 (0.118±0.004)	2.0±0.15 (0.079±0.006)	2000
NS 12565	12.5±0.3 (0.492±0.012)	12.5±0.3 (0.492±0.012)	6.5±0.35 (0.256±0.014)	3.0±0.1 (0.118±0.004)	2.0±0.15 (0.079±0.006)	2000
NS 12575	12.5±0.3 (0.492±0.012)	12.5±0.3 (0.492±0.012)	7.5±0.35 (0.295±0.014)	3.0±0.1 (0.118±0.004)	2.0±0.15 (0.079±0.006)	2000

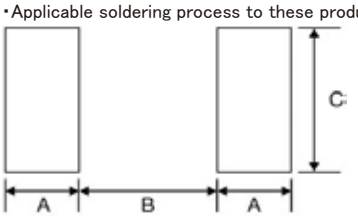
Unit:mm(inch)

Recommended Land Patterns

Surface Mounting

・Mounting and soldering conditions should be checked beforehand.

・Applicable soldering process to these products is reflow soldering only.



Type	A	B	C
NS 10145	2.5	5.6	3.2
NS 10155	2.5	5.6	3.2
NS 10165	2.5	5.6	3.2
NS 12555	2.5	8.6	3.2
NS 12565	2.5	8.6	3.2
NS 12575	2.5	8.6	3.2

Unit:mm

■PARTS NUMBER

●NS 10145 type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	DC Resistance [Ω](±20%)	Rated current ※) [A]		Measuring frequency [kHz]
					Saturation current Idc1	Temperature rise current Idc2	
NS 10145T 1R0NNA	RoHS	1.0	±30%	0.0049	12.54	8.90	100
NS 10145T 1R5NNA	RoHS	1.5	±30%	0.0060	10.34	7.99	100
NS 10145T 2R2NNA	RoHS	2.2	±30%	0.0085	8.91	6.64	100
NS 10145T 3R3NNA	RoHS	3.3	±30%	0.0100	7.33	6.10	100
NS 10145T 4R7NNA	RoHS	4.7	±30%	0.0144	6.69	5.03	100
NS 10145T 5R6NNA	RoHS	5.6	±30%	0.0181	5.85	4.45	100
NS 10145T 6R8NNA	RoHS	6.8	±30%	0.0200	5.05	4.22	100
NS 10145T 100MNA	RoHS	10	±20%	0.0248	4.22	3.77	100
NS 10145T 150MNA	RoHS	15	±20%	0.0381	3.44	3.00	100
NS 10145T 220MNA	RoHS	22	±20%	0.0520	2.87	2.55	100
NS 10145T 330MNA	RoHS	33	±20%	0.0815	2.36	2.01	100
NS 10145T 470MNA	RoHS	47	±20%	0.100	1.85	1.80	100
NS 10145T 680MNA	RoHS	68	±20%	0.150	1.66	1.45	100
NS 10145T 101MNA	RoHS	100	±20%	0.200	1.29	1.25	100
NS 10145T 151MNA	RoHS	150	±20%	0.341	1.11	0.94	100
NS 10145T 221MNA	RoHS	220	±20%	0.485	0.91	0.78	100
NS 10145T 331MNA	RoHS	330	±20%	0.700	0.71	0.64	100
NS 10145T 471MNA	RoHS	470	±20%	1.030	0.61	0.52	100
NS 10145T 681MNA	RoHS	680	±20%	1.57	0.50	0.42	100
NS 10145T 102MNA	RoHS	1000	±20%	2.58	0.41	0.32	100
NS 10145T 152MNA	RoHS	1500	±20%	3.70	0.36	0.27	100

●NS 10155 type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	DC Resistance [Ω](±20%)	Rated current ※) [A]		Measuring frequency [kHz]
					Saturation current Idc1	Temperature rise current Idc2	
NS 10155T 1R5NNA	RoHS	1.5	±30%	0.0060	11.90	8.39	100
NS 10155T 2R2NNA	RoHS	2.2	±30%	0.0072	10.00	7.61	100
NS 10155T 3R3NNA	RoHS	3.3	±30%	0.0097	8.50	6.49	100
NS 10155T 4R7NNA	RoHS	4.7	±30%	0.0112	7.40	6.01	100
NS 10155T 6R8NNA	RoHS	6.8	±30%	0.0159	6.00	4.98	100
NS 10155T 100MNA	RoHS	10	±20%	0.0200	4.49	4.40	100
NS 10155T 150MNA	RoHS	15	±20%	0.0284	4.03	3.65	100
NS 10155T 220MNA	RoHS	22	±20%	0.0380	3.37	3.12	100

●NS 10165 type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	DC Resistance [Ω](±20%)	Rated current ※) [A]		Measuring frequency [kHz]
					Saturation current Idc1	Temperature rise current Idc2	
NS 10165T 1R5NNA	RoHS	1.5	±30%	0.0062	13.60	8.04	100
NS 10165T 2R2NNA	RoHS	2.2	±30%	0.0074	10.80	7.32	100
NS 10165T 3R3NNA	RoHS	3.3	±30%	0.0086	9.30	6.76	100
NS 10165T 4R7NNA	RoHS	4.7	±30%	0.0112	7.70	5.88	100
NS 10165T 6R8NNA	RoHS	6.8	±30%	0.0140	6.00	5.22	100
NS 10165T 100MNA	RoHS	10	±20%	0.0174	5.20	4.66	100
NS 10165T 150MNA	RoHS	15	±20%	0.0250	4.50	3.84	100
NS 10165T 220MNA	RoHS	22	±20%	0.0313	3.60	3.41	100

●NS 12555 type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	DC Resistance [Ω](±20%)	Rated current ※) [A]		Measuring frequency [kHz]
					Saturation current Idc1	Temperature rise current Idc2	
NS 12555T 6R0NN	RoHS	6.0	±30%	0.0140	5.01	5.60	100
NS 12555T 100MN	RoHS	10	±20%	0.0175	4.73	5.04	100
NS 12555T 150MN	RoHS	15	±20%	0.0233	3.89	4.18	100
NS 12555T 220MN	RoHS	22	±20%	0.0297	3.20	3.81	100
NS 12555T 330MN	RoHS	33	±20%	0.0415	2.64	3.16	100
NS 12555T 470MN	RoHS	47	±20%	0.0551	2.23	2.70	100
NS 12555T 680MN	RoHS	68	±20%	0.0797	1.81	2.14	100
NS 12555T 101MN	RoHS	100	±20%	0.117	1.53	1.86	100
NS 12555T 151MN	RoHS	150	±20%	0.176	1.22	1.43	100
NS 12555T 221MN	RoHS	220	±20%	0.270	1.00	1.18	100
NS 12555T 331MN	RoHS	330	±20%	0.410	0.82	0.96	100
NS 12555T 471MN	RoHS	470	±20%	0.520	0.68	0.80	100
NS 12555T 681MN	RoHS	680	±20%	0.760	0.60	0.72	100
NS 12555T 102MN	RoHS	1000	±20%	1.12	0.47	0.59	100
NS 12555T 152MN	RoHS	1500	±20%	1.73	0.40	0.44	100

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20℃)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40℃. (at 20℃)
※) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

▶This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PARTS NUMBER

●NS 12565 type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	DC Resistance [Ω] (±20%)	Rated current ※) [A]		Measuring frequency [kHz]
					Saturation current Idc1	Temperature rise current Idc2	
NS 12565T 2R0NN	RoHS	2.0	±30%	0.0080	13.91	7.60	100
NS 12565T 4R2NN	RoHS	4.2	±30%	0.0126	10.15	5.91	100
NS 12565T 7R0NN	RoHS	7.0	±30%	0.0162	7.93	5.21	100
NS 12565T 100MN	RoHS	10	±20%	0.0199	6.96	4.75	100
NS 12565T 150MN	RoHS	15	±20%	0.0237	5.84	4.33	100
NS 12565T 220MN	RoHS	22	±20%	0.0310	4.87	3.91	100
NS 12565T 330MN	RoHS	33	±20%	0.0390	3.89	3.22	100
NS 12565T 470MN	RoHS	47	±20%	0.0575	3.34	2.78	100
NS 12565T 680MN	RoHS	68	±20%	0.0775	2.78	2.30	100
NS 12565T 101MN	RoHS	100	±20%	0.123	2.23	1.81	100
NS 12565T 151MN	RoHS	150	±20%	0.173	1.84	1.54	100
NS 12565T 221MN	RoHS	220	±20%	0.273	1.39	1.18	100

●NS 12575 type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	DC Resistance [Ω] (±20%)	Rated current ※) [A]		Measuring frequency [kHz]
					Saturation current Idc1	Temperature rise current Idc2	
NS 12575T 1R2NN	RoHS	1.2	±30%	0.0058	18.08	9.15	100
NS 12575T 2R7NN	RoHS	2.7	±30%	0.0085	13.91	7.69	100
NS 12575T 3R9NN	RoHS	3.9	±30%	0.0099	12.52	7.38	100
NS 12575T 5R6NN	RoHS	5.6	±30%	0.0116	10.85	6.36	100
NS 12575T 6R8NN	RoHS	6.8	±30%	0.0131	10.02	5.84	100
NS 12575T 100MN	RoHS	10	±20%	0.0156	7.65	5.55	100
NS 12575T 150MN	RoHS	15	±20%	0.0184	6.54	5.22	100
NS 12575T 220MN	RoHS	22	±20%	0.0260	5.56	4.05	100
NS 12575T 330MN	RoHS	33	±20%	0.0390	4.45	3.48	100
NS 12575T 470MN	RoHS	47	±20%	0.0515	3.76	2.95	100
NS 12575T 680MN	RoHS	68	±20%	0.0720	2.78	2.49	100
NS 12575T 101MN	RoHS	100	±20%	0.110	2.64	2.01	100
NS 12575T 151MN	RoHS	150	±20%	0.161	2.09	1.51	100
NS 12575T 221MN	RoHS	220	±20%	0.245	1.81	1.35	100
NS 12575T 102MN	RoHS	1000	±20%	0.927	0.80	0.68	100

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20℃)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40℃. (at 20℃)
※) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

SMD POWER INDUCTORS (NS SERIES)

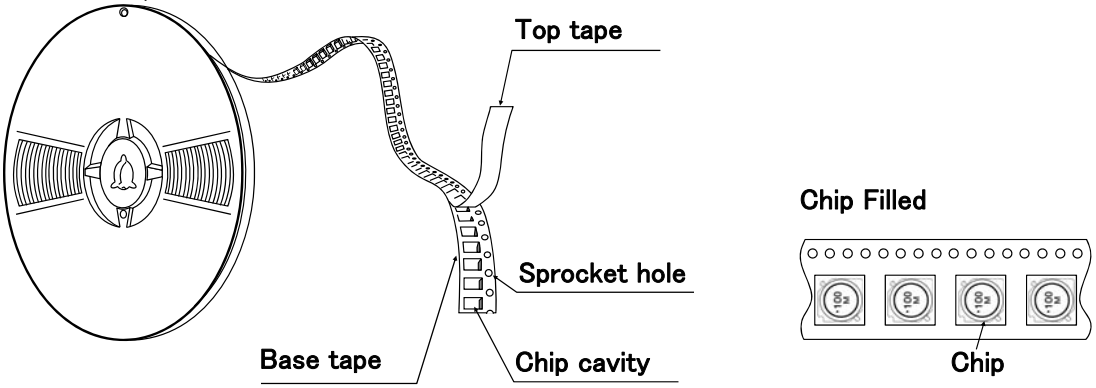
■PACKAGING

①Packing Quantity

Type	Standard Quantity (1reel) [pcs]	Minimum Quantity [pcs]
	Embossed Tape	Embossed Tape
NS10145	500	2000
NS10155	500	2000
NS10165	500	2000
NS12555	500	2000
NS12565	500	2000
NS12575	500	2000

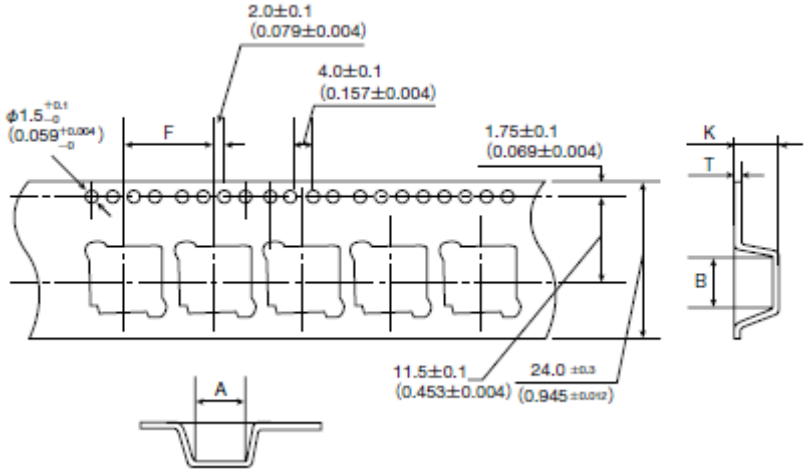
②Tape Material

●Embossed Tape



③Taping dimensions

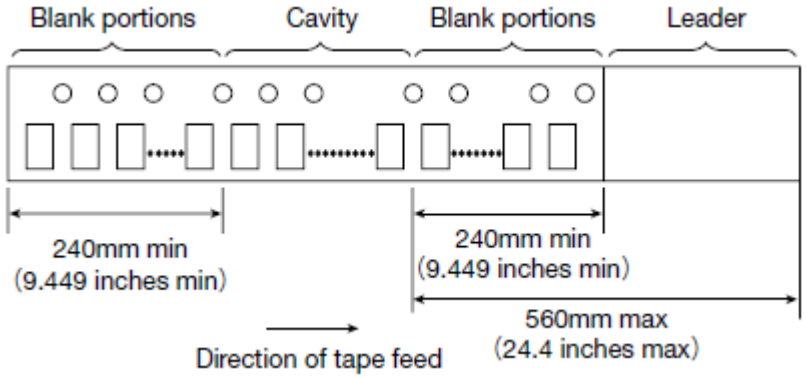
●Embossed tape 24mm wide (0.945 inches wide)



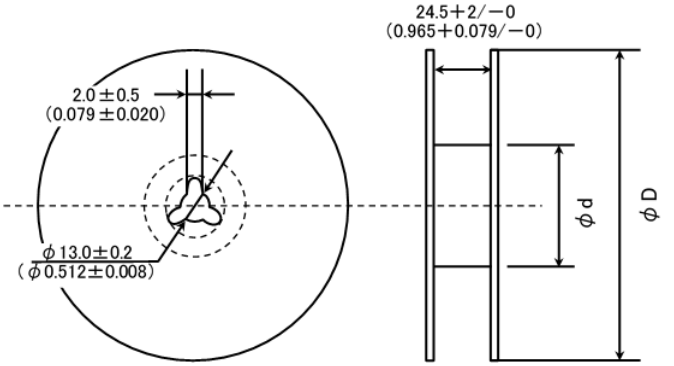
Type	Chip cavity		Insertion pitch	Tape thickness	
	A	B	F	T	K
NS10145	10.5±0.1 (0.413±0.004)	10.5±0.1 (0.413±0.004)	16.0±0.1 (0.630±0.004)	0.4±0.1 (0.016±0.004)	5.0±0.1 (0.197±0.004)
NS10155	10.5±0.1 (0.413±0.004)	10.5±0.1 (0.413±0.004)	16.0±0.1 (0.630±0.004)	0.4±0.1 (0.016±0.004)	6.0±0.1 (0.236±0.004)
NS10165	10.5±0.1 (0.413±0.004)	10.5±0.1 (0.413±0.004)	16.0±0.1 (0.630±0.004)	0.4±0.1 (0.016±0.004)	7.0±0.1 (0.276±0.004)
NS12555	13.0±0.1 (0.512±0.004)	13.0±0.1 (0.512±0.004)	16.0±0.1 (0.630±0.004)	0.4±0.1 (0.016±0.004)	6.1±0.1 (0.240±0.004)
NS12565	13.0±0.1 (0.512±0.004)	13.0±0.1 (0.512±0.004)	16.0±0.1 (0.630±0.004)	0.4±0.1 (0.016±0.004)	7.1±0.1 (0.280±0.004)
NS12575	13.0±0.1 (0.512±0.004)	13.0±0.1 (0.512±0.004)	16.0±0.1 (0.630±0.004)	0.4±0.1 (0.016±0.004)	8.0±0.1 (0.315±0.004)

Unit:mm(inch)

④Leader and Blank portion



⑤Reel size

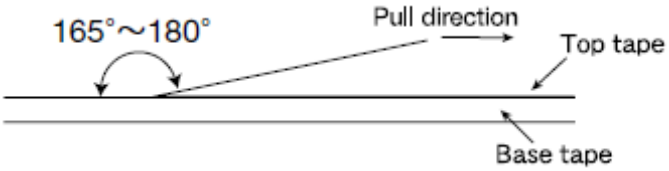


Type	Reel size (Reference values)	
	φD	φd
NS10145	330±2 (12.99±0.079)	100±1 (3.937±0.039)
NS10155		
NS10165		
NS12555		
NS12565		
NS12575		

Unit : mm (inch)

⑥Top Tape Strength

The top tape requires a peel-off force of 0.1 to 1.3N in the direction of the arrow as illustrated below.



■RELIABILITY DATA

1. Operating Temperature Range		
Specified Value	NR30/40/50/60/80, NRS20, NRV20/30, NRH24/30 Type	−25～＋120℃
	NRS40/50/60/80 Type	−25～＋125℃
	NR10050 Type	−25～＋105℃
	NS101, NS125 Type	−40～＋125℃
Test Methods and Remarks	Including self-generated heat	

2. Storage Temperature Range		
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	−40～＋85℃
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type: −5 to 40℃ for the product with taping.	

3. Rated current		
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Within the specified tolerance
	NR10050 Type	
	NS101, NS125 Type	

4. Inductance		
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Within the specified tolerance
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : Specified frequency NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type : Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : 100kHz, 1V NR10050 Type : Measuring equipment : LCR Meter (HP 4263A or equivalent) Measuring frequency : 100kHz, 1V	

5. DC Resistance		
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Within the specified tolerance
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent)	

6. Self resonance frequency		
Specified Value	NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	Within the specified tolerance
	NR10050 Type	
	NS101, NS125 Type	−
Test Methods and Remarks	NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050 Type : Measuring equipment : Impedance analyzer/material analyzer(HP4291A or equivalent HP4191A, 4192A or equivalent)	

7. Temperature characteristic

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±20%
	NR10050 Type	
	NS101, NS125 Type	Inductance change : Within ±15%
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type : Measurement of inductance shall be taken at temperature range within −25℃～+85℃. With reference to inductance value at +20℃., change rate shall be calculated. NS101, NS125 Type : Measurement of inductance shall be taken at temperature range within −40℃～+125℃. With reference to inductance value at +20℃., change rate shall be calculated. Change of maximum inductance deviation in step 1 to 5	

Step	Temperature(℃)
1	20
2	Minimum operating temperature
3	20 (Standard temperature)
4	Maximum operating temperature
5	20

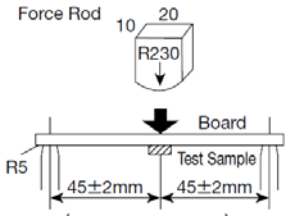
8. Resistance to flexure of substrate

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	No damage
	NR10050 Type	—
	NS101, NS125 Type	No damage

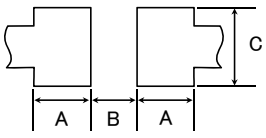
Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2 mm.

Test board size : 100×40×1.0
Test board material : Glass epoxy-resin
Solder cream thickness : 0.10mm (NR30, NRS20, NRH24/30, NRV20/30)
: 0.15mm(NR40/50/60/80, NRS40/50/60, NS101/125Type)



Land dimension



Type	A	B	C
NRS20, NRV20	0.65	0.7	2.0
NRH24	0.7	0.75	2.0
NR30, NRV30, NRH30	0.8	1.4	2.7
NR40, NRS40	1.2	1.6	3.7
NR50, NRS50	1.5	2.1	4.0
NR60, NRS60	1.6	3.1	5.7
NR80, NRS80	1.8	3.8	7.5

Type	A	B	C
NS101	2.5	5.6	3.2
NS125	2.5	8.6	3.2

9. Insulation resistance : between wires

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	—
	NR10050 Type	
	NS101, NS125 Type	

10. Insulation resistance : between wire and core

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	—
	NR10050 Type	
	NS101, NS125 Type	

11. Withstanding voltage : between wire and core

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	—
	NR10050 Type	
	NS101, NS125 Type	

12. Adhesion of terminal electrode

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Shall not come off PC board
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NS101/125 Type : The test samples shall be soldered to the test board by the reflow. Applied force : 10N to X and Y directions. Duration : 5s. Solder cream thickness : 0.10mm (NR30, NRS20, NRH24/30, NRV20/30) : 0.15mm (NR40/50/60/80, NRS40/50/60, NS101/125Type)  NR10050 Type Applied force : 5N to X and Y directions. Duration : 5s.	

13. Resistance to vibration

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	

Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow.
Then it shall be submitted to below test conditions.

Frequency Range	10～55Hz	
Total Amplitude	1.5mm (May not exceed acceleration 196m/s^2)	
Sweeping Method	10Hz to 55Hz to 10Hz for 1min.	
Time	X	For 2 hours on each X, Y, and Z axis.
	Y	
	Z	

Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

14. Solderability

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	At least 90% of surface of terminal electrode is covered by new solder.
	NR10050 Type	
	NS101, NS125 Type	

Test Methods and Remarks

The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table.
Flux : Methanol solution containing rosin 25%.
NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type

Solder Temperature	245±5℃
Time	5±1.0 sec.

※Immersion depth : All sides of mounting terminal shall be immersed.

15. Resistance to soldering heat

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type : The test sample shall be exposed to reflow oven at 230±5℃ for 40 seconds, with peak temperature at 260±5℃ for 5 seconds, 2 times. NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80Type, NS101/125 Type Test board material : Glass epoxy-resin Test board thickness : 1.0mm NR10050 Type Test board material : Glass epoxy-resin Test board thickness : 1.6mm Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

16. Thermal shock

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	

Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified time by step 1 to step 4 as shown in below table in sequence. The temperature cycle shall be repeated 100 cycles.

Conditions of 1 cycle		
Step	Temperature (℃)	Duration (min)
1	−40±3	30±3
2	Room temperature	Within 3
3	+85±2	30±3
4	Room temperature	Within 3

Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

17. Damp heat

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	—
	NS101, NS125 Type	Inductance change : Within ±10% No significant abnormality in appearance.

Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow.
The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.

Temperature	60±2℃
Humidity	90～95%RH
Time	500+24/−0 hour

Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

18. Loading under damp heat

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	

Test Methods and Remarks

NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type :
The test samples shall be soldered to the test board by the reflow.
The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated current continuously as shown in below table.

Temperature	60±2℃
Humidity	90～95%RH
Applied current	Rated current
Time	500+24/−0 hour

Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

19. Low temperature life test

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	
	NS101, NS125 Type	
Test Methods and Remarks	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type : The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table. Temperature: −40±2℃ Time: 500+24/−0 hour Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

20. High temperature life test

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	—
	NR10050 Type	—
	NS101, NS125 Type	—
Test Methods and Remarks	NR10050 Type : Temperature: 105±3℃ Time: 500+24/−0 hour Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

21. Loading at high temperature life test

Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Inductance change : Within ±10% No significant abnormality in appearance.
	NR10050 Type	—
	NS101, NS125 Type	Inductance change : Within ±10% No significant abnormality in appearance.
Test Methods and Remarks	NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type : The test samples shall be soldered to the test board by the reflow soldering. Temperature: 85±2℃ Applied current: Rated current Time: 500+24/−0 hour Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

22. Standard condition

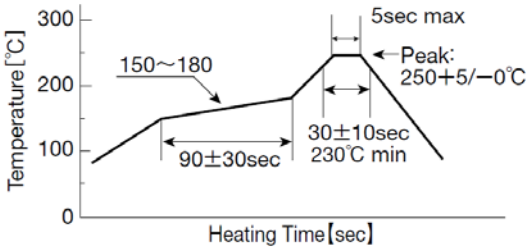
Specified Value	NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type	Standard test condition : Unless otherwise specified, temperature is 20±15℃ and 65±20%of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of 20±2℃ of temperature, 65±5% relative humidity. Inductance is in accordance with our measured value.
	NR10050 Type	
	NS101, NS125 Type	

■PRECAUTIONS

1. Circuit Design	
Precautions	◆Operating environment 1. The products described in this specification are intended for use in general electronic equipment,(office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

2. PCB Design	
Precautions	◆Land pattern design 1. Please refer to a recommended land pattern.
Technical considerations	◆Land pattern design Surface Mounting ・ Mounting and soldering conditions should be checked beforehand. ・ Applicable soldering process to this products is reflow soldering only.

3. Considerations for automatic placement	
Precautions	◆Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand.
Technical considerations	◆Adjustment of mounting machine 1. When installing products, care should be taken not to apply distortion stress as it may deform the products.

4. Soldering	
Precautions	◆Reflow soldering 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. 2. The product shall be used reflow soldering only. 3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering. ◆Lead free soldering 1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently. ◆Recommended conditions for using a soldering iron (NR10050 Type) ・ Put the soldering iron on the land-pattern. ・ Soldering iron's temperature – Below 350℃ ・ Duration – 3 seconds or less ・ The soldering iron should not directly touch the inductor.
Technical considerations	◆Reflow soldering 1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products. ・NR30/40/50/60/80, NRV20/30, NRH24/30, NRS20/40/50/60/80 Type, NR10050 Type, NS101/125 Type Recommended reflow condition (Pb free solder) 

5. Cleaning	
Precautions	◆Cleaning conditions 1. Washing by supersonic waves shall be avoided.
Technical considerations	◆Cleaning conditions 1. If washed by supersonic waves, the products might be broken.

6. Handling	
Precautions	◆Handling 1. Keep the product away from all magnets and magnetic objects. ◆Breakaway PC boards (splitting along perforations) 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations 1. Please do not give the product any excessive mechanical shocks. 2. Please do not add any shock and power to a product in transportation. ◆Pick-up pressure 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. ◆Packing 1. Please avoid accumulation of a packing box as much as possible.
Technical considerations	◆Handling 1. There is a case that a characteristic varies with magnetic influence. ◆Breakaway PC boards (splitting along perforations) 1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ◆Mechanical considerations 1. There is a case to be damaged by a mechanical shock. 2. There is a case to be broken by the handling in transportation. ◆Pick-up pressure 1. Damage and a characteristic can vary with an excessive shock or stress. ◆Packing 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.

7. Storage conditions	
Precautions	◆Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. ・ Recommended conditions Ambient temperature : −5～40℃ Humidity : Below 70% RH ・ The ambient temperature must be kept below 30℃. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used within 6 months from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage.
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.

WIRE-WOUND CHIP POWER INDUCTORS(BR SERIES)

REFLOW

■PARTS NUMBER

＊Operating Temp.:−40〜+105℃(Including self-generated heat)

B R	△ L	2 5 1 8	T	2 R 2	M	△ △ △
①	②	③	④	⑤	⑥	⑦

△=Blank space

①Series name

Code	Series name
BR	Wire-Wound chip power inductor

②Characteristics

Code	Characteristics
FL	Low profile
△L	
HL	
△C	High current

③Dimensions(L×W)

Code	Type(inch)	Dimensions (L×W)[mm]
1608	1608(0603)	1.6×0.8
2012	2012(0805)	2.0×1.25
2016	2016(0806)	2.0×1.6
2518	2518(1007)	2.5×1.8
3225	3225(1210)	3.2×2.5

④Packaging

Code	Packaging
T	Taping

⑤Nominal inductance

Code (example)	Nominal inductance[μH]
R20	0.2
1R0	1.0
100	10
101	100

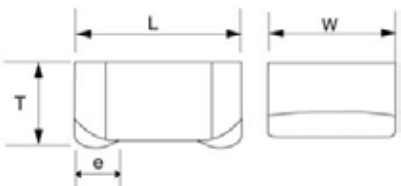
※R=Decimal point

⑥Inductance tolerance

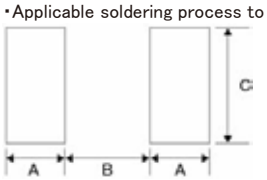
Code	Inductance tolerance
K	±10%
M	±20%

⑦Internal code

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Recommended Land Patterns
Surface Mounting
・Mounting and soldering conditions should be checked beforehand.
・Applicable soldering process to these products is reflow soldering only.



Type	A	B	C
1608	0.55	0.70	1.00
2012	0.60	1.00	1.45
2016	0.60	1.00	1.80
2518	0.60	1.50	2.00
3225	0.85	1.70	2.70

Unit:mm

Type	L	W	T	e	Standard quantity[pcs]	
					Paper tape	Embossed tape
BR L1608	1.6±0.2 (0.063±0.008)	0.8±0.2 (0.031±0.008)	0.7 max (0.028 max)	0.45±0.15 (0.016±0.006)	—	3000
BR C1608	1.6±0.2 (0.063±0.008)	0.8±0.2 (0.031±0.008)	0.8±0.2 (0.031±0.008)	0.45±0.15 (0.016±0.006)	—	3000
BR L2012	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	1.0 max (0.040 max)	0.5±0.2 (0.020±0.008)	—	3000
BR C2012	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	1.4 max (0.056 max)	0.5±0.2 (0.020±0.008)	—	2000
BR C2016	2.0±0.2 (0.079±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.2 (0.020±0.008)	—	2000
BRFL2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.0 max (0.040 max)	0.5±0.2 (0.020±0.008)	—	3000
BR L2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.2 max (0.048 max)	0.5±0.2 (0.020±0.008)	—	3000
BRHL2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.5 max (0.060 max)	0.5±0.2 (0.020±0.008)	—	2000
BR C2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.8±0.2 (0.071±0.008)	0.5±0.2 (0.020±0.008)	—	2000
BR L3225	3.2±0.2 (0.126±0.008)	2.5±0.2 (0.098±0.008)	1.7 max (0.068 max)	0.75±0.2 (0.03±0.008)	—	2000

Unit:mm(inch)

▶This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PARTS NUMBER

●1608(0603)TYPE

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
BR L1608T1R0M	RoHS	1.0	±20%	700	0.230	510	650	1.0
BR L1608T1R5M	RoHS	1.5	±20%	600	0.280	440	590	1.0
BR L1608T2R2M	RoHS	2.2	±20%	400	0.400	360	500	1.0
BR L1608T3R3M	RoHS	3.3	±20%	300	0.650	290	390	1.0
BR L1608T4R7M	RoHS	4.7	±20%	150	1.00	240	310	1.0
BR L1608T6R8M	RoHS	6.8	±20%	100	1.64	200	250	1.0
BR L1608T100M	RoHS	10	±20%	45	2.00	170	220	1.0
BR L1608T150M	RoHS	15	±20%	32	2.56	150	200	1.0

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
BR C1608TR43M 6	RoHS	0.43	±20%	740	0.082	1,400	1,100	6.0
BR C1608TR50M 6	RoHS	0.50	±20%	710	0.090	1,200	1,050	6.0
BR C1608TR60M 6	RoHS	0.60	±20%	630	0.099	1,100	940	6.0
BR C1608TR72M 6	RoHS	0.72	±20%	600	0.144	1,000	810	6.0
BR C1608TR82M 6	RoHS	0.82	±20%	560	0.176	950	730	6.0
BR C1608T1R0M 6	RoHS	1.0	±20%	550	0.188	890	680	6.0

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
BR C1608TR20M	RoHS	0.20	±20%	400	0.060	1,750	980	7.96
BR C1608TR35M	RoHS	0.35	±20%	300	0.080	1,400	810	7.96
BR C1608TR45M	RoHS	0.45	±20%	200	0.090	1,250	800	7.96
BR C1608TR56M	RoHS	0.56	±20%	170	0.095	1,150	760	7.96
BR C1608TR77M	RoHS	0.77	±20%	150	0.110	1,000	660	7.96
BR C1608T1R0M	RoHS	1.0	±20%	140	0.180	850	520	7.96
BR C1608T1R5M	RoHS	1.5	±20%	120	0.300	700	410	7.96
BR C1608T2R2M	RoHS	2.2	±20%	100	0.550	550	280	7.96

●2012(0805)TYPE

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
BR L2012TR47M 6	RoHS	0.47	±20%	500	0.048	1,500	1,900	6.0
BR L2012T1R0M 6	RoHS	1.0	±20%	400	0.108	1,050	1,230	6.0
BR L2012T2R2MD6	RoHS	2.2	±20%	250	0.184	680	950	6.0

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
BR L2012TR47M	RoHS	0.47	±20%	350	0.090	1,100	1,050	7.96
BR L2012T1R0M	RoHS	1.0	±20%	300	0.135	850	850	7.96
BR L2012T1R5M	RoHS	1.5	±20%	250	0.180	700	750	7.96
BR L2012T2R2M	RoHS	2.2	±20%	200	0.300	600	550	7.96
BR L2012T3R3M	RoHS	3.3	±20%	190	0.500	490	440	7.96
BR L2012T4R7M	RoHS	4.7	±20%	150	0.550	340	400	7.96
BR L2012T6R8M	RoHS	6.8	±20%	60	0.750	290	350	7.96
BR L2012T100M	RoHS	10	±20%	30	0.850	270	330	2.52
BR L2012T150M	RoHS	15	±20%	15	1.00	220	300	2.52
BR L2012T220M	RoHS	22	±20%	13	1.30	190	270	2.52
BR L2012T330M	RoHS	33	±20%	8.0	2.00	150	220	2.52
BR L2012T470M	RoHS	47	±20%	7.0	3.50	125	160	2.52
BR L2012T680M	RoHS	68	±20%	6.5	5.80	100	110	2.52
BR L2012T101M	RoHS	100	±20%	6.0	7.70	85	85	0.796

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
BR C2012T1R0M	RoHS	1.0	±20%	490	0.060	1,500	1,400	1.0
BR C2012T1R5MD	RoHS	1.5	±20%	390	0.090	1,200	1,100	1.0
BR C2012T2R2MD	RoHS	2.2	±20%	350	0.110	1,100	1,000	1.0
BR C2012T3R3MD	RoHS	3.3	±20%	300	0.170	800	870	1.0
BR C2012T4R7MD	RoHS	4.7	±20%	250	0.265	700	600	1.0

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20℃)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40℃. (at 20℃)

▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PARTS NUMBER

●2016(0806)TYPE

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
BR C2016T1R0M	RoHS	1.0	±20%	450	0.085	1,350	1,100	0.10
BR C2016T1R5M	RoHS	1.5	±20%	370	0.150	1,100	820	0.10
BR C2016T2R2M	RoHS	2.2	±20%	250	0.180	910	760	0.10
BR C2016T3R3M	RoHS	3.3	±20%	140	0.220	740	680	0.10
BR C2016T4R7M	RoHS	4.7	±20%	78	0.270	660	610	0.10
BR C2016T6R8M	RoHS	6.8	±20%	39	0.330	550	560	0.10
BR C2016T100□	RoHS	10	±10%, ±20%	35	0.400	450	520	0.10
BR C2016T150□	RoHS	15	±10%, ±20%	28	0.600	400	410	0.10
BR C2016T220□	RoHS	22	±10%, ±20%	24	1.00	310	310	0.10
BR C2016T330□	RoHS	33	±10%, ±20%	13	1.70	270	240	0.10
BR C2016T470□	RoHS	47	±10%, ±20%	11	2.20	210	210	0.10
BR C2016T680□	RoHS	68	±10%, ±20%	8	2.80	200	190	0.10
BR C2016T101□	RoHS	100	±10%, ±20%	7	3.40	140	170	0.10

●2518(1007)TYPE

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
BRFL2518T1R0M	RoHS	1.0	±20%	130	0.090	1,200	1,200	1.0
BRFL2518T1R5M	RoHS	1.5	±20%	100	0.110	1,100	1,000	1.0
BRFL2518T2R2M	RoHS	2.2	±20%	80	0.130	850	950	1.0
BRFL2518T3R3M	RoHS	3.3	±20%	70	0.220	700	700	1.0
BRFL2518T4R7M	RoHS	4.7	±20%	60	0.330	650	650	1.0

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
BR L2518T1R0M	RoHS	1.0	±20%	130	0.080	1,600	1,000	7.96
BR L2518T1R5M	RoHS	1.5	±20%	100	0.100	1,200	920	7.96
BR L2518T2R2M	RoHS	2.2	±20%	80	0.135	1,000	850	7.96
BR L2518T3R3M	RoHS	3.3	±20%	70	0.300	800	580	7.96
BR L2518T4R7M	RoHS	4.7	±20%	60	0.400	700	470	7.96

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
BRHL2518T1R0M	RoHS	1.0	±20%	400	0.055	2,000	1,400	1.0
BRHL2518T1R5M	RoHS	1.5	±20%	350	0.085	1,700	1,100	1.0
BRHL2518T2R2M	RoHS	2.2	±20%	300	0.115	1,500	1,000	1.0
BRHL2518T3R3MD	RoHS	3.3	±20%	200	0.165	1,200	800	1.0
BRHL2518T4R7MD	RoHS	4.7	±20%	150	0.245	1,100	750	1.0

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
BR C2518T1R0M	RoHS	1.0	±20%	280	0.050	2,550	1,650	1.0
BR C2518T1R5M	RoHS	1.5	±20%	230	0.080	2,100	1,300	1.0
BR C2518T2R2M	RoHS	2.2	±20%	200	0.120	1,800	1,000	1.0
BR C2518T3R3M	RoHS	3.3	±20%	150	0.175	1,450	860	1.0
BR C2518T4R7M	RoHS	4.7	±20%	100	0.230	1,250	750	1.0
BR C2518T6R8M	RoHS	6.8	±20%	45	0.280	1,050	680	1.0
BR C2518T100□	RoHS	10	±10%, ±20%	20	0.350	890	610	1.0
BR C2518T150□	RoHS	15	±10%, ±20%	13	0.430	760	550	1.0
BR C2518T220□	RoHS	22	±10%, ±20%	10	0.560	640	490	1.0
BR C2518T330□	RoHS	33	±10%, ±20%	8	0.850	560	390	1.0
BR C2518T470□	RoHS	47	±10%, ±20%	6.5	1.45	410	300	1.0
BR C2518T680□	RoHS	68	±10%, ±20%	5.5	2.40	340	230	1.0
BR C2518T101□	RoHS	100	±10%, ±20%	4.5	3.60	300	190	1.0

・□ Please specify the inductance tolerance code. (M or K)

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20℃)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40℃. (at 20℃)

▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

●3225(1210)TYPE

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±30%)	Rated current ※) [mA]		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
BR L3225TR27M	RoHS	0.27	±20%	390	0.022	4,500	2,850	7.96
BR L3225TR36M	RoHS	0.36	±20%	350	0.025	4,300	2,750	7.96
BR L3225TR51M	RoHS	0.51	±20%	270	0.029	3,600	2,550	7.96

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (±20%)	Rated current ※) [mA]		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
BR L3225T1R0M	RoHS	1.0	±20%	220	0.043	2,400	2,200	0.1
BR L3225T1R5M	RoHS	1.5	±20%	170	0.045	2,200	1,750	0.1
BR L3225T2R2M	RoHS	2.2	±20%	150	0.065	1,850	1,600	0.1
BR L3225T3R3M	RoHS	3.3	±20%	140	0.120	1,450	1,200	0.1
BR L3225T4R7M	RoHS	4.7	±20%	120	0.180	1,300	1,000	0.1
BR L3225T6R8M	RoHS	6.8	±20%	90	0.270	1,050	770	0.1
BR L3225T100□	RoHS	10	±10%, ±20%	70	0.350	900	700	0.1
BR L3225T150□	RoHS	15	±10%, ±20%	20	0.570	700	530	0.1
BR L3225T220□	RoHS	22	±10%, ±20%	13	0.690	550	470	0.1
BR L3225T330□	RoHS	33	±10%, ±20%	9	0.840	470	420	0.1
BR L3225T470□	RoHS	47	±10%, ±20%	7	1.00	420	390	0.1
BR L3225T680□	RoHS	68	±10%, ±20%	6	1.40	330	300	0.1
BR L3225T101□	RoHS	100	±10%, ±20%	5	2.50	270	250	0.1

・□ Please specify the inductance tolerance code. (M or K)

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20℃)
※) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40℃. (at 20℃)

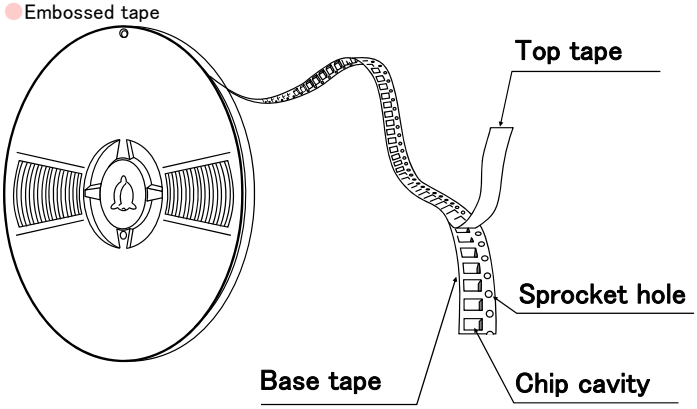
■PACKAGING

①Minimum Quantity

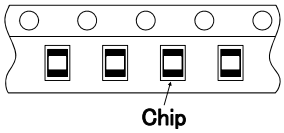
Type	Standard Quantity [pcs]	
	Paper Tape	Embossed Tape
BR C1608	—	3,000
BR L1608	—	3,000
BR L2012	—	3,000
BR C2012	—	2,000
BR C2016	—	2,000
BR C2518	—	2,000
BRHL2518	—	2,000
BR L2518	—	3,000
BRFL2518	—	3,000
BR L3225	—	2,000

②Tape Material

●Embossed tape

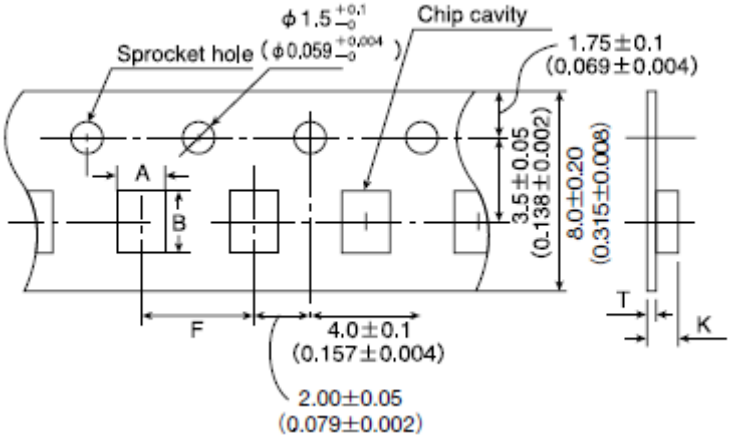


Chip Filled



③Taping dimensions

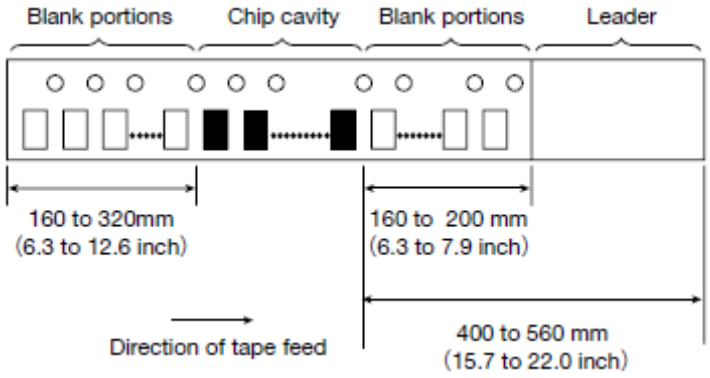
●Embossed Tape 8mm wide (0.315 inches wide)



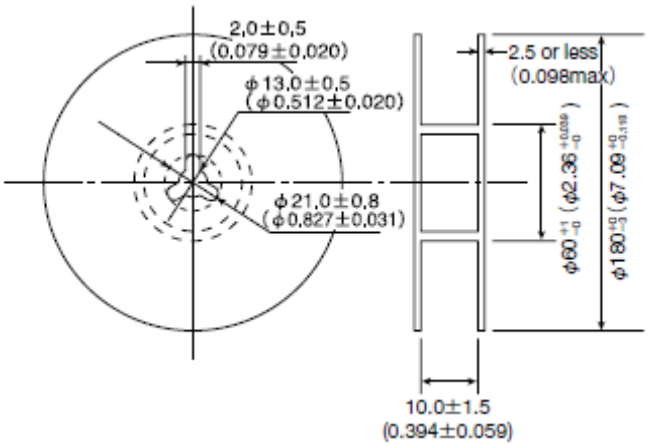
Type	Chip cavity		Insertion pitch	Tape thickness	
	A	B	F	T	K
BR L1608	1.1±0.1 (0.043±0.004)	1.9±0.1 (0.075±0.004)	4.0±0.1 (0.157±0.004)	0.2±0.05 (0.008±0.002)	0.9 max (0.035 max)
BR C1608	1.1±0.1 (0.043±0.004)	1.9±0.1 (0.075±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.2 max (0.047 max)
BR L2012	1.45±0.1 (0.057±0.004)	2.2±0.1 (0.087±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.2 max (0.047 max)
BR C2012	1.45±0.1 (0.057±0.004)	2.37±0.1 (0.093±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.59 max (0.063 max)
BR C2016	1.75±0.1 (0.069±0.004)	2.1±0.1 (0.083±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.9 max (0.075 max)
BRFL2518	2.3±0.1 (0.091±0.004)	2.8±0.1 (0.110±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.3 max (0.051 max)
BR L2518	2.3±0.1 (0.091±0.004)	2.8±0.1 (0.110±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.45 max (0.057 max)
BRHL2518	2.1±0.1 (0.083±0.004)	2.8±0.1 (0.110±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.7 max (0.067 max)
BR C2518	2.15±0.1 (0.085±0.004)	2.7±0.1 (0.106±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	2.2 max (0.087 max)
BR L3225	2.8±0.1 (0.110±0.004)	3.5±0.1 (0.138±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.9 max (0.075 max)

Unit : mm (inch)

④Leader and Blank portion

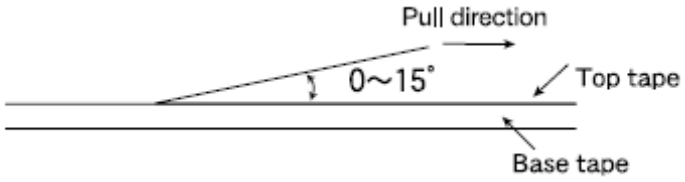


⑤Reel size



⑥Top Tape Strength

The top tape requires a peel-off force of 0.2 to 0.7N in the direction of the arrow as illustrated below.



WIRE-WOUND CHIP POWER INDUCTORS (BR SERIES)

■RELIABILITY DATA

1. Operating Temperature Range		
Specified Value	BR series	−40～＋105℃
Test Methods and Remarks	Including self-generated heat	

2. Storage Temperature Range (after soldering)		
Specified Value	BR series	−40～＋85℃
Test Methods and Remarks	Please refer the term of "7.Storage conditions" in Precautions.	

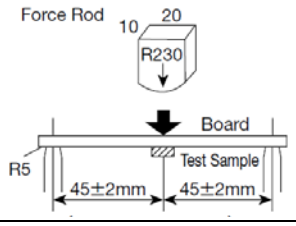
3. Rated current		
Specified Value	BR series	Within the specified tolerance

4. Inductance		
Specified Value	BR series	Within the specified tolerance
Test Methods and Remarks	Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : Specified frequency	

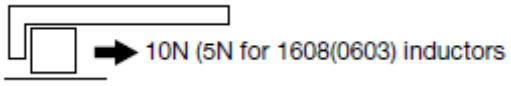
5. DC Resistance		
Specified Value	BR series	Within the specified tolerance
Test Methods and Remarks	Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent)	

6. Self resonance frequency		
Specified Value	BR series	Within the specified tolerance
Test Methods and Remarks	Measuring equipment : Impedance analyzer/material analyzer (HP4291A or equivalent HP4191A, 4192A or equivalent)	

7. Temperature characteristic		
Specified Value	BR series	Inductance change : Within ±15%
Test Methods and Remarks	Based on the inductance at 20℃ and Measured at the ambient of −40℃～＋85℃.	

8. Resistance to the bendability		
Specified Value	BR series	No damage.
Test Methods and Remarks	The given sample is soldered on the board and then the back side of the board is pushed until it bends 2mm like the figure. Dimension of the board : 100×40×1.0mm (0.8mm thickness for 1608(0603) inductors) Material of the board : Glass epoxy-resin Thickness of soldering paste : 0.12mm 	

9. Body strength		
Specified Value	BR series	No damage.
Test Methods and Remarks	2012～ Applied orce 10N Duration : 10sec. 1608 size Applied force : 5N Duration : 10sec.	

10. Adhesion of terminal electrodes		
Specified Value	BR series	Not to removed from the board.
Test Methods and Remarks	The given sample is soldered to the board and then it is kept for 5sec with 10N stress (5N for 1608(0603) inductors) like the figure.  	

11. Resistance to vibration			
Specified Value	BR series		Inductance change : Within ±10% No significant abnormality in appearance.
Test Methods and Remarks	The given sample is soldered to the board and then it is tested depending on the conditions of the following table.		
	Vibration Frequency	10～55Hz	
	Total Amplitude	1.5mm (May not exceed acceleration 196m/s2)	
	Sweeping Method	10Hz to 55Hz to 10Hz for 1min.	
	Time	X	For 2 hours on each X, Y, and Z axis.
		Y	
		Z	
	Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.		

12. Solderability		
Specified Value	BR series	At least 90% area of the electrodes is covered by new solder.
Test Methods and Remarks	Test Method and Remarks】 The given sample is dipped into the flux and then it is tested depending on the conditions of the following table. Flux : Methanol solution containing rosin 25%.	
	Solder Temperature	245±5℃
	Time	5±0.5 sec.

13. Resistance to soldering heat		
Specified Value	BR series	Inductance change : Within ±10% No significant abnormality in appearance.
Test Methods and Remarks	3 times reflow having the temperature profile of 5sec of 260+0/−5 ℃ and 40sec of more than 230℃. Test board thickness : 1.0mm Test board material : Glass epoxy-resin	

14. Thermal shock		
Specified Value	BR series	Inductance change : Within ±10% No significant abnormality in appearance.
Test Methods and Remarks	The given sample is soldered to the board and then its Inductance is measured after 100cycles of the following conditions.	

Conditions of 1 cycle		
Step	Temperature (℃)	Duration (min)
1	−40±3	30±3
2	Room temperature	Within 3
3	+85±2	30±3
4	Room temperature	Within 3

15. Damp heat

Specified Value	BR series	Inductance change : Within ±10% No significant abnormality in appearance.
Test Methods and Remarks	The given sample is soldered to the board and then it is kept at the following conditions. Temperature: 60±2℃ Humidity: 90～95%RH Time: 1000 hours. Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

16. Loading under damp heat

Specified Value	BR series	Inductance change : Within ±10% No significant abnormality in appearance.
Test Methods and Remarks	The given sample is soldered to the board and then it is kept at the following conditions. Temperature: 60±2℃ Humidity: 90～95%RH Applied current: Rated current Time: 1000hours. Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

17. Low temperature life test

Specified Value	BR series	Inductance change : Within ±10% No significant abnormality in appearance.
Test Methods and Remarks	The given sample is soldered to the board and then it is kept at the following conditions. Temperature: −40±2℃ Duration: 1000hours Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

18. High temperature life test

Specified Value	BR series	Inductance change : Within ±10% No significant abnormality in appearance.
Test Methods and Remarks	The given sample is soldered to the board and then it is kept at the following conditions. Temperature: 85±2℃ Duration: 1000hours Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

19. Standard conditions

Specified Value	BR series	Standard test condition : Unless otherwise specified, temperature is 20±15℃ and 65±20%of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of 20±2℃ of temperature, 65±5% relative humidity. Inductance is in accordance with our measured value.

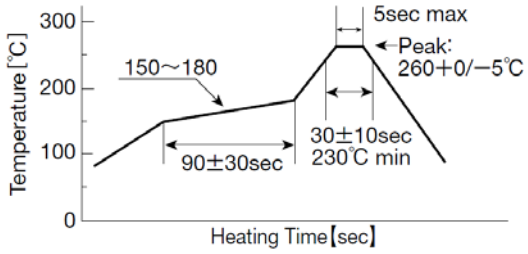
WIRE-WOUND CHIP POWER INDUCTORS (BR SERIES)

■PRECAUTIONS

1. Circuit Design	
Precautions	◆Operating Ambient The products are premised on the usage for the general equipments like the office supply equipment, the telecommunications systems, the measuring equipment, the household equipment and so on. Please ask to TAIYO YUDEN's sales person in advance, if you need to apply them to the equipments or the systems which might have any influences for the human body, the property, like the traffic systems, the safety equipment, the aerospace systems, the nuclear control systems, the medical equipment and soon.

2. PCB Design	
Precautions	◆Land pattern design 1. Please refer to a recommended land pattern.
Technical considerations	◆Land pattern design Surface Mounting 1. The conditions of the picking and placing should be checked in advance. 2. The products are only for reflow soldering.

3. Considerations for automatic placement	
Precautions	◆Adjustment of mounting machine 1. Excessive physical impact should not be imposed on the products for picking and placing onto the PC boards. 2. Mounting and soldering conditions should be checked in advance.
Technical considerations	◆Adjustment of mounting machine The products might be broken if too much stress is given for the picking and placing.

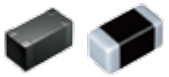
4. Soldering	
Precautions	◆Reflow soldering 1. Please apply our recommended soldering conditions on the specification as much as possible. 2. The products are only for reflow soldering. 3. Please do not give any stress to a product until it returns in room temperature after reflow soldering. ◆Lead free soldering 1. Please check the adhesion, the solder temperature, the solderability and the shape of solder filet if the solder that is not in the specification is used. ◆Recommended conditions for using a soldering iron (NR10050 Type) Touch a soldering iron to the land pattern not to the product directly. The temperature of a soldering iron is less than 350degC. The soldering is for 3 seconds or less.
Technical considerations	◆Reflow soldering 1. The product might break or might make the tombstoning, if the soldering conditions are too far from our recommended conditions. 

5. Cleaning	
Precautions	◆Cleaning conditions 1. Please don't wash by the ultra-sonic waves.
Technical considerations	◆Cleaning conditions 1. Washing by the ultra-sonic waves might break the product.

6. Handling	
Precautions	◆Handling 1. Keep the product away from any magnets. ◆Cutting the PC boards 1. Please don't give any stress of the bending or the twisting for the cutting process of PC boards. 2. Please don't give any shock and stress to the products in transportation. ◆Mechanical considerations 1. Please don't give too much shock to the product. 2. Please don't give any shock and stress to the products in transportation. ◆The stress for picking and placing 1. Please don't give any shock into an exposed ferrite core. ◆Packing 1. Please don't pile the packing boxes up as much as possible.
Technical considerations	◆Handling 1. There is a case that a characteristic varies with magnetic influence. ◆Cutting the PC boards 1. Please don't give the bending stress or the twisting stress to the products because they might break in such cases. ◆Mechanical considerations 1. The mechanical shock might break the products. 2. The products might break depending on the handling in transportation. ◆Pick-up pressure 1. The electrical characteristics of the products might be shifted by too much physical shock and stress. ◆Packing 1. The products and the tape might break, if the packing boxes are piled up.

7. Storage conditions	
Precautions	◆Storage 1. The packing boxes can be kept at the ambient which the temperature is from 0 to 40degC and the humidity is less than 70%. 2. The ambient temperature of less than 30degC is recommended not to get the tape and the solderability worse. 3. Please solder the products by a half year after they have been shipped. Otherwise please use them after checking the solderability in advance.
Technical considerations	◆Storage 1. The ambient of high temperature or high humidity might accelerate to make the solderability and the tape worse.

WIRE-WOUND CHIP POWER INDUCTORS(CB SERIES)



REFLOW

■PARTS NUMBER

＊ Operating Temp.：−40〜+105℃(Including self-generated heat)

C	B	△	△	2	0	1	2	T	1	0	0	M	△	△	△	△
①		②		③				④	⑤			⑥	⑦	⑧		

△＝Blank space

①Series name

Code	Series name
CB	Wound chip power inductor

②Characteristics

Code	Characteristics
△△	Standard
△C	High current
△L	Low profile
MF	Low loss

③Dimensions(L×W)

Code	Type(inch)	Dimensions (L×W)[mm]
1608	1608(0603)	1.6×0.8
2012	2012(0805)	2.0×1.25
2016	2016(0806)	2.0×1.6
2518	2518(1007)	2.5×1.8
3225	3225(1210)	3.2×2.5

④Packaging

Code	Packaging
T	Taping

⑤Nominal inductance

Code (example)	Nominal inductance[μH]
1R0	1.0
100	10
101	100

※R＝Decimal point

⑥Inductance tolerance

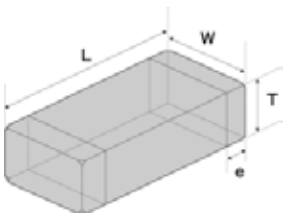
Code	Inductance tolerance
K	±10%
M	±20%

⑦Special code

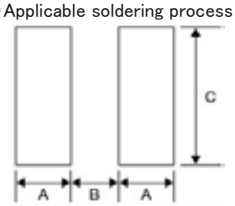
Code	Special code
△	Standard
R	Low Rdc type

⑧Internal code

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Recommended Land Patterns
Surface Mounting
・Mounting and soldering conditions should be checked beforehand.
・Applicable soldering process to these products is reflow soldering only.



Type	A	B	C
MF1608	0.55	0.7	1.0
2012	0.60	1.0	1.45
2016	0.60	1.0	1.8
2518	0.60	1.5	2.0
3225	0.85	1.7	2.7

Unit：mm

Type	L	W	T	e	Standard quantity[pcs]	
					Paper tape	Embossed tape
CBMF1608	1.6±0.2 (0.063±0.008)	0.8±0.2 (0.031±0.008)	0.8±0.2 (0.031±0.008)	0.45±0.15 (0.016±0.006)	—	3000
CB L2012	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	0.9±0.1 (0.035±0.004)	0.5±0.2 (0.020±0.008)	4000	—
CB 2012 CB C2012	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	1.25±0.2 (0.049±0.008)	0.5±0.2 (0.020±0.008)	—	3000
CB 2016 CB C2016	2.0±0.2 (0.079±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.2 (0.020±0.008)	—	2000
CB 2518 CB C2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.8±0.2 (0.071±0.008)	0.5±0.2 (0.020±0.008)	—	2000
CB C3225	3.2±0.2 (0.126±0.008)	2.5±0.2 (0.098±0.008)	2.5±0.2 (0.098±0.008)	0.6±0.3 (0.024±0.012)	—	1000

Unit：mm(inch)

▶This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PARTS NUMBER

●1608(0603)type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance [Ω](±30%)	Rated current ※) [mA]		Measuring frequency[MHz]
						Saturation current Idc1	Temperature rise current Idc2	
CBMF1608T1R0M	RoHS	1.0	±20%	100	0.09	290	770	7.96
CBMF1608T2R2M	RoHS	2.2	±20%	80	0.17	190	560	7.96
CBMF1608T3R3M	RoHS	3.3	±20%	60	0.22	170	500	7.96
CBMF1608T4R7M	RoHS	4.7	±20%	45	0.24	145	470	7.96
CBMF1608T100□	RoHS	10	±10%, ±20%	32	0.36	115	380	2.52
CBMF1608T220□	RoHS	22	±10%, ±20%	16	1.0	70	230	2.52
CBMF1608T470□	RoHS	47	±10%, ±20%	11	2.5	50	140	2.52

●2012(0805)type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance [Ω](±30%)	Rated current ※) [mA]		Measuring frequency[MHz]
						Saturation current Idc1	Temperature rise current Idc2	
CB 2012T1R0M	RoHS	1.0	±20%	100	0.15	500	900	7.96
CB 2012T2R2M	RoHS	2.2	±20%	80	0.23	410	770	7.96
CB 2012T3R3M	RoHS	3.3	±20%	55	0.30	330	650	7.96
CB 2012T4R7M	RoHS	4.7	±20%	45	0.40	300	580	7.96
CB 2012T6R8M	RoHS	6.8	±20%	38	0.47	250	540	7.96
CB 2012T100□	RoHS	10	±10%, ±20%	32	0.70	190	440	2.52
CB 2012T100□R	RoHS	10	±10%, ±20%	32	0.50	200	520	2.52
CB 2012T150□	RoHS	15	±10%, ±20%	28	1.3	170	320	2.52
CB 2012T220□	RoHS	22	±10%, ±20%	16	1.7	135	280	2.52
CB 2012T470□	RoHS	47	±10%, ±20%	11	3.7	90	190	2.52
CB 2012T680□	RoHS	68	±10%, ±20%	10	6.0	70	140	2.52
CB 2012T101□	RoHS	100	±10%, ±20%	8	7.0	60	130	0.796

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance [Ω](±30%)	Rated current ※) [mA]		Measuring frequency[MHz]
						Saturation current Idc1	Temperature rise current Idc2	
CB C2012T1R0M	RoHS	1.0	±20%	100	0.19	700	840	7.96
CB C2012T2R2M	RoHS	2.2	±20%	70	0.33	530	640	7.96
CB C2012T4R7M	RoHS	4.7	±20%	45	0.50	360	520	7.96
CB C2012T100□	RoHS	10	±10%, ±20%	40	1.2	240	340	2.52
CB C2012T220□	RoHS	22	±10%, ±20%	16	3.7	170	190	2.52
CB C2012T470□	RoHS	47	±10%, ±20%	11	5.8	120	150	2.52

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance [Ω](±30%)	Rated current ※) [mA]		Measuring frequency[MHz]
						Saturation current Idc1	Temperature rise current Idc2	
CB L2012T1R0M	RoHS	1.0	±20%	100	0.15	620	950	0.1
CB L2012T2R2M	RoHS	2.2	±20%	80	0.39	440	590	0.1
CB L2012T4R7M	RoHS	4.7	±20%	45	0.66	275	490	0.1
CB L2012T100M	RoHS	10	±20%	32	1.0	205	370	0.1
CB L2012T220M	RoHS	22	±20%	23	2.1	150	250	0.1
CB L2012T470M	RoHS	47	±20%	11	4.2	100	140	0.1

●2016(0806)type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance [Ω](±30%)	Rated current ※) [mA]		Measuring frequency[MHz]
						Saturation current Idc1	Temperature rise current Idc2	
CB 2016T1R0M	RoHS	1.0	±20%	100	0.09	600	1,100	7.96
CB 2016T1R5M	RoHS	1.5	±20%	80	0.11	550	1,000	7.96
CB 2016T2R2M	RoHS	2.2	±20%	70	0.13	510	1,000	7.96
CB 2016T3R3M	RoHS	3.3	±20%	55	0.20	400	800	7.96
CB 2016T4R7M	RoHS	4.7	±20%	45	0.25	340	740	7.96
CB 2016T6R8M	RoHS	6.8	±20%	38	0.35	300	600	7.96
CB 2016T100□	RoHS	10	±10%, ±20%	32	0.50	250	520	2.52
CB 2016T150□	RoHS	15	±10%, ±20%	28	0.70	210	440	2.52
CB 2016T220□	RoHS	22	±10%, ±20%	16	1.0	165	370	2.52
CB 2016T330□	RoHS	33	±10%, ±20%	14	1.7	130	270	2.52
CB 2016T470□	RoHS	47	±10%, ±20%	11	2.4	110	240	2.52
CB 2016T680□	RoHS	68	±10%, ±20%	10	3.0	90	210	2.52
CB 2016T101□	RoHS	100	±10%, ±20%	8	4.5	70	170	0.796

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance [Ω](±30%)	Rated current ※) [mA]		Measuring frequency[MHz]
						Saturation current Idc1	Temperature rise current Idc2	
CB C2016T1R0M	RoHS	1.0	±20%	100	0.10	1,100	1,100	7.96
CB C2016T1R5M	RoHS	1.5	±20%	80	0.15	1,000	1,000	7.96
CB C2016T2R2M	RoHS	2.2	±20%	70	0.20	750	720	7.96
CB C2016T3R3M	RoHS	3.3	±20%	55	0.27	600	610	7.96
CB C2016T4R7M	RoHS	4.7	±20%	45	0.37	550	530	7.96
CB C2016T6R8M	RoHS	6.8	±20%	38	0.59	450	450	7.96
CB C2016T100□	RoHS	10	±10%, ±20%	32	0.82	380	350	2.52
CB C2016T150□	RoHS	15	±10%, ±20%	28	1.2	300	300	2.52
CB C2016T220□	RoHS	22	±10%, ±20%	16	1.8	250	240	2.52
CB C2016T330□	RoHS	33	±10%, ±20%	14	2.8	220	220	2.52
CB C2016T470□	RoHS	47	±10%, ±20%	11	4.3	150	150	2.52
CB C2016T680□	RoHS	68	±10%, ±20%	10	7.0	130	130	2.52
CB C2016T101□	RoHS	100	±10%, ±20%	8	8.0	110	110	0.796

・□ Please specify the Inductance tolerance code(Kor M)

※)The saturation current value(Idc1) is the DC current value having inductance decrease down to 30%.(at 20℃)
※)The temperature rise current value(Idc2) is the DC current value having temperature increase up to 40℃.(at 20℃)

▶This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

■PARTS NUMBER

●2518(1007)type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance [Ω](±30%)	Rated current ※) [mA]		Measuring frequency[MHz]
						Saturation current Idc1	Temperature rise current Idc2	
CB 2518T1R0M	RoHS	1.0	±20%	100	0.06	1,200	1,500	7.96
CB 2518T1R5M	RoHS	1.5	±20%	80	0.07	650	1,400	7.96
CB 2518T2R2M	RoHS	2.2	±20%	68	0.09	510	1,300	7.96
CB 2518T3R3M	RoHS	3.3	±20%	54	0.11	440	1,200	7.96
CB 2518T4R7MR	RoHS	4.7	±20%	46	0.10	310	1,200	7.96
CB 2518T4R7M	RoHS	4.7	±20%	46	0.13	340	1,100	7.96
CB 2518T6R8M	RoHS	6.8	±20%	38	0.15	270	930	7.96
CB 2518T100□	RoHS	10	±10%, ±20%	30	0.25	250	820	2.52
CB 2518T150□	RoHS	15	±10%, ±20%	23	0.32	180	650	2.52
CB 2518T220□	RoHS	22	±10%, ±20%	19	0.50	165	580	2.52
CB 2518T330□	RoHS	33	±10%, ±20%	15	0.70	130	460	2.52
CB 2518T470□	RoHS	47	±10%, ±20%	12	0.95	110	420	2.52
CB 2518T680□	RoHS	68	±10%, ±20%	9.5	1.5	70	310	2.52
CB 2518T101□	RoHS	100	±10%, ±20%	9.0	2.1	60	260	0.796
CB 2518T151□	RoHS	150	±10%, ±20%	7.0	3.2	55	210	0.796
CB 2518T221□	RoHS	220	±10%, ±20%	5.5	4.5	50	180	0.796
CB 2518T331□	RoHS	330	±10%, ±20%	4.5	7.0	40	140	0.796
CB 2518T471□	RoHS	470	±10%, ±20%	3.5	10	35	120	0.796
CB 2518T681□	RoHS	680	±10%, ±20%	3.0	17	30	90	0.796
CB 2518T102□	RoHS	1000	±10%, ±20%	2.4	24	25	75	0.252

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance [Ω](±30%)	Rated current ※) [mA]		Measuring frequency[MHz]
						Saturation current Idc1	Temperature rise current Idc2	
CB C2518T1R0M	RoHS	1.0	±20%	100	0.08	1,000	1,200	7.96
CB C2518T1R5M	RoHS	1.5	±20%	80	0.11	950	1,190	7.96
CB C2518T2R2M	RoHS	2.2	±20%	68	0.13	890	1,100	7.96
CB C2518T3R3M	RoHS	3.3	±20%	54	0.16	730	1,020	7.96
CB C2518T4R7M	RoHS	4.7	±20%	41	0.20	680	920	7.96
CB C2518T6R8M	RoHS	6.8	±20%	38	0.30	550	740	7.96
CB C2518T100□	RoHS	10	±10%, ±20%	30	0.36	480	680	2.52
CB C2518T150□	RoHS	15	±10%, ±20%	23	0.65	350	500	2.52
CB C2518T220□	RoHS	22	±10%, ±20%	19	0.77	320	460	2.52
CB C2518T330□	RoHS	33	±10%, ±20%	15	1.5	270	320	2.52
CB C2518T470□	RoHS	47	±10%, ±20%	12	1.9	240	290	2.52
CB C2518T680□	RoHS	68	±10%, ±20%	9.5	2.8	200	200	2.52
CB C2518T101□	RoHS	100	±10%, ±20%	9.0	3.7	160	170	0.796
CB C2518T151□	RoHS	150	±10%, ±20%	7.0	6.1	140	130	0.796
CB C2518T221□	RoHS	220	±10%, ±20%	5.5	8.4	115	110	0.796
CB C2518T331□	RoHS	330	±10%, ±20%	4.5	12.3	100	90	0.796
CB C2518T471□	RoHS	470	±10%, ±20%	3.5	22	80	70	0.796
CB C2518T681□	RoHS	680	±10%, ±20%	3.0	28	65	60	0.796

●3225(1210)type

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance [Ω](±30%)	Rated current ※) [mA]		Measuring frequency[MHz]
						Saturation current Idc1	Temperature rise current Idc2	
CB C3225T1R0MR	RoHS	1.0	±20%	250	0.055	2,000	1,440	0.1
CB C3225T1R5MR	RoHS	1.5	±20%	220	0.060	2,000	1,310	0.1
CB C3225T2R2MR	RoHS	2.2	±20%	190	0.080	2,000	1,130	0.1
CB C3225T3R3MR	RoHS	3.3	±20%	160	0.095	2,000	1,040	0.1
CB C3225T4R7MR	RoHS	4.7	±20%	70	0.100	1,250	1,010	0.1
CB C3225T6R8MR	RoHS	6.8	±20%	50	0.120	950	940	0.1
CB C3225T100□R	RoHS	10	±10%, ±20%	23	0.133	900	900	0.1
CB C3225T150□R	RoHS	15	±10%, ±20%	20	0.195	730	850	0.1
CB C3225T220□R	RoHS	22	±10%, ±20%	17	0.27	620	780	0.1
CB C3225T330□R	RoHS	33	±10%, ±20%	13	0.41	500	570	0.1
CB C3225T470□R	RoHS	47	±10%, ±20%	10	0.67	390	480	0.1
CB C3225T680□R	RoHS	68	±10%, ±20%	8.0	1.0	320	410	0.1
CB C3225T101□R	RoHS	100	±10%, ±20%	6.0	1.4	270	340	0.1
CB C3225T221□R	RoHS	220	±10%, ±20%	3.0	2.5	190	190	0.1
CB C3225T821□R	RoHS	820	±10%, ±20%	1.8	12	110	110	0.1
CB C3225T102□R	RoHS	1000	±10%, ±20%	1.6	13	100	100	0.1

・□ Please specify the Inductance tolerance code(Kor M)

※)The saturation current value(Idc1) is the DC current value having inductance decrease down to 30%.(at 20℃)
※)The temperature rise current value(Idc2) is the DC current value having temperature increase up to 40℃.(at 20℃)

▶This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

WIRE-WOUND CHIP INDUCTORS (LB SERIES),
WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES),
WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

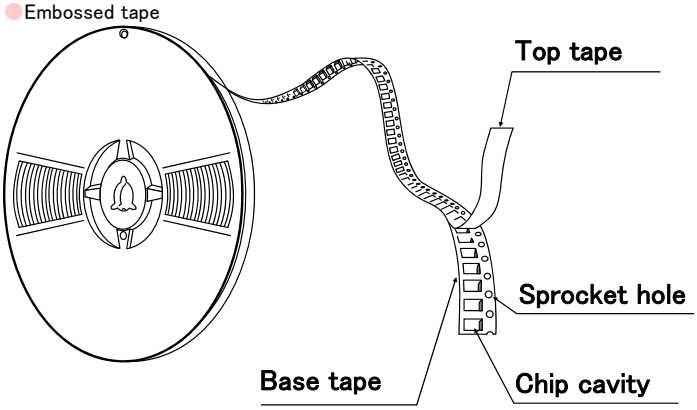
■PACKAGING

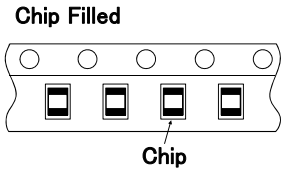
①Minimum Quantity

Type	Standard Quantity [pcs]	
	Paper Tape	Embossed Tape
LB C3225 CB C3225	—	1000
LB 3218	—	2000
LB R2518 LB C2518 LB 2518 CB 2518 CB C2518	—	2000
LBM2016 LB C2016 LB 2016 CB 2016 CB C2016	—	2000
LB 2012 LB C2012 LB R2012 CB 2012 CB C2012	—	3000
CB L2012	4000	—
LB 1608	4000	—
LBMF1608 CBMF1608	—	3000

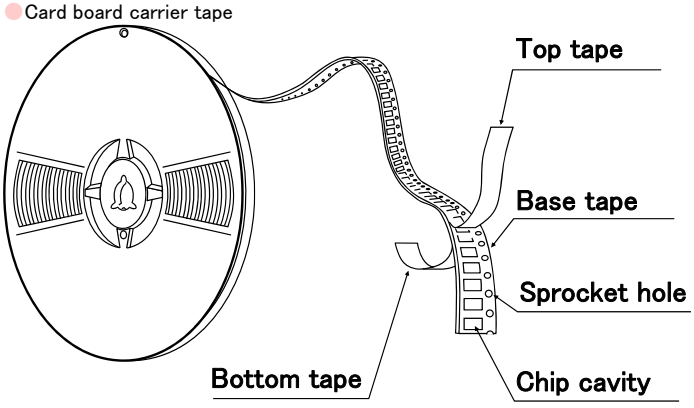
②Tape material

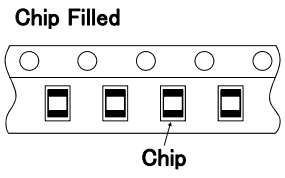
●Embossed tape





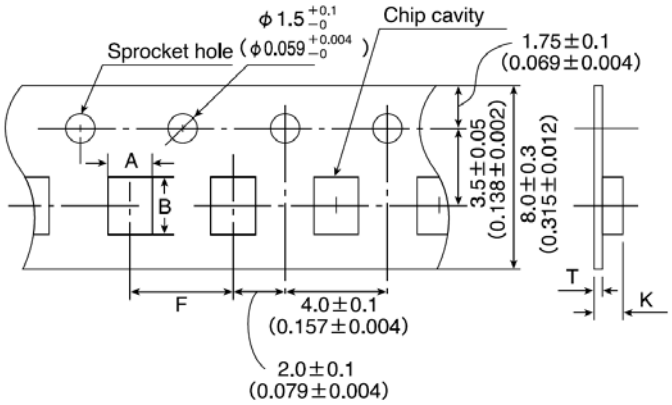
●Card board carrier tape





③Taping Dimensions

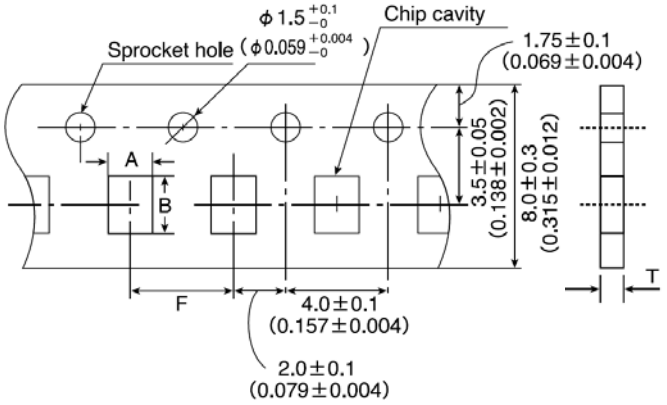
Embossed Tape (0.315 inches wide)



Type	Chip cavity		Insertion pitch	Tape thickness	
	A	B	F	T	K
LBM2016	1.75±0.1 (0.069±0.004)	2.1±0.1 (0.083±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)
LB C3225 CB C3225	2.8±0.1 (0.110±0.004)	3.5±0.1 (0.138±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	4.0max. (0.157max.)
LB 3218	2.1±0.1 (0.083±0.004)	3.5±0.1 (0.138±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	2.2max. (0.087max.)
LB 2518 CB 2518 LB C2518 CB C2518 LB R2518	2.15±0.1 (0.085±0.004)	2.7±0.1 (0.106±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	2.2max. (0.087max.)
LB 2016 CB 2016 LB C2016 CB C2016	1.75±0.1 (0.069±0.004)	2.1±0.1 (0.083±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)
LB 2012 CB 2012 LB C2012 CB C2012 LB R2012	1.45±0.1 (0.057±0.004)	2.25±0.1 (0.089±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.45max. (0.057max.)
LBMF1608 CBMF1608	1.1±0.1 (0.043±0.004)	1.9±0.1 (0.075±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.2max. (0.047max.)

Unit : mm (inch)

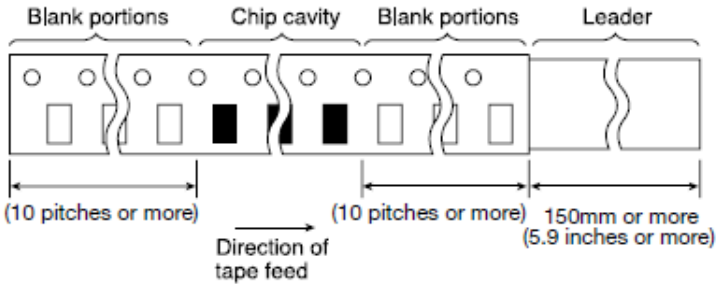
Card board carrier tape (0.315 inches wide)



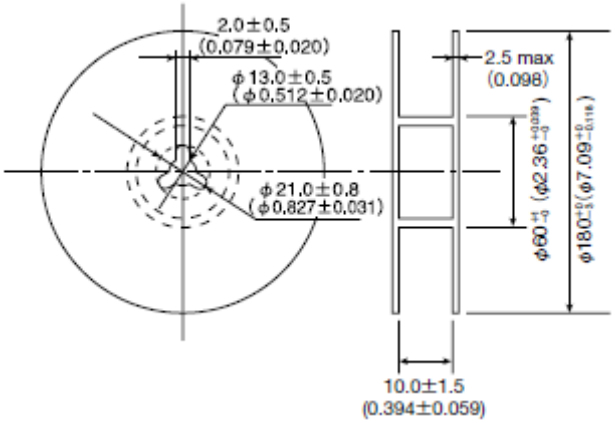
Type	Chip cavity		Insertion pitch	Tape thickness
	A	B	F	T
CB L2012	1.55±0.1 (0.061±0.004)	2.3±0.1 (0.091±0.004)	4.0±0.1 (0.157±0.004)	1.1max. (0.043max.)
LB 1608	1.0±0.1 (0.039±0.004)	1.8±0.1 (0.071±0.004)	4.0±0.1 (0.157±0.004)	1.1max. (0.043max.)

Unit : mm (inch)

④Leader and Blank Portion

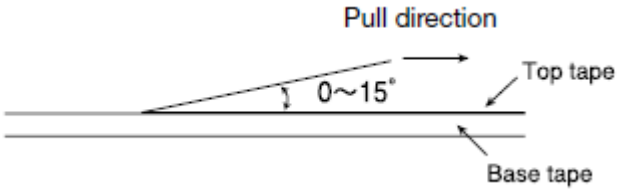


⑤Reel Size



⑥Top Tape Strength

The top tape requires a peel-off force 0.2 to 0.7N in the direction of the arrow as illustrated below.



WIRE-WOUND CHIP INDUCTORS (LB SERIES),
WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES),
WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

■RELIABILITY DATA

1.Operating temperature Range		
Specified Value	LB, LBC, LBR, LBMF Series	−40～＋105℃(Including self-generated heat)
	CB, CBC, CBL, CBMF Series	
	LBM Series	

2. Storage Temperature Range(after soldering)		
Specified Value	LB, LBC, LBR, LBMF Series	−40～＋85℃
	CB, CBC, CBL, CBMF Series	
	LBM Series	
Test Methods and Remarks	LB, CB Series: Please refer the term of "7. storage conditions" in precautions.	

3.Rated Current		
Specified Value	LB, LBC, LBR, LBMF Series	Within the specified tolerance
	CB, CBC, CBL, CBMF Series	
	LBM Series	

4.Inductance		
Specified Value	LB, LBC, LBR, LBMF Series	Within the specified tolerance
	CB, CBC, CBL, CBMF Series	
	LBM Series	
Test Methods and Remarks	LB・LBC・LBR・CB・CBC・CBL・LBMF・CBMF・LBM Series Measuring equipment :LCR Mater(HP4285A or its equivalent)	

5.Q		
Specified Value	LB, LBC, LBR, LBMF Series	—
	CB, CBC, CBL, CBMF Series	
	LBM Series	Within the specified tolerance
Test Methods and Remarks	LBM Series Measuring equipment : LCR Mater(HP4285A or its equivalent)	

6.DC Resisitance		
Specified Value	LB, LBC, LBR, LBMF Series	Within the specified tolerance
	CB, CBC, CBL, CBMF Series	
	LBM Series	
Test Methods and Remarks	Measuring equipment : DC Ohmmeter (HIOKI 3227 or its equivalent)	

7.Self-Resonant Frequency		
Specified Value	LB, LBC, LBR, LBMF Series	Within the specified tolerance
	CB, CBC, CBL, CBMF Series	
	LBM Series	
Test Methods and Remarks	Measuring equipment : Impedance analyzer (HP4291A or its equivalent)	

8.Temperature Characteristic

Specified Value	LBM2016				Inductance change : Within±5%
	LB1608	LB2012	LBR2012	CB2012	Inductance change : Within±20%
	CBL2012	LB2016	CB2016	LB2518	
	LBR2518	CB2518	LBC3225	CBC3225	
	LBMF1608	CBMF1608	LBC2016	CBC2016	Inductance change : Within±25%
	LBC2518	CBC2518	LB3218		
	LBC2012	CBC2012			Inductance change : Within±35%

Test Methods and Remarks

Change of maximum inductance deviation in step 1–5

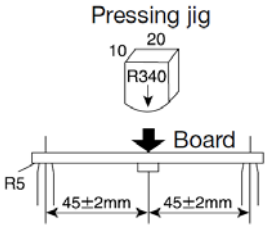
Step	Temperature(℃)
	L, CB Series
1	20
2	−40
3	20(Reference temperature)
4	+85(Maximum operating temperature)
5	20

9.Rasistance to Flexure of Substrate

Specified Value	LB, LBC, LBR, LBMF Series	No damage.
	CB, CBC, CBL, CBMF Series	
	LBM Series	

Test Methods and Remarks

Warp : 2mm(LB・LBC・LBR・CB・CBC・CBL・LBM・LBMF・CBMF Series)
Test substrate : Glass epoxy-resin substrate
Thickness : 0.8mm(LB・LBMF・CBMF1608)
: 1.0mm(Others)



10.Body Strength

Specified Value	LB, LBC, LBR, LBMF Series	No damage.
	CB, CBC, CBL, CBMF Series	
	LBM Series	

Test Methods and Remarks

LB・LBC・LBR・CB・CBC・CBL・LBM
Applied force : 10N
Duration : 10sec.
LB1608・LBMF1608・CBMF1608
Applied force : 5N
Duration : 10sec.

11.Adhesion of terminal electrode

Specified Value	LB, LBC, LBR, LBMF Series	No abnormality.
	CB, CBC, CBL, CBMF Series	
	LBM Series	

Test Methods and Remarks

LB・LBC・LBR・CB・CBC・CBL・LBM・LBMF・CBMF
Applied force : 10N to X and Y directions
Duration : 5 sec.
Test substrate : Printed board
LB1608・CBMF1608・LBMF1608
Applied force : 5N to X and Y directions
Duration : 5 sec.
Test substrate : Printed board

12.Resistance to vibration		
Specified Value	LB, LBC, LBR, LBMF Series	Inductance change : Within±10% No significant abnormality in appearance.
	CB, CBC, CBL, CBMF Series	
	LBM Series	Inductance change : Within±5% No significant abnormality in appearance.
Test Methods and Remarks	LB・LBR・LBC・CB・CBC・CBL・LBM・LBMF・CBMF : According to JIS C5102 clause 8.2. Vibration type : A Directions : 2 hrs each in X, Y and Z directions. Total : 6 hrs Frequency range : 10 to 55 to 10 Hz (1min.) Amplitude : 1.5mm Mounting method : Soldering onto printed board Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

13.Drop test		
Specified Value	LB, LBC, LBR, LBMF Series	—
	CB, CBC, CBL, CBMF Series	
	LBM Series	

14.Solderability		
Specified Value	LB, LBC, LBR, LBMF Series	At least 90% of surface of terminal electrode is covered by new
	CB, CBC, CBL, CBMF Series	
	LBM Series	
Test Methods and Remarks	LB・LBC・LBR・CB・CBC・CBL・LBM・LBMF・CBMF : Solder temperature : 245±5℃ Duration : 5±0.5sec Flux : Methanol solution with 25% of colophony	

15.Resistance to soldering		
Specified Value	LB, LBC, LBR, LBMF Series	Inductance change : Within±10%
	CB, CBC, CBL, CBMF Series	
	LBM Series	Inductance change : Within±5%
Test Methods and Remarks	LB・LBC・LBR・CB・CBC・CBL・LBM・LBMF・CBMF : 3 times of reflow oven at 230℃ MIN for 40sec. with peak temperature at 260 ℃ for 5sec.	

16.Resisitance to solvent		
Specified Value	LB, LBC, LBR, LBMF Series	—
	CB, CBC, CBL, CBMF Series	
	LBM Series	
Test Methods and Remarks	Solvent temperature : Room temperature Type of solvent : Isopropyl alcohol Cleaning conditions : 90s. Immersion and cleaning.	

17.Thermal shock		
Specified Value	LB, LBC, LBR, LBMF Series	Inductance change : Within±10% No significant abnormality in appearance.
	CB, CBC, CBL, CBMF Series	
	LBM Series	
Test Methods and Remarks	LB・LBC・LBR・CB・CBC・CBL・LBM・LBMF・CBMF : −40～＋85℃, maintain times 30min. ,100 cycle Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

18.Damp heat life test		
Specified Value	LB, LBC, LBR, LBMF Series	Inductance change : Within±10% No significant abnormality in appearance.
	CB, CBC, CBL, CBMF Series	
	LBM Series	
Test Methods and Remarks	Temperature : 60±2℃ Humidity : 90～95%RH Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

19.Loading under damp heat life test		
Specified Value	LB, LBC, LBR, LBMF Series	Inductance change : Within±10% No significant abnormality in appearance.
	CB, CBC, CBL, CBMF Series	
	LBM Series	
Test Methods and Remarks	Temperature : 60±2℃ Humidity : 90～95%RH Duration : 1000 hrs Applied current : Rated current Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

20.High temperature life test		
Specified Value	LB, LBC, LBR, LBMF Series	—
	CB, CBC, CBL, CBMF Series	Inductance change : Within±10% No significant abnormality in appearance.
	LBM Series	
Test Methods and Remarks	Temperature : 85±2℃ Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

21.Loading at high temperature life test		
Specified Value	LB, LBC, LBR, LBMF Series	Inductance change : Within±10% (LBC3225 Series : Within±20%) No significant abnormality in appearance.
	CB, CBC, CBL, CBMF Series	—
	LBM Series	
Test Methods and Remarks	Temperature : 85±2℃ Duration : 1000 hrs Applied current : Rated current Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

22.Low temperature life test		
Specified Value	LB, LBC, LBR, LBMF Series	Inductance change : Within±10% No significant abnormality in appearance.
	CB, CBC, CBL, CBMF Series	
	LBM Series	
Test Methods and Remarks	Temperature : −40±2℃ Duration : 1000 hrs Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.	

23.Standard condition		
Specified Value	LB, LBC, LBR, LBMF Series	Standard test conditions Unless specified, Ambient temperature is 20±15℃ and the Relative humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits: Ambient Temperature: 20±2℃ Relative humidity: 65±5% Inductance value is based on our standard measurement systems.
	CB, CBC, CBL, CBMF Series	
	LBM Series	

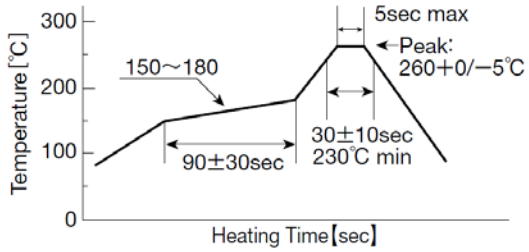
WIRE-WOUND CHIP INDUCTORS (LB SERIES),
WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES),
WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

■PRECAUTIONS

1. Circuit Design	
Precautions	◆Operating environment 1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

2. PCB Design	
Precautions	◆Land pattern design 1. Please contact any of our offices for a land pattern, and refer to a recommended land pattern of a right figure or specifications.
Technical considerations	PRECAUTIONS 【Recommended Land Patterns】 Surface Mounting ・ Mounting and soldering conditions should be checked beforehand. ・ Applicable soldering process to those products is reflow soldering only.

3. Considerations for automatic placement	
Precautions	◆Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand.
Technical considerations	1. When installing products, care should be taken not to apply distortion stress as it may deform the products.

4. Soldering	
Precautions	◆Reflow soldering(LB and CB Types) 1. For reflow soldering with either leaded or lead-free solder, the profile specified in "point for controlling" is recommended. ◆Recommended conditions for using a soldering iron 1. Put the soldering iron on the land-pattern. Soldering iron's temperature – Below 350℃ Duration-3 seconds or less. The soldering iron should not come in contact with inductor directly.
Technical considerations	◆Reflow soldering(LB and CB Types) 1. Reflow profile  ◆Recommended conditions for using a soldering iron 1. Components can be damaged by excessive heat where soldering conditions exceed the specified range.

5. Cleaning	
Precautions	◆Cleaning conditions Washing by supersonic waves shall be avoided.
Technical considerations	◆Cleaning conditions If washed by supersonic waves, the products might be broken.

6. Handling	
Precautions	◆Handling 1. Keep the inductors away from all magnets and magnetic objects. ◆Breakaway PC boards (splitting along perforations) 1. When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations 1. Please do not give the inductors any excessive mechanical shocks.
Technical considerations	◆Handling 1. There is a case that a characteristic varies with magnetic influence. ◆Breakaway PC boards (splitting along perforations) 1. Planning pattern configurations and the position of products should be carefully performed to minimize stress. ◆Mechanical considerations 1. There is a case to be damaged by a mechanical shock.

7. Storage conditions	
Precautions	◆Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. ・ Recommended conditions Ambient temperature : 0～40℃ / Humidity : Below 70% RH The ambient temperature must be kept below 30℃ even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, LB type : Should be used within 6 months from the time of delivery.
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.

MULTILAYER CHIP POWER INDUCTORS(CK SERIES P TYPE / NM SERIES)

WAVE REFLOW

■PARTS NUMBER

＊Operating Temp.:−40〜+85℃

C K P	2 5 2 0	V	1 R 0	M	− T	△
①	②	③	④	⑤	⑥	⑦

△=Blank space

①Series name

Code	Series name
CKP	Multilayer chip power inductor
NM△	Multilayer chip power inductor (Temperature characteristic improved)

②Dimensions(L×W)

Code	Type(inch)	Dimensions (L×W)[mm]
1608	1608(0603)	1.6×0.8
2012	2012(0805)	2.0×1.25
2016	2016(0806)	2.0×1.6
2520	2520(1008)	2.5×2.0

③Thickness

Code	Thickness[mm]
V	1.2 max
△	1.0 max
N	
C	
E	
D	0.95 max
M	0.8 max

④Nominal inductance

Code (example)	Nominal inductance[μH]
1R0	1.0
R82	0.82

※R=Decimal point

⑤Inductance tolerance

Code	Inductance tolerance
M	±20%
	※NM 2520V2R2M: +30/−10%

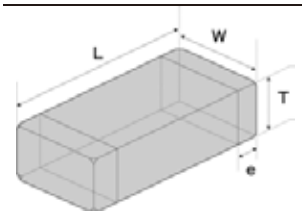
⑥Packaging

Code	Packaging
−T	Taping

⑦Internal code

Code	Internal code
△	Standard

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Type	L	W	T	e	Standard quantity[pcs]	
					Paper tape	Embossed tape
CKP1608 (0603)	1.6±0.15 (0.063±0.006)	0.8±0.15 (0.031±0.006)	0.95 max (0.037 max)	0.3±0.2 (0.012±0.008)	4000	−
CKP2012 NM 2012 (0805)	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	1.0 max (0.039 max)	0.5±0.3 (0.02±0.012)	−	3000
CKP2016 (0806)	2.0±0.2 (0.079±0.008)	1.6±0.2 (0.063±0.008)	1.0 max (0.039 max)	0.5±0.3 (0.02±0.012)	−	3000
CKP2520 NM 2520 (1008)	2.5±0.2 (0.098±0.008)	2.0±0.2 (0.079±0.008)	0.8 max (0.031 max)	0.5±0.3 (0.02±0.012)	−	3000
	2.5±0.2 (0.098±0.008)	2.0±0.2 (0.079±0.008)	1.0 max (0.039 max)	0.5±0.3 (0.02±0.012)	−	3000
	2.5±0.2 (0.098±0.008)	2.0±0.2 (0.079±0.008)	1.2 max (0.047 max)	0.5±0.3 (0.02±0.012)	−	2000

Unit:mm(inch)

■PARTS NUMBER

●CKP1608

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	DC Resistance [Ω] (max.)	DC Resistance [Ω] (typ.)	Rated current [A] (max.)	Measuring frequency [MHz]	Thickness [mm] (max.)
CKP1608DR33M-T	RoHS	0.33	±20%	0.35	0.27	0.35	1	0.95
CKP1608DR50M-T	RoHS	0.5	±20%	0.15	0.12	0.9	1	0.95
CKP1608D1R0M-T	RoHS	1.0	±20%	0.20	0.17	0.75	1	0.95
CKP1608D2R2M-T	RoHS	2.2	±20%	0.30	0.27	0.65	1	0.95

●CKP2012

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	DC Resistance [Ω] (max.)	DC Resistance [Ω] (typ.)	Rated current [A] (max.)	Measuring frequency [MHz]	Thickness [mm] (max.)
CKP2012NR47M-T	RoHS	0.47	±20%	0.08	0.06	1.2	1	1.0
CKP2012N1R0M-T	RoHS	1.0	±20%	0.14	0.11	1.0	1	1.0
CKP2012N1R5M-T	RoHS	1.5	±20%	0.20	0.15	0.8	1	1.0
CKP2012N2R2M-T	RoHS	2.2	±20%	0.20	0.15	0.8	1	1.0
CKP2012N3R3M-T	RoHS	3.3	±20%	0.24	0.20	0.7	1	1.0
CKP2012N4R7M-T	RoHS	4.7	±20%	0.28	0.23	0.7	1	1.0
CKP2012E1R0M-T	RoHS	1.0	±20%	0.10	0.08	1.7	1	1.0
CKP2012E2R2M-T	RoHS	2.2	±20%	0.16	0.12	1.3	1	1.0

●CKP2016

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	DC Resistance [Ω] (max.)	DC Resistance [Ω] (typ.)	Rated current [A] (max.)	Measuring frequency [MHz]	Thickness [mm] (max.)
CKP2016 R47M-T	RoHS	0.47	±20%	0.075	0.06	1.6	1	1.0
CKP2016 1R0M-T	RoHS	1.0	±20%	0.12	0.09	1.3	1	1.0
CKP2016 1R5M-T	RoHS	1.5	±20%	0.13	0.10	1.2	1	1.0
CKP2016 2R2M-T	RoHS	2.2	±20%	0.14	0.11	1.2	1	1.0
CKP2016 3R3M-T	RoHS	3.3	±20%	0.16	0.13	1.1	1	1.0
CKP2016 4R7M-T	RoHS	4.7	±20%	0.20	0.16	0.9	1	1.0

●CKP2520

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	DC Resistance [Ω] (max.)	DC Resistance [Ω] (typ.)	Rated current [A] (max.)	Measuring frequency [MHz]	Thickness [mm] (max.)
CKP2520M1R5M-T	RoHS	1.5	±20%	0.09	0.075	1.3	1	0.8
CKP2520M2R2M-T	RoHS	2.2	±20%	0.10	0.08	1.2	1	0.8
CKP2520 R47M-T	RoHS	0.47	±20%	0.05	0.04	1.8	1	1.0
CKP2520 1R0M-T	RoHS	1.0	±20%	0.08	0.065	1.4	1	1.0
CKP2520 1R5M-T	RoHS	1.5	±20%	0.09	0.075	1.3	1	1.0
CKP2520 2R2M-T	RoHS	2.2	±20%	0.09	0.075	1.3	1	1.0
CKP2520 3R3M-T	RoHS	3.3	±20%	0.12	0.09	1.2	1	1.0
CKP2520 4R7M-T	RoHS	4.7	±20%	0.15	0.12	1.1	1	1.0
CKP2520C1R0M-T	RoHS	1.0	±20%	0.08	0.06	1.4	1	1.0
CKP2520N1R0M-T	RoHS	1.0	±20%	0.115	0.09	1.2	1	1.0
CKP2520N2R2M-T	RoHS	2.2	±20%	0.115	0.09	1.2	1	1.0
CKP2520N2R7M-T	RoHS	2.7	±20%	0.15	0.12	1.1	1	1.0
CKP2520N4R7M-T	RoHS	4.7	±20%	0.16	0.14	1.1	1	1.0
CKP2520V1R0M-T	RoHS	1.0	±20%	0.12	0.09	1.2	1	1.2
CKP2520V2R2M-T	RoHS	2.2	±20%	0.15	0.12	1.1	1	1.2
CKP2520V2R7M-T	RoHS	2.7	±20%	0.15	0.12	1.1	1	1.2
CKP2520V3R3M-T	RoHS	3.3	±20%	0.15	0.11	1.1	1	1.2
CKP2520V4R7M-T	RoHS	4.7	±20%	0.16	0.14	1.1	1	1.2

●NM 2012

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	DC Resistance [Ω] (max.)	DC Resistance [Ω] (typ.)	Rated current [A] (max.)	Measuring frequency [MHz]	Thickness [mm] (max.)
NM 2012NR82M-T	RoHS	0.82	±20%	0.10	0.085	1.2	1	1.0
NM 2012N1R0M-T	RoHS	1.0	±20%	0.15	0.12	1.0	1	1.0

●NM 2520

Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	DC Resistance [Ω] (max.)	DC Resistance [Ω] (typ.)	Rated current [A] (max.)	Measuring frequency [MHz]	Thickness [mm] (max.)
NM 2520N1R0M-T	RoHS	1.0	±20%	0.11	0.08	1.2	1	1.0
NM 2520V1R0M-T	RoHS	1.0	±20%	0.13	0.10	1.1	1	1.2
NM 2520V2R2M-T	RoHS	2.2	+30/−10%	0.22	0.18	0.9	1	1.2

※ Rated current specifies that self-heat generation is below 40 degC during DC loaded (at 20 degC).

▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) .

Multilayer chip inductors
Multilayer chip inductors for high frequency, Multilayer chip bead inductors
Multilayer common mode choke coils (MC series F type)
Metal Multilayer Chip Power Inductors (MCOIL™ MC series)

■PACKAGING

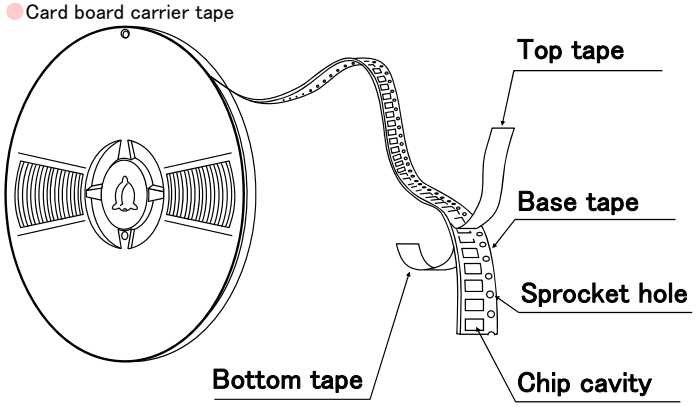
①Minimum Quantity

●Tape & Reel Packaging

Type	Thickness mm (inch)	Standard Quantity [pcs]	
		Paper Tape	Embossed Tape
CK1608 (0603)	0.8 (0.031)	4000	—
CK2125 (0805)	0.85 (0.033)	4000	—
	1.25 (0.049)	—	2000
CKS2125 (0805)	0.85 (0.033)	4000	—
	1.25 (0.049)	—	2000
CKP1608 (0603)	0.8 (0.031)	4000	—
CKP2012 (0805)	0.9 (0.035)	—	3000
CKP2016 (0806)	0.9 (0.035)	—	3000
CKP2520 (1008)	0.7 (0.028)	—	3000
	0.9 (0.035)	—	3000
	1.1 (0.043)	—	2000
NM2012 (0805)	0.9 (0.035)	—	3000
NM2520 (1008)	0.9 (0.035)	—	3000
	1.1 (0.043)	—	2000
LK1005 (0402)	0.5 (0.020)	10000	—
LK1608 (0603)	0.8 (0.031)	4000	—
LK2125 (0805)	0.85 (0.033)	4000	—
	1.25 (0.049)	—	2000
HK0603 (0201)	0.3 (0.012)	15000	—
HK1005 (0402)	0.5 (0.020)	10000	—
HK1608 (0603)	0.8 (0.031)	4000	—
HK2125 (0805)	0.85 (0.033)	—	4000
	1.0 (0.039)	—	3000
HKQ0402 (01005)	0.2 (0.008)	20000	40000
HKQ0603W (0201)	0.3 (0.012)	15000	—
HKQ0603C (0201)	0.3 (0.012)	15000	—
HKQ0603S (0201)	0.3 (0.012)	15000	—
HKQ0603U (0201)	0.3 (0.012)	15000	—
AQ105 (0402)	0.5 (0.020)	10000	—
BK0402 (01005)	0.2 (0.008)	20000	—
BK0603 (0201)	0.3 (0.012)	15000	—
BK1005 (0402)	0.5 (0.020)	10000	—
BKH0603 (0201)	0.3 (0.012)	15000	—
BKH1005 (0402)	0.5 (0.020)	10000	—
BK1608 (0603)	0.8 (0.031)	4000	—
BK2125 (0805)	0.85 (0.033)	4000	—
	1.25 (0.049)	—	2000
BK2010 (0804)	0.45 (0.018)	4000	—
BK3216 (1206)	0.8 (0.031)	—	4000
BKP0402 (01005)	0.2 (0.008)	20000	—
BKP0603 (0201)	0.3 (0.012)	15000	—
BKP1005 (0402)	0.5 (0.020)	10000	—
BKP1608 (0603)	0.8 (0.031)	4000	—
BKP2125 (0805)	0.85 (0.033)	4000	—
MCF0605 (0202)	0.3 (0.012)	15000	—
MCF0806 (0302)	0.4 (0.016)	—	10000
MCF1210 (0504)	0.55 (0.022)	—	5000
MCF2010 (0804)	0.45 (0.018)	—	4000
MCFE1608 (0603)	0.65 (0.026)	4000	-
MCKK2012 (0805)	1.00 (0.039)	-	3000

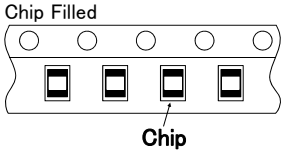
②Taping material

Card board carrier tape

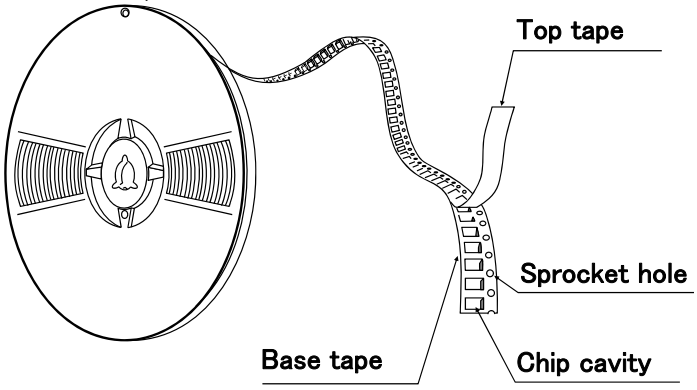


CK	1608
CKP	1608
CK	2125
CKS	2125
LK	1005
LK	1608
LK	2125
HK	0603
HK	1005
HK	1608
HKQ	0402
HKQ	0603
AQ	105

BK	0402
BK	0603
BK	1005
BK	1608
BK	2125
BK	2010
BKP	0402
BKP	0603
BKP	1005
BKP	1608
BKP	2125
BKH	0603
BKH	1005
MCF	0605
MC	1608

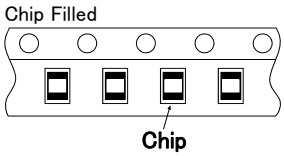


Embossed Tape



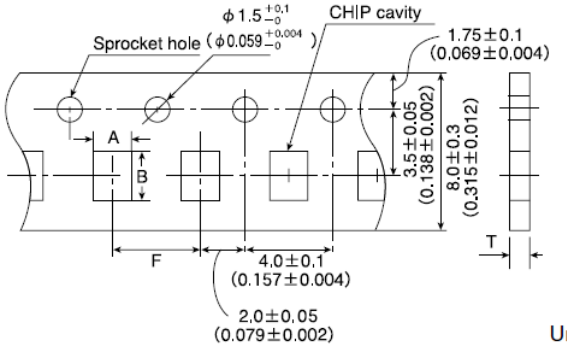
CK	2125
CKS	2125
CKP	2012
CKP	2016
CKP	2520
NM	2012
NM	2520
LK	2125
HKQ	0402
HK	2125

BK	2125
BK	3216
MCF	0806
MCF	1210
MCF	2010
MC	2012



③Taping Dimensions

Paper tape (8mm wide)

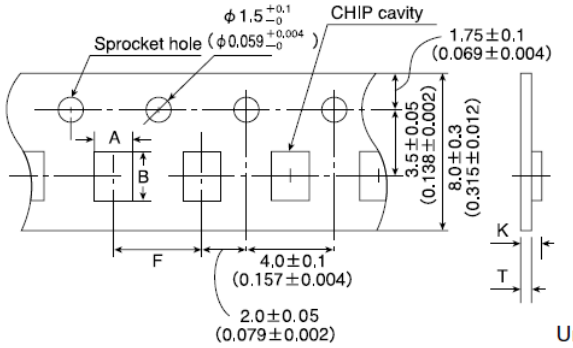


Unit : mm (inch)

Type	Thickness mm(inch)	Chip cavity		Insertion Pitch	Tape Thickness
		A	B	F	T
CK1608(0603)	0.8 (0.031)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
CK2125(0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
CKS2125(0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
CKP1608(0603)	0.8 (0.031)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
LK1005(0402)	0.5 (0.020)	0.65±0.1 (0.026±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
LK1608(0603)	0.8 (0.031)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
LK2125(0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
HK0603(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
HK1005(0402)	0.5 (0.020)	0.65±0.1 (0.026±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
HK1608(0603)	0.8 (0.031)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
HKQ0402(01005)	0.2 (0.008)	0.25±0.04 (0.010±0.002)	0.45±0.04 (0.018±0.002)	2.0±0.05 (0.079±0.002)	0.36max (0.014max)
HKQ0603W(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
HKQ0603C(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
HKQ0603S(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
HKQ0603U(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
AQ105(0402)	0.5 (0.020)	0.75±0.1 (0.030±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
BK0402(01005)	0.2 (0.008)	0.25±0.04 (0.010±0.002)	0.45±0.04 (0.018±0.002)	2.0±0.05 (0.079±0.002)	0.36max (0.014max)
BK0603(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
BK1005(0402)	0.5 (0.020)	0.65±0.1 (0.026±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
BK1608(0603)	0.8 (0.031)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
BK2125(0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
BK2010(0804)	0.45(0.018)	1.2±0.1 (0.047±0.004)	2.17±0.1 (0.085±0.004)	4.0±0.1 (0.157±0.004)	0.8max (0.031max)
BKP0402(01005)	0.2 (0.008)	0.25±0.04 (0.010±0.002)	0.45±0.04 (0.018±0.002)	2.0±0.05 (0.079±0.002)	0.36max (0.014max)
BKP0603(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
BKP1005(0402)	0.5 (0.020)	0.65±0.1 (0.026±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
BKP1608(0603)	0.8 (0.031)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
BKP2125(0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
BKH0603(0201)	0.3 (0.012)	0.40±0.06 (0.016±0.002)	0.70±0.06 (0.028±0.002)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
BKH1005(0402)	0.5 (0.020)	0.65±0.1 (0.026±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
MCF0605(0202)	0.3 (0.012)	0.62±0.03 (0.024±0.001)	0.77±0.03 (0.030±0.001)	2.0±0.05 (0.079±0.002)	0.45max (0.018max)
MCFE1608(0603)	0.65(0.026)	1.1±0.05 (0.043±0.002)	1.9±0.05 (0.075±0.002)	4.0±0.1 (0.157±0.004)	0.72max (0.028max)

Unit : mm(inch)

● Embossed Tape (8mm wide)

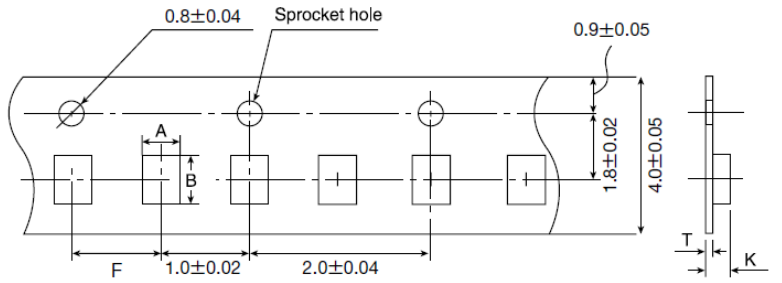


Unit : mm (inch)

Type	Thickness mm(inch)	Chip cavity		Insertion Pitch	Tape Thickness	
		A	B	F	K	T
CK2125(0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
CKS2125(0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
CKP2012(0805)	0.9 (0.035)	1.55±0.2 (0.061±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.3 (0.012)
CKP2016(0806)	0.9 (0.035)	1.8±0.1 (0.071±0.004)	2.2±0.1 (0.087±0.004)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.25 (0.01)
CKP2520(1008)	0.7 (0.028)	2.3±0.1 (0.091±0.004)	2.8±0.1 (0.110±0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)
	0.9 (0.035)				1.4 (0.055)	
	1.1 (0.043)				1.7 (0.067)	
NM2012(0805)	0.9 (0.035)	1.55±0.2 (0.061±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.3 (0.012)
NM2520(1008)	0.9 (0.035)	2.3±0.1 (0.091±0.004)	2.8±0.1 (0.110±0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)
	1.1 (0.043)				1.7 (0.067)	
LK2125(0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
HK2125(0805)	0.85(0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.5 (0.059)	0.3 (0.012)
	1.0 (0.039)				2.0 (0.079)	
BK2125(0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
BK3216(1206)	0.8(0.031)	1.9±0.1 (0.075±0.004)	3.5±0.1 (0.138±0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)
MCF0806(0302)	0.4 (0.016)	0.75±0.05 (0.030±0.002)	0.95±0.05 (0.037±0.002)	2.0±0.05 (0.079±0.002)	0.55 (0.022)	0.3 (0.012)
MCF1210(0504)	0.55(0.022)	1.15±0.05 (0.045±0.002)	1.40±0.05 (0.055±0.002)	4.0±0.1 (0.157±0.004)	0.65 (0.026)	0.3 (0.012)
MCF2010(0804)	0.45(0.018)	1.1±0.1 (0.043±0.004)	2.3±0.1 (0.091±0.004)	4.0±0.1 (0.157±0.004)	0.85 (0.033)	0.3 (0.012)
MCKK2012(0805)	1.0 (0.039)	1.55±0.2 (0.061±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.25 (0.010)

Unit : mm(inch)

Embossed Tape (4mm wide)

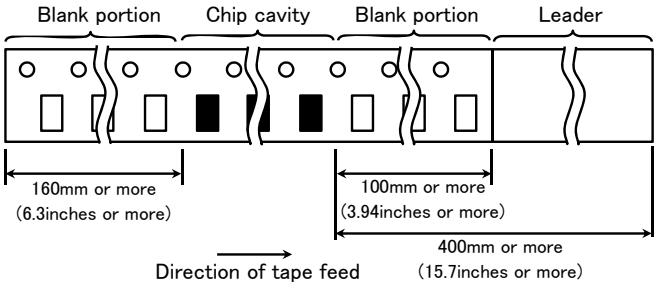


Unit : mm

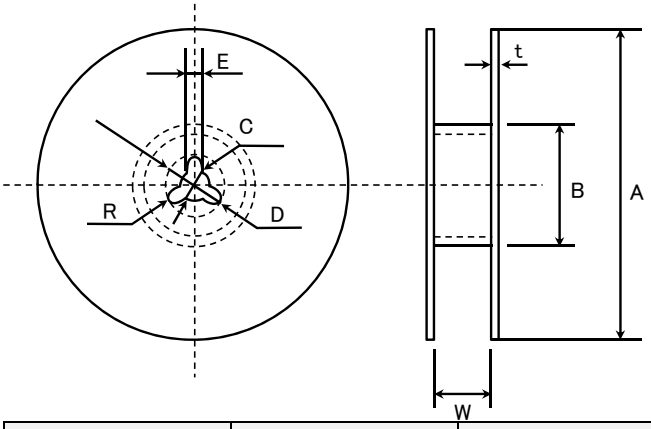
Type	Thickness mm(inch)	Chip cavity		Insertion Pitch	Tape Thickness	
		A	B	F	K	T
HKQ0402(01005)	0.2 (0.008)	0.23	0.43	1.0±0.02	0.5max.	0.25max.

Unit : mm

④LEADER AND BLANK PORTION



⑤Reel Size



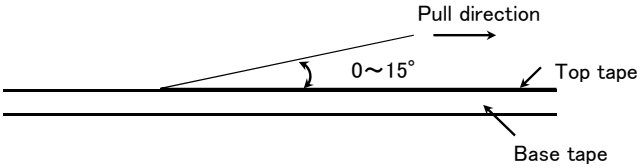
A	B	C	D	E	R
ϕ178±2.0	ϕ50 or more	ϕ13.0±0.2	ϕ21.0±0.8	2.0±0.5	1.0

	t	W
4mm width tape	1.5max.	5±1.0
8mm width tape	2.5max.	10±1.5

(Unit : mm)

⑥Top tape strength

The top tape requires a peel-off force of 0.1～0.7N in the direction of the arrow as illustrated below.



■RELIABILITY DATA

1. Operating Temperature Range			
Specified Value	BK0402		−55～＋125℃
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		−55～＋85℃
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		−40～＋85℃
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		−40～＋85℃
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HKQ0402		−55～＋125℃
	HK0603		
	HK1005		
	HK1608		−40～＋85℃
	HK2125		
	HKQ0603W/HKQ0603C/HKQ0603S/ HKQ0603U/		−55～＋125℃
	AQ105		
	MCFE1608		−40～＋125℃(Including self-generated heat)
	MCKK2012		

2. Storage Temperature Range			
Specified Value	BK0402		−55～＋125℃
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		−55～＋85℃
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		−40～＋85℃
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		−40～＋85℃
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HKQ0402		−55～＋125℃
	HK0603		
	HK1005		
	HK1608		−40～＋85℃
	HK2125		
	HKQ0603W/HKQ0603C/HKQ0603S/ HKQ0603U/		−55～＋125℃
	AQ105		
	MCFE1608		−40～＋85℃
	MCKK2012		

3. Rated Current			
Specified Value	BK0402		150～750mA DC
	BK0603		100～500mA DC
	BK1005		120～1000mA DC
	BKH0603		115～450mA DC
	BKH1005		200～300mA DC
	BK1608		150～1500mA DC
	BK2125		200～1200mA DC
	ARRAY	BK2010	100mA DC
		BK3216	100～200mA DC
	BKP0402		0.55～1.1A DC
	BKP0603		0.8～1.8A DC
	BKP1005		0.8～2.4A DC
	BKP1608		1.0～3.0A DC
	BKP2125		1.5～4.0A DC
	MCF 0605		0.05A DC
	MCF 0806		0.1～0.13A DC
	MCF 1210		0.1～0.15A DC
	MCF 2010		0.1A DC
	CK1608		50～60mA DC
	CK2125		60～500mA DC
	CKS2125		110～280mA DC
	CKP1608		0.35～0.9A DC
	CKP2012		0.7～1.7A DC
	CKP2016		0.9～1.6A DC
	CKP2520		1.1～1.8A DC
	NM2012		1.0～1.2A DC
	NM2520		0.9～1.2A DC
	LK1005		20～25mA DC
	LK1608		1～150mA DC
	LK2125		5～300mA DC
	HK0603		60～470mA DC
	HK1005		110～300mA DC (−55～+125℃) 200～900mA DC (−55～+85℃)
	HK1608		150～300mA DC
	HK2125		300mA DC
	HKQ0402		100～500mA DC
	HKQ0603W		100～850mA DC
	HKQ0603C		160～850mA DC
	HKQ0603S		130～600mA DC
	HKQ0603U		190～900mA DC
	AQ105		280～710mA DC
	MCFE1608		Idc1 :1400～2600mA DC, Idc2 :800～1500mA DC
	MCKK2012		Idc1 :2000mA DC, Idc2 :1400mA DC

Definition of rated current:

・In the CK, CKS and BK Series, the rated current is the value of current at which the temperature of the element is increased within 20℃.

・In the BK Series P type, CK Series P type, NM Series, the rated current is the value of current at which the temperature of the element is increased within 40℃.

・In the LK, HK, HKQ0603, and AQ Series, the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20℃.

・In the HKQ0402(～9N1), the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20℃.

・In the HKQ0402(10N～), the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 25℃.

・In the MC Series, Idc1 is the DC value at which the initial L value is decreased within 30% and Idc2 is the DC value at which the temperature of element is increased within 40℃ by the application of DC bias. (at 20℃)

4. Impedance			
Specified Value	BK0402		10～330Ω ±5Ω(10Ω), ±25%(Other)
	BK0603		10～1200Ω ±25%
	BK1005		10～1800Ω ±25%
	BKH0603		25～1500Ω ±25%
	BKH1005		600～1800Ω ±25%
	BK1608		22～2500Ω ±25%
	BK2125		15～2500Ω ±25%
	ARRAY	BK2010	5～1000Ω ±25%
		BK3216	60～1000Ω ±25%
	BKP0402		10～33Ω ±5Ω(10Ω)、±25%(Other)
	BKP0603		10～120Ω ±5Ω(10Ω), ±25%(Other)
	BKP1005		10～330Ω ±5Ω(EM100), ±25%(Other)
	BKP1608		33～470Ω ±25%
	BKP2125		33～330Ω ±25%
	MCF 0605		12～90Ω ±5Ω(12Ω), ±20%(35Ω), ±25%(Other)
	MCF 0806		12～90Ω ±5Ω(12Ω), ±20%(Other)
	MCF 1210		40～90Ω ±20%(2H900),±25%(Other)
	MCF 2010		90Ω ±25%
	CK1608		–
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HKQ0402		
	HK0603		
	HK1005		
	HK1608		
	HK2125		
	HKQ0603W/HKQ0603C/HKQ0603S/ HKQ0603U		
	AQ105		
	MCFE1608		
	MCKK2012		

Test Methods and Remarks

BK0402Series, BKP0402Series
- Measuring frequency : 100±1MHz
- Measuring equipment : E4991A(or its equivalent)
- Measuring jig : 16197A(or its equivalent)

BK0603Series, BKP0603Series
- Measuring frequency : 100±1MHz
- Measuring equipment : 4291A(or its equivalent)
- Measuring jig : 16193A(or its equivalent)

BK1005Series, BKP1005Series ,BKH1005Series
- Measuring frequency : 100±1MHz
- Measuring equipment : 4291A(or its equivalent)
- Measuring jig : 16192A(or its equivalent), 16193A(or its equivalent)

BK1608・2125Series, BKP1608・2125Series
- Measuring frequency : 100±1MHz
- Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)
- Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW

BK2010・3216Series, MCF Series
- Measuring frequency : 100±1MHz
- Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)
- Measuring jig : 16192A(or its equivalent)

5. Inductance

Specified Value	BK0402		—
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		4.7～10.0 μH: ±20%
	CK2125		0.1～10.0 μH: ±20%
	CKS2125		1.0～10.0 μH: ±20%
	CKP1608		0.33～2.2 μH: ±20%
	CKP2012		0.47～4.7 μH: ±20%
	CKP2016		0.47～4.7 μH: ±20%
	CKP2520		0.47～4.7 μH: ±20%
	NM2012		0.82～1.0 μH: ±20%
	NM2520		1.0～2.2 μH: ±20%
	LK1005		0.12～2.2 μH: ±10 or 20%
	LK1608		0.047～33.0 μH: ±20%　0.10～12.0 μH: ±10%
	LK2125		0.047～33.0 μH: ±20%　0.10～12.0 μH: ±10%
	HK0603		1.0～6.2nH: ±0.3nH　6.8～100nH: ±5%
	HK1005		1.0～6.2nH: ±0.3nH　6.8～270nH: ±5%
	HK1608		1.0～5.6nH: ±0.3nH　6.8～470nH: ±5%
	HK2125		1.5～5.6nH: ±0.3nH　6.8～470nH: ±5%
	HKQ0402		0.5～3.9nH: ±0.1 or 0.2 or 0.3nH　4.3～5.6nH: ±0.3nH or 3% or 5% 6.2～47nH: ±3 or 5%
	HKQ0603W		0.6～3.9nH: ±0.1 or 0.2 or 0.3nH　4.3～6.2nH: ±0.2 or 0.3nH or 3 or 5% 6.8～27nH: ±3 or 5%　33～100nH: ±5%
	HKQ0603C		0.6～3.9nH: ±0.1 or 0.2 or 0.3nH　4.3～6.2nH: ±0.2 or 0.3nH　6.8～22nH: ±3 or 5%
	HKQ0603S		0.6～6.2nH: ±0.2 or 0.3nH　6.8～22nH: ±3 or 5%
	HKQ0603U		0.6～4.2nH: ±0.1 or 0.2 or 0.3nH　4.3～6.5nH: ±0.2 or 0.3nH　6.8～22nH: ±3 or 5%
	AQ105		1.0～6.2nH: ±0.3nH　6.8～15nH: ±5%
	MCFE1608		0.24～1.0 μH: ±20%
	MCKK2012		1.0　μH: ±20%

Test Methods and Remarks

CK、LK、CKP、NM、MC Series

- Measuring frequency : 2～4MHz(CK1608)
- Measuring frequency : 2～25MHz(CK2125)
- Measuring frequency : 2～10MHz(CKS2125)
- Measuring frequency : 10～25MHz(LK1005)
- Measuring frequency : 1～50MHz(LK1608)
- Measuring frequency : 0.4～50MHz(LK2125)
- Measuring frequency : 1MHz(CKP1608・CKP2012・CKP2016・CKP2520・NM2012・NM2520・MCFE1608・MCKK2012)
- Measuring equipment /jig :・4194A＋16085B＋16092A(or its equivalent)　・4195A＋41951＋16092A(or its equivalent)
  ・4294A＋16192A(or its equivalent)　・4291A＋16193A(or its equivalent)/LK1005
  ・4285A＋42841A＋42842C＋42851－61100(or its equivalent)/CKP1608・CKP2012・CKP2016・CKP2520・NM2012・NM2520・MCFE1608・MCKK2012
- Measuring current :・1mA rms(0.047～4.7 μH)
  ・0.1mA rms(5.6～33 μH)

HK、HKQ、AQ Series

- Measuring frequency : 100MHz(HK0603・HK1005・AQ105)
- Measuring frequency : 50/100MHz(HK1608・HK2125)
- Measuring frequency : 500MHz(HKQ0603C・HKQ0603S・HKQ0603U)
- Measuring frequency : 300/500MHz(HKQ0603W)
- Measuring frequency : 100/500MHz(HKQ0402)
- Measuring equipment /jig :・4291A＋16197A(or its equivalent)/HK0603・AQ105
  ・4291A＋16193A(or its equivalent)/HK1005
  ・E4991A＋16197A(or its equivalent)/HKQ0603S・HKQ0603U・HKQ0603W・HKQ0603C
  ・4291A＋16092A ＋ in-house made jig(or its equivalent)/HK1608・HK2125
  ・E4991A＋16196D(or its equivalent)/HKQ0402

6. Q			
Specified Value	BK0402		—
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		—
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		10～20 min.
	LK1608		10～35 min.
	LK2125		15～50 min.
	HK0603		4～5 min.
	HK1005		8 min.
	HK1608		8～12 min.
	HK2125		10～18 min.
	HKQ0402		3～8 min.
	HKQ0603W		6～15 min.
	HKQ0603C		14～15 min.
	HKQ0603S		10～13 min.
	HKQ0603U		14 min.
	AQ105		8 min.
	MCFE1608		—
	MCKK2012		

Test Methods and Remarks

LK Series

Measuring frequency	: 10～25MHz(LK1005)
Measuring frequency	: 1～50MHz(LK1608)
Measuring frequency	: 0.4～50MHz(LK2125)
Measuring equipment /jig	:・4194A＋16085B＋16092A(or its equivalent)
	・4195A＋41951＋16092A(or its equivalent)
	・4294A＋16192A(or its equivalent)
	・4291A＋16193A(or its equivalent)/LK1005
Measuring current	・1mA rms(0.047～4.7 μH)
	・0.1mA rms(5.6～33 μH)

HK、HKQ、AQ Series

Measuring frequency	: 100MHz(HK0603・HK1005・AQ105)
Measuring frequency	: 50/100MHz(HK1608・HK2125)
Measuring frequency	: 500MHz(HKQ0603C・HKQ0603S・HKQ0603U)
Measuring frequency	: 300/500MHz(HKQ0603W)
Measuring frequency	: 100/500MHz(HKQ0402)
Measuring equipment /jig	:・4291A＋16197A(or its equivalent)/HK0603・AQ105
	・4291A＋16193A(or its equivalent)/HK1005
	・E4991A＋16197A(or its equivalent)/HKQ0603S・HKQ0603U・HKQ0603W・HKQ0603C
	・4291A＋16092A ＋ in-house made jig(or its equivalent)/HK1608, HK2125
	・E4991A＋16196D(or its equivalent)HKQ0402

7. DC Resistance			
Specified Value	BK0402		0.07～1.2Ω max.
	BK0603		0.065～1.50Ω max.
	BK1005		0.03～0.90Ω max.
	BKH0603		0.26～3.20Ω max.
	BKH1005		0.85～2.00Ω max.
	BK1608		0.05～1.10Ω max.
	BK2125		0.05～0.75Ω max.
	ARRAY	BK2010	0.10～0.90Ω max.
		BK3216	0.15～0.80Ω max.
	BKP0402		0.05～0.15Ω max.
	BKP0603		0.030～0.180Ω max.
	BKP1005		0.0273～0.220Ω max.
	BKP1608		0.025～0.18Ω max.
	BKP2125		0.020～0.075Ω max.
	MCF 0605		2.5～6.5Ω max
	MCF 0806		2.5～5.0Ω max.
	MCF 1210		2.5～4.5Ω max.
	MCF 2010		4.5Ω max.
	CK1608		0.45～0.85Ω(±30%)
	CK2125		0.16～0.65Ω max.
	CKS2125		0.12～0.52Ω max.
	CKP1608		0.15～0.35Ω max.
	CKP2012		0.08～0.28Ω max.
	CKP2016		0.075～0.20Ω max
	CKP2520		0.05～0.16Ω max.
	NM2012		0.10～0.15Ω max.
	NM2520		0.11～0.22Ω max.
	LK1005		0.41～1.16Ω max.
	LK1608		0.2～2.2Ω max.
	LK2125		0.1～1.1Ω max.
	HK0603		0.11～3.74Ω max.
	HK1005		0.08～4.8Ω max.
	HK1608		0.05～2.6Ω max.
	HK2125		0.10～1.5Ω max.
	HKQ0402		0.08～5.0Ω max.
	HKQ0603W		0.07～4.1Ω max.
	HKQ0603C		0.07～1.6Ω max.
	HKQ0603S		0.06～1.29Ω max.
	HKQ0603U		0.06～1.29Ω max.
	AQ105		0.07～0.45Ω max.
	MCFE1608		0.100～0.340Ω max.
	MCKK2012		0.123Ω max.
Test Methods and Remarks	Measuring equipment：VOAC-7412, VOAC-7512, VOAC-7521（made by Iwasaki Tsushinki）, HIOKI3227 (or its equivalent)		

8. Self Resonance Frequency (SRF)			
Specified Value	BK0402		—
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		17～25MHz min.
	CK2125		24～235MHz min.
	CKS2125		24～75MHz min.
	CKP1608		—
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		40～180MHz min.
	LK1608		9～260MHz min.
	LK2125		13～320MHz min.
	HK0603		900～10000MHz min.
	HK1005		400～10000MHz min.
	HK1608		300～10000MHz min.
	HK2125		200～4000MHz min.
	HKQ0402		1200～10000MHz min.
	HKQ0603W		800～10000MHz min.
	HKQ0603C		2500～10000MHz min.
	HKQ0603S		1900～10000MHz min.
	HKQ0603U		1900～10000MHz min.
	AQ105		2300～10000MHz min.
	MCFE1608		—
	MCKK2012		
Test Methods and Remarks	LK、CK Series : Measuring equipment : 4195A (or its equivalent) Measuring jig : 41951＋16092A (or its equivalent) HK、HKQ、AQ Series : Measuring equipment : 8719C (or its equivalent)・8753D (or its equivalent)/HK2125		

9. Temperature Characteristic

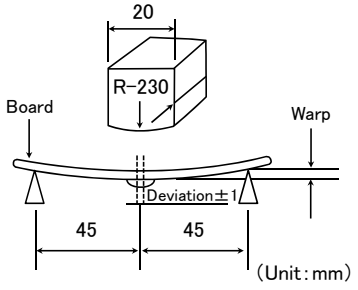
Specified Value	BK0402		−
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HK0603		Inductance change : Within ±10%
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		
	MCKK2012		
Test Methods and Remarks	HK、HKQ、AQ Series: Temperature range : −30～+85℃ Reference temperature : +20℃		
	MC Series: Temperature range : −40～+85℃ Reference temperature : +20℃		

10. Resistance to Flexure of Substrate

Specified Value	BK0402		No mechanical damage.
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HK0603		
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		
	MCKK2012		

Test Methods and Remarks

Warp : 2mm(BK Series without 0402size、BKP、BKH1005、CK、CKS、CKP、NM、LK、HK、HKQ0603S、HKQ0603U、AQ Series、MCF1210、MC Series)
: 1mm(BK0402、BKP0402、BKH0603、HKQ0402、HKQ0603W、HKQ0603C Series、MCF Series without 1210 size,)
Testing board : glass epoxy-resin substrate
Thickness : 0.8mm



11. Solderability			
Specified Value	BK0402		At least 75% of terminal electrode is covered by new solder.
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		At least 75% of terminal electrode is covered by new solder.
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		
	LK1608		
	LK2125		
	HK0603		
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		
	MCKK2012		
Test Methods and Remarks	Solder temperature	:230±5℃ (JIS Z 3282 H60A or H63A)	
	Solder temperature	:245±3℃ (Sn/3.0Ag/0.5Cu)	
	Duration	:4±1 sec.	

12. Resistance to Soldering			
Specified Value	BK0402		Appearance : No significant abnormality Impedance change : Within ±30%
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		Appearance : No significant abnormality Impedance change : Within ±20%
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		No mechanical damage. Remaining terminal electrode : 70% min Inductance change R10～4R7 : Within ±10% 6R8～100 : Within ±15% CKS2125 : Within ±20% CKP1608、CKP2012、CKP2016、CKP2520、NM2012、NM2520 : Within ±30%
	CK2125		
	CKS2125		
	CKP1608		
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		No mechanical damage. Remaining terminal electrode : 70% min. Inductance change : Within ±15%
	LK1608		No mechanical damage. Remaining terminal electrode : 70% min. Inductance change 47N～4R7 : Within ±10% 5R6～330 : Within ±15%
	LK2125		
	HK0603		No mechanical damage. Remaining terminal electrode : 70% min. Inductance change : Within ±5%
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		No mechanical damage. Remaining terminal electrode : 70% min. Inductance change : Within ±10%
	MCKK2012		
Test Methods and Remarks	Solder temperature	: 260±5℃	
	Duration	: 10±0.5 sec.	
	Preheating temperature	: 150 to 180℃	
	Preheating time	: 3 min.	
	Flux	: Immersion into methanol solution with colophony for 3 to 5 sec.	
	Recovery	: 2 to 3 hrs of recovery under the standard condition after the test. (See Note 1)	

(Note 1) When there are questions concerning measurement result ; measurement shall be made after 48±2 hrs of recovery under the standard condition.

13. Thermal Shock

Specified Value	BK0402		Appearance：No significant abnormality Impedance change： Within ±30%
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		Appearance：No significant abnormality Impedance change： Within ±20%
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		No mechanical damage. Inductance change：Within ±20% Q change：Within ±30%
	CK2125		
	CKS2125		Inductance change：Within ±20% (CKS2125)
	CKP1608		No mechanical damage. Inductance change： Within ±30%
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		No mechanical damage. Inductance change： Within ±10% Q change： Within ±30%
	LK1608		
	LK2125		
	HK0603		No mechanical damage. Inductance change： Within ±10% Q change： Within ±20%
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		Appearance：No significant abnormality Inductance change： Within ±10%
	MCKK2012		

Test Methods and Remarks

Conditions for 1 cycle

Step	temperature(℃)	time(min.)
1	Minimum operating temperature +0/−3	30±3
2	Room temperature	2～3
3	Maximum operating temperature +3/−0	30±3
4	Room temperature	2～3

Number of cycles：5

Recovery：2 to 3 hrs of recovery under the standard condition after the test.(See Note 1)

(Note 1) When there are questions concerning measurement result；measurement shall be made after 48±2 hrs of recovery under the standard condition.

14. Damp Heat(Steady state)			
Specified Value	BK0402		Appearance:No significant abnormality Impedance change: Within ±30%
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		Appearance:No significant abnormality Impedance change: Within ±20%
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		No mechanical damage. Inductance change: Within ±20% Q change: Within ±30%
	CK2125		
	CKS2125		Inductance change: Within ±20%
	CKP1608		No mechanical damage. Inductance change: Within ±30%
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		No mechanical damage. Inductance change: Within ±10% Q change: Within ±30%
	LK1608		
	LK2125		No mechanical damage. Inductance change: Within ±20% Q change: Within ±30%
	HK0603		No mechanical damage. Inductance change: Within ±10% Q change: Within ±20%
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MC1608		Appearance:No significant abnormality Inductance change: Within ±10%
	MC2012		
Test Methods and Remarks	BK、BKP、BKH Series、MCF Series: Temperature :40±2℃ Humidity :90 to 95%RH Duration :500+24/−0 hrs Recovery :2 to 3 hrs of recovery under the standard condition after the removal from test chamber.(See Note 1) LK、CK、CKS、CKP、NM、HK、HKQ、AQ、MC Series: Temperature :40±2℃(LK、CK、CKS、CKP、NM Series) :60±2℃(HK、HKQ、AQ、MC Series) Humidity :90 to 95%RH Duration :500±12 hrs Recovery :2 to 3 hrs of recovery under the standard condition after the removal from test chamber.(See Note 1)		

(Note 1) When there are questions concerning measurement result;measurement shall be made after 48±2 hrs of recovery under the standard condition.

15. Loading under Damp Heat			
Specified Value	BK0402		Appearance：No significant abnormality Impedance change： Within ±30%
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	CK1608		No mechanical damage. Inductance change： Within ±20% Q change： Within ±30%
	CK2125		
	CKS2125		No mechanical damage. Inductance change： Within ±20%
	CKP1608		No mechanical damage. Inductance change： Within ±30%
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		No mechanical damage. Inductance change： Within ±10% Q change： Within ±30%
	LK1608		No mechanical damage. Inductance change： 0.047～12.0 μH： Within ±10% 15.0～33.0 μH： Within ±15% Q change： Within ±30%
	LK2125		No mechanical damage. Inductance change： Within ±20% Q change： Within ±30%
	HK0603		No mechanical damage. Inductance change： Within ±10% Q change： Within ±20%
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		Appearance：No significant abnormality Inductance change： Within ±10%
	MCKK2012		
Test Methods and Remarks	BK、BKP、BKH Series： Temperature ：40±2℃ Humidity ：90 to 95%RH Applied current ：Rated current Duration ：500＋24／－0 hrs Recovery ：2 to 3 hrs of recovery under the standard condition after the removal from test chamber.(See Note 1) LK、CK、CKS、CKP、NK、HK、HKQ、AQ、MC Series： Temperature ：40±2℃(LK、CK、CKS、CKP、NM Series) ：60±2℃(HK、HKQ、AQ、MC Series) Humidity ：90 to 95%RH Applied current ：Rated current Duration ：500±12 hrs Recovery ：2 to 3 hrs of recovery under the standard condition after the removal from test chamber.(See Note 1)		

Note on standard condition: "standard condition" referred to herein is defined as follows:
5 to 35℃ of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.
When there are questions concerning measurement results:
In order to provide correlation data, the test shall be conducted under condition of 20±2℃ of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure.
Unless otherwise specified, all the tests are conducted under the "standard condition."
(Note 1) Measurement shall be made after 48±2 hrs of recovery under the standard condition.

16. Loading at High Temperature			
Specified Value	BK0402		Appearance：No significant abnormality Impedance change： Within ±30%
	BK0603		
	BK1005		
	BKH0603		
	BKH1005		
	BK1608		
	BK2125		
	ARRAY	BK2010	
		BK3216	
	BKP0402		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		Appearance：No significant abnormality Impedance change： Within ±20%
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		No mechanical damage. Inductance change： Within ±20% Q change： Within ±30%
	CK2125		
	CKS2125		No mechanical damage. Inductance change： Within ±20%
	CKP1608		No mechanical damage. Inductance change： Within ±30%
	CKP2012		
	CKP2016		
	CKP2520		
	NM2012		
	NM2520		
	LK1005		No mechanical damage. Inductance change： Within ±10% Q change： Within ±30%
	LK1608		No mechanical damage. Inductance change： 0.047～12.0 μH： Within ±10% 15.0～33.0 μH： Within ±15% Q change： Within ±30%
	LK2125		No mechanical damage. Inductance change： Within ±20% Q change： Within ±30%
	HK0603		No mechanical damage. Inductance change： Within ±10% Q change： Within ±20%
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603C		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	MCFE1608		Appearance：No significant abnormality Inductance change： Within ±10%
	MCKK2012		
Test Methods and Remarks	BK、BKH、BKP Series、MCF Series： Temperature ：125±3℃(BK、BKH Series) ：85±3℃(BKP、MCF Series) Applied current ：Rated current Duration ：500+24/−0 hrs Recovery ：2 to 3 hrs of recovery under the standard condition after the removal from test chamber. (See Note 1) LK、CK、CKS、CKP、NM、HK、HKQ、AQ、MC Series： Temperature ：85±2℃(LK、CK、CKS、CKP、NM、MC Series) ：85±2℃(HK1608, 2125) ：85±2℃(HK1005, AQ105 operating temperature range−55～+85℃) ：125±2℃(HKQ0402, HK0603, HK1005, HKQ0603S, HKQ0603U, HKQ0603W, HKQ0603C, AQ105 operating temperature range−55～+125℃) Applied current ：Rated current Duration ：500±12 hrs Recovery ：2 to 3 hrs of recovery under the standard condition after the test.(See Note 1)		

Note on standard condition: "standard condition" referred to herein is defined as follows:
5 to 35℃ of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.
When there are questions concerning measurement results:
In order to provide correlation data, the test shall be conducted under condition of 20±2℃ of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure. Unless otherwise specified, all the tests are conducted under the "standard condition."
(Note 1) Measurement shall be made after 48±2 hrs of recovery under the standard condition.

Precautions on the use of Multilayer chip inductors
Multilayer chip inductors for high frequency, Multilayer chip bead inductors
Multilayer common mode choke coils (MC series F type)
Metal Multilayer Chip Power Inductors (MCOIL™ MC series)

■PRECAUTIONS

1. Circuit Design

Precautions

◆Verification of operating environment, electrical rating and performance

1. A malfunction in medical equipment, spacecraft, nuclear reactors, etc. may cause serious harm to human life or have severe social ramifications.
   As such, any inductors to be used in such equipment may require higher safety and/or reliability considerations and should be clearly differentiated from components used in general purpose applications.

◆Operating Current (Verification of Rated current)

1. The operating current for inductors must always be lower than their rated values.
2. Do not apply current in excess of the rated value because the inductance may be reduced due to the magnetic saturation effect.

2. PCB Design

Precautions

◆Pattern configurations (Design of Land-patterns)

1. When inductors are mounted on a PCB, the size of land patterns and the amount of solder used (size of fillet) can directly affect inductor performance.
   Therefore, the following items must be carefully considered in the design of solder land patterns:
   (1) The amount of solder applied can affect the ability of chips to withstand mechanical stresses which may lead to breaking or cracking. Therefore, when designing land-patterns it is necessary to consider the appropriate size and configuration of the solder pads which in turn determines the amount of solder necessary to form the fillets.
   (2) When more than one part is jointly soldered onto the same land or pad, the pad must be designed so that each component's soldering point is separated by solder-resist.
   (3) The larger size of land patterns and amount of solder, the smaller Q value after mounting on PCB. It makes higher the Q value to design land patterns smaller than terminal electrode of chips.

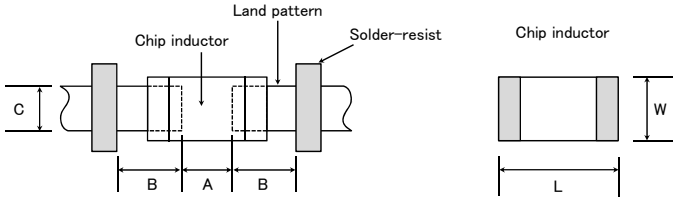
◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)

1. After inductors have been mounted on the boards, chips can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering the reflow soldered boards etc.) For this reason, planning pattern configurations and the position of SMD inductors should be carefully performed to minimize stress.

Technical considerations

◆Pattern configurations (Design of Land-patterns)

1. The following diagrams and tables show some examples of recommended patterns to prevent excessive solder amounts (larger fillets which extend above the component end terminations). Examples of improper pattern designs are also shown.
   (1) Recommended land dimensions for a typical chip inductor land patterns for PCBs



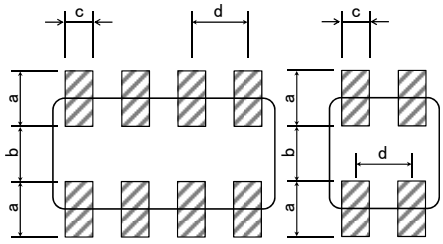
Recommended land dimensions for wave-soldering (Unit: mm)

Type		1608	2012	2125	2016	2520	3216
Size	L	1.6	2.0	2.0	2.0	2.5	3.2
	W	0.8	1.25	1.25	1.6	2.0	1.6
A		0.8～1.0	1.0～1.4	1.0～1.4	1.0～1.4	1.0～1.4	1.8～2.5
B		0.5～0.8	0.8～1.5	0.8～1.5	0.8～1.5	0.6～1.0	0.8～1.7
C		0.6～0.8	0.9～1.2	0.9～1.2	1.3～1.6	1.6～2.0	1.2～1.6

Recommended land dimensions for reflow-soldering (Unit: mm)

Type		0402	0603	1005	105	1608	2012	2125	2016	2520	3216
Size	L	0.4	0.6	1.0	1.0	1.6	2.0	2.0	2.0	2.5	3.2
	W	0.2	0.3	0.5	0.6	0.8	1.25	1.25	1.6	2.0	1.6
A		0.15～0.25	0.20～0.30	0.45～0.55	0.50～0.55	0.8～1.0	0.8～1.2	0.8～1.2	0.8～1.2	1.0～1.4	1.8～2.5
B		0.10～0.20	0.20～0.30	0.40～0.50	0.30～0.40	0.6～0.8	0.8～1.2	0.8～1.2	0.8～1.2	0.6～1.0	0.6～1.5
C		0.15～0.30	0.25～0.40	0.45～0.55	0.60～0.70	0.6～0.8	0.9～1.6	0.9～1.6	1.2～2.0	1.8～2.2	1.2～2.0

Excess solder can affect the ability of chips to withstand mechanical stresses. Therefore, please take proper precautions when designing land-patterns.

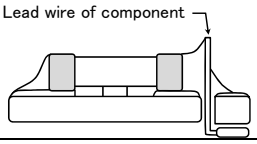
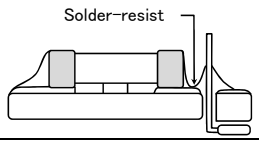
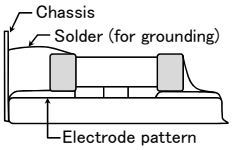
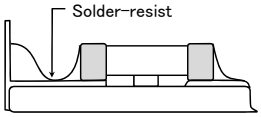
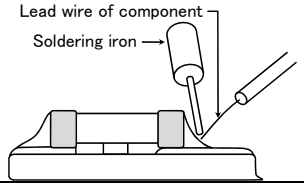
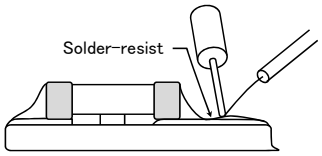
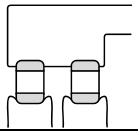
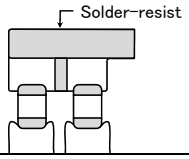


Recommended land dimension for Reflow-soldering

Type		3216	2010	1210	0806	0605
Size	L	3.2	2.0	1.25	0.85	0.65
	W	1.6	1.0	1.0	0.65	0.50
a		0.7～0.9	0.5～0.6	0.45～0.55	0.25～0.35	0.27～0.33
b		0.8～1.0	0.5～0.6	0.7～0.8	0.25～0.35	0.17～0.23
c		0.4～0.5	0.2～0.3	0.25～0.35	0.25～0.35	0.20～0.26
d		0.8	0.5	0.55	0.5	0.4

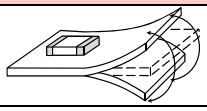
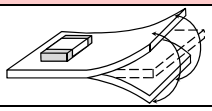
(Unit : mm)

((2) Examples of good and bad solder application

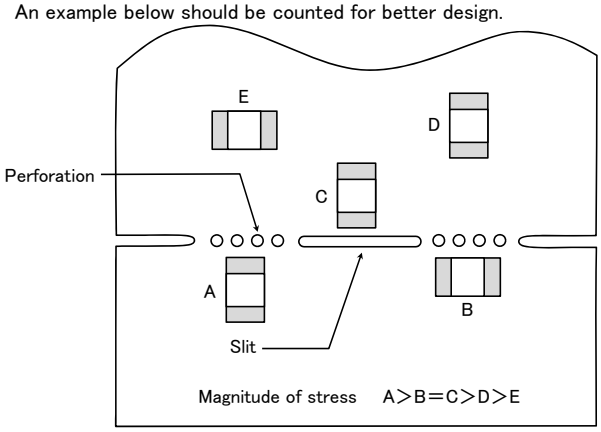
Item	Not recommended	Recommended
Mixed mounting of SMD and leaded components		
Component placement close to the chassis		
Hand-soldering of leaded components near mounted components		
Horizontal component placement		

◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)

1-1. The following are examples of good and bad inductor layout; SMD inductors should be located to minimize any possible mechanical stresses from board warp or deflection.

Item	Not recommended	Recommended
Deflection of the board		 Position the component at a right angle to the direction of the mechanical stresses that are anticipated.

1-2. To layout the inductors for the breakaway PC board, it should be noted that the amount of mechanical stresses given will vary depending on inductor layout.
An example below should be counted for better design.



1-3. When breaking PC boards along their perforations, the amount of mechanical stress on the inductors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, any ideal SMD inductor layout must also consider the PCB splitting procedure.

3. Considerations for automatic placement

Precautions

◆Adjustment of mounting machine

1. Excessive impact load should not be imposed on the inductors when mounting onto the PC boards.
2. The maintenance and inspection of the mounter should be conducted periodically.

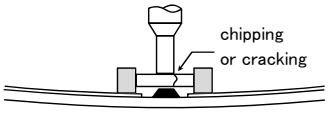
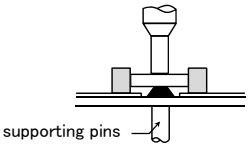
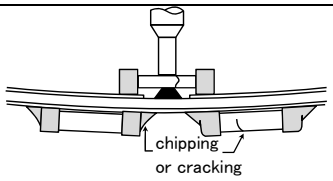
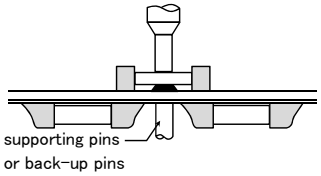
◆Selection of Adhesives

1. Mounting inductors with adhesives in preliminary assembly, before the soldering stage, may lead to degraded inductor characteristics unless the following factors are appropriately checked; the size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, it is imperative to consult the manufacturer of the adhesives on proper usage and amounts of adhesive to use.

Technical considerations

◆Adjustment of mounting machine

1. If the lower limit of the pick-up nozzle is low, too much force may be imposed on the inductors, causing damage. To avoid this, the following points should be considered before lowering the pick-up nozzle:
   (1) The lower limit of the pick-up nozzle should be adjusted to the surface level of the PC board after correcting for deflection of the board.
   (2) The pick-up pressure should be adjusted between 1 and 3N static loads.
   (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins should be used under the PC board. The following diagrams show some typical examples of good pick-up nozzle placement:

Item	Improper method	Proper method
Single-sided mounting		
Double-sided mounting		

2. As the alignment pin wears out, adjustment of the nozzle height can cause chipping or cracking of the inductors because of mechanical impact on the inductors. To avoid this, the monitoring of the width between the alignment pin in the stopped position, and maintenance, inspection and replacement of the pin should be conducted periodically.

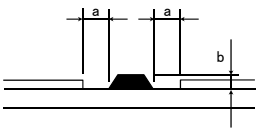
◆Selection of Adhesives

1. Some adhesives may cause reduced insulation resistance. The difference between the shrinkage percentage of the adhesive and that of the inductors may result in stresses on the inductors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect component placement, so the following precautions should be noted in the application of adhesives.
   (1) Required adhesive characteristics
      a. The adhesive should be strong enough to hold parts on the board during the mounting & solder process.
      b. The adhesive should have sufficient strength at high temperatures.
      c. The adhesive should have good coating and thickness consistency.
      d. The adhesive should be used during its prescribed shelf life.
      e. The adhesive should harden rapidly.
      f. The adhesive must not be contaminated.
      g. The adhesive should have excellent insulation characteristics.
      h. The adhesive should not be toxic and have no emission of toxic gasses.
   (2) When using adhesives to mount inductors on a PCB, inappropriate amounts of adhesive on the board may adversely affect component placement. Too little adhesive may cause the inductors to fall off the board during the solder process. Too much adhesive may cause defective soldering due excessive flow of adhesive on to the land or solder pad.

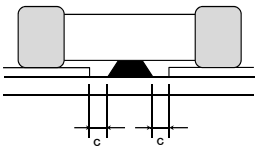
[Recommended conditions]

Figure	0805 case sizes as examples
a	0.3mm min
b	100～120 μm
c	Area with no adhesive

Amount of adhesives



After inductors are bonded



4. Soldering

Precautions

◆Selection of Flux

1. Since flux may have a significant effect on the performance of inductors, it is necessary to verify the following conditions prior to use;
   (1) Flux used should be with less than or equal to 0.1 wt% (Chlorine conversion method) of halogenated content. Flux having a strong acidity content should not be applied.
   (2) When soldering inductors on the board, the amount of flux applied should be controlled at the optimum level.
   (3) When using water-soluble flux, special care should be taken to properly clean the boards.

◆Soldering

1. Temperature, time, amount of solder, etc. are specified in accordance with the following recommended conditions, and please contact us about peak temperature when you use lead-free paste.

Technical considerations

◆Selection of Flux

1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate the flux, or highly acidic flux is used, an excessive amount of residue after soldering may lead to corrosion of the terminal electrodes or degradation of insulation resistance on the surface of the Inductor.

1-2. Flux is used to increase solderability in flow soldering, but if too much is applied, a large amount of flux gas may be emitted and may detrimentally affect solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.

1-3. Since the residue of water-soluble flux is easily dissolved by water content in the air, the residue on the surface of Inductor in high humidity conditions may cause a degradation of insulation resistance and therefore affect the reliability of the components. The cleaning methods and the capability of the machines used should also be considered carefully when selecting water-soluble flux.

◆Soldering

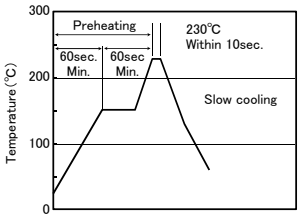
1-1. Preheating when soldering

Heating: Chip inductor components should be preheated to within 100 to 130℃ of the soldering. Cooling: The temperature difference between the components and cleaning process should not be greater than 100℃.

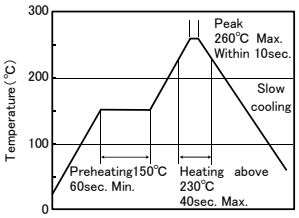
Chip inductors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling. Therefore, the soldering process must be conducted with a great care so as to prevent malfunction of the components due to excessive thermal shock.

[Reflow soldering]

【Recommended conditions for eutectic soldering】



【Recommended condition for Pb-free soldering】

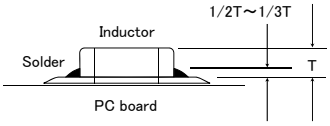


※Ceramic chip components should be preheated to within 100 to 130℃ of the soldering.

※Assured to be reflow soldering for 2 times.

Caution

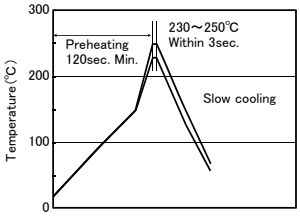
1. The ideal condition is to have solder mass (fillet) controlled to 1/2 to 1/3 of the thickness of the inductor, as shown below:



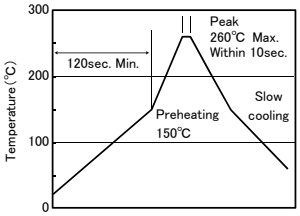
2. Because excessive dwell times can detrimentally affect solderability, soldering duration should be kept as close to recommended times as possible.

[Wave soldering]

【Recommended conditions for eutectic soldering】



【Recommended condition for Pb-free soldering】



※Ceramic chip components should be preheated to within 100 to 130℃ of the soldering.

※Assured to be wave soldering for 1 time.

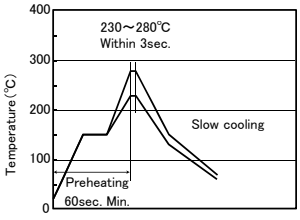
※Except for reflow soldering type.

Caution

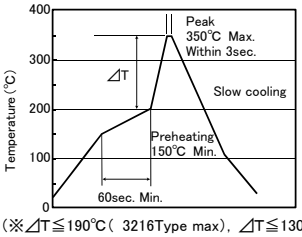
1. Make sure the inductors are preheated sufficiently.
2. The temperature difference between the inductor and melted solder should not be greater than 100 to 130℃.
3. Cooling after soldering should be as gradual as possible.
4. Wave soldering must not be applied to the inductors designated as for reflow soldering only.

[Hand soldering]

【Recommended conditions for eutectic soldering



【Recommended condition for Pb-free soldering】



(※⊿T≦190℃(3216Type max), ⊿T≦130℃(3225 Type min)

※It is recommended to use 20W soldering iron and the tip is 1φ or less.

※The soldering iron should not directly touch the components.

※Assured to be soldering iron for 1 time.

Note: The above profiles are the maximum allowable soldering condition, therefore these profiles are not always recommended.

	Caution 1. Use a 20W soldering iron with a maximum tip diameter of 1.0 mm. 2. The soldering iron should not directly touch the inductor.

5. Cleaning	
Precautions	◆Cleaning conditions 1. When cleaning the PC board after the Inductors are all mounted, select the appropriate cleaning solution according to the type of flux used and purpose of the cleaning(e.g. to remove soldering flux or other materials from the production process.) 2. Cleaning conditions should be determined after verifying, through a test run, that the cleaning process does not affect the inductor's characteristics.
Technical considerations	◆Cleaning conditions 1. The use of inappropriate solutions can cause foreign substances such as flux residue to adhere to the inductor, resulting in a degradation of the inductor's electrical properties(especially insulation resistance). 2. Inappropriate cleaning conditions(insufficient or excessive cleaning)may detrimentally affect the performance of the inductors. (1) Excessive cleaning a. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of the PC board which may lead to the cracking of the inductor or the soldered portion, or decrease the terminal electrodes' strength. Thus the following conditions should be carefully checked; Ultrasonic output Below 20W/ℓ Ultrasonic frequency Below 40kHz Ultrasonic washing period 5 min. or less

6. Post cleaning processes	
Precautions	◆Application of resin coatings, moldings, etc. to the PCB and components. 1. With some type of resins a decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the inductor's performance. 2. When a resin's hardening temperature is higher than the inductor's operating temperature, the stresses generated by the excess heat may lead to inductor damage or destruction. 3. Stress caused by a resin's temperature generated expansion and contraction may damage inductors. The use of such resins, molding materials etc. is not recommended.

7. Handling	
Precautions	◆Breakaway PC boards(splitting along perforations) 1. When splitting the PC board after mounting inductors and other components, care is required so as not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆General handling precautions 1. Always wear static control bands to protect against ESD. 2. Keep the inductors away from all magnets and magnetic objects. 3. Use non-magnetic tweezers when handling inductors. 4. Any devices used with the inductors(soldering irons, measuring instruments) should be properly grounded. 5. Keep bare hands and metal products(i.e., metal desk)away from chip electrodes or conductive areas that lead to chip electrodes. 6. Keep inductors away from items that generate magnetic fields such as speakers or coils. ◆Mechanical considerations 1. Be careful not to subject the inductors to excessive mechanical shocks. (1) If inductors are dropped on the floor or a hard surface they should not be used. (2) When handling the mounted boards, be careful that the mounted components do not come in contact with or bump against other boards or components.

8. Storage conditions	
Precautions	◆Storage 1. To maintain the solderability of terminal electrodes and to keep the packaging material in good condition, care must be taken to control temperature and humidity in the storage area. Humidity should especially be kept as low as possible. Recommended conditions Ambient temperature Below 30℃ Humidity Below 70% RH The ambient temperature must be kept below 40℃. Even under ideal storage conditions inductor electrode solderability decreases as time passes, so inductors should be used within 6 months from the time of delivery. *The packaging material should be kept where no chlorine or sulfur exists in the air.
Technical considerations	◆Storage 1. If the parts are stocked in a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. For this reason, components should be used within 6 months from the time of delivery. If exceeding the above period, please check solderability before using the inductors.